

DP83869HM High Immunity 10/100/1000 Ethernet Physical Layer Transceiver With **Copper and Fiber Interface**

1 Features

- Multiple operating modes
 - Media support: copper and fiber
 - Media conversion between copper and fiber
 - Bridge between RGMII and SGMII
- Maximum ambient temperature available of 125°C
- Exceeds 8kV IEC61000-4-2 ESD
- Low power consumption
 - < 150mW for 1000Base-X</p>
 - < 500mW for 1000Base-T
- Low RGMII latency
 - Total latency ≤ 384ns for 1000Base-T
 - Total latency ≤ 361ns for 100Base-TX
- Time Sensitive Network (TSN) compliant
- Recovered clock output for SyncE
- Selectable synchronized clock output: 25MHz and
- SFF-8431 V4.1, 1000BASE-X and 100BASE-FX Compatible
- IEEE1588 support via SFD
- Wake on LAN support
- Configurable IO voltages: 1.8V, 2.5V, and 3.3V
- SGMII, RGMII, MII MAC interface
- Jumbo frame support for 1000M and 100M speed
- Cable diagnostics
 - TDR
 - BIST
- Programmable RGMII termination impedance
- Integrated MDI termination resistor
- Fast link drop modes
- Conforms to IEEE 802.3 1000Base-T, 100Base-TX, 10Base-Te,1000Base-X, 100Base-FX

2 Applications

- **Industrial Factory Automation**
- **Grid Infrastructure**
- Motor and Motion Control
- **Test and Measurement**
- **Building Automation**
- Real-Time Industrial Ethernet Applications such as **ProfiNET®**

3 Description

The DP83869HM device is a robust, fully-featured gigabit physical layer (PHY) transceiver with integrated PMD sublayers that supports 10BASE-Te, 100BASE-TX and 1000BASE-T Ethernet protocols. The DP83869 also supports 1000BASE-X and 100BASE-FX fiber protocols. Optimized for ESD protection, the DP83869HM exceeds 8kV 61000-4-2 (direct contact). This device interfaces to the MAC layer through reduced GMII (RGMII) and SGMII. In 100M mode, the device lets the designer use MII for lower latency. Programmable integrated termination impedance on RGMII/MII helps reduce system BOM.

The DP83869HM supports media conversion in unmanaged mode. In this mode, the DP83869HM can run 1000BASE-X-to-1000BASE-T and 100BASE-FXto-100BASE-TX conversions.

The DP83869HM can also support bridge conversion from RGMII to SGMII and SGMII to RGMII. The DP83869HM is compliant to TSN standards and offers low latency.

The DP83869HM can also generate IEEE 1588 Sync Frame Detect indications to MAC. This can reduce the jitter in Time Synchronization and help the System account for asymmetric delays in Transmission and Reception of packets.

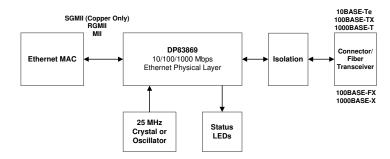
The standard Ethernet system block diagram is shown on the first page. Designers can also use the DP83869 in Media Convertor mode, in RGMIIto-SGMII Bridge applications, and in SGMII-RGMII Bridge applications.

Package Information

| PART NUMBER | | PACKAGE (1) | PACKAGE SIZE ⁽²⁾ | | | | | |
|-------------|----------|----------------|-----------------------------|--|--|--|--|--|
| DP8386 | 9HM | RGZ (VQFN, 48) | 7mm × 7mm | | | | | |
| DP8386 | 7E/IS/CS | RGZ (VQFN, 48) | 7mm × 7mm | | | | | |
| DP8386 | 7IR/CR | RGZ (VQFN, 48) | 7mm × 7mm | | | | | |

- For all available packages, see Section 11. (1)
- (2) The package size (length × width) is a nominal value and includes pins, where applicable.





Standard Ethernet System Block Diagram

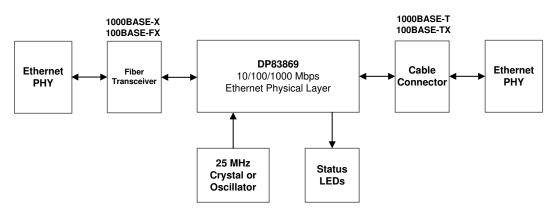


Figure 3-1. Media Convertor System Block Diagram

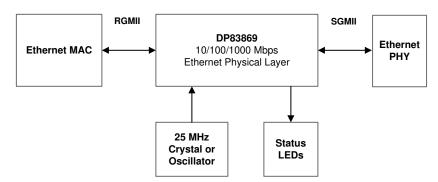


Figure 3-2. RGMII-SGMII Bridge System Block Diagram

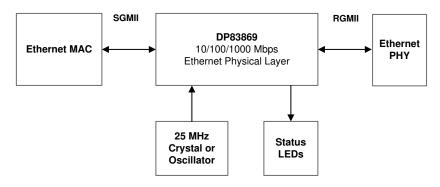


Figure 3-3. SGMII-RGMII Bridge System Block Diagram

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4 Device Comparison

Table 4-1. Device Comparison

| DEVICE | BRIDGE MODE | TEMPERATURE | TEMPERATURE GRADE |
|-----------|-------------|-----------------|-------------------|
| DP83869HM | Yes | -40°C to +125°C | High Temp |



5 Pin Configuration and Functions

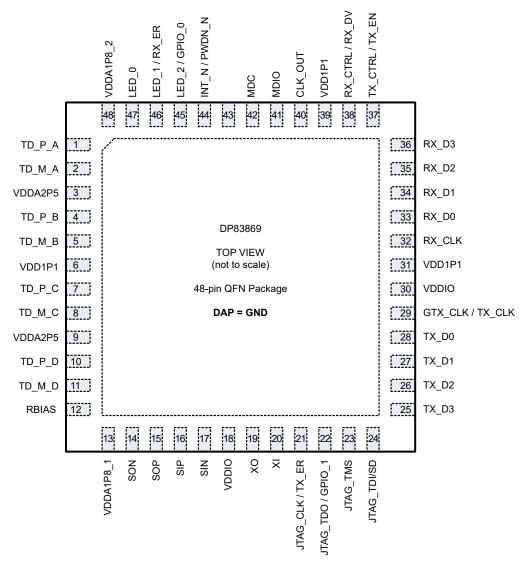


Figure 5-1. RGZ Package (48-Pin VQFN) Top View

Table 5-1. RGZ Package (VQFN) Pin Functions

| | PIN | 1/0 | TYPE | DESCRIPTION |
|-----|---------|-------|--------|---|
| NO. | NAME |] "// | IIFE | DESCRIPTION |
| 1 | TD_P_A | I/O | Analog | Differential Transmit and Receive Signals |
| 2 | TD_M_A | I/O | Analog | Differential Transmit and Receive Signals |
| 3 | VDDA2P5 | ı | Power | 2.5V Analog Supply (+/-5%). Each pin requires a 1µF and 0.1µF capacitor to GND. |
| 4 | TD_P_B | I/O | Analog | Differential Transmit and Receive Signals |
| 5 | TD_M_B | I/O | Analog | Differential Transmit and Receive Signals |
| 6 | VDD1P1 | ı | Power | 1.1V Digital Supply (+/-10%). Each pin requires a 1µF and 0.1µF capacitor to GND. |
| 7 | TD_P_C | I/O | Analog | Differential Transmit and Receive Signals |
| 8 | TD_M_C | I/O | Analog | Differential Transmit and Receive Signals |
| 9 | VDDA2P5 | I | Power | 2.5V Analog Supply (+/-5%). Each pin requires a 1µF and 0.1µF capacitor to GND. |



Table 5-1. RGZ Package (VQFN) Pin Functions (continued)

| | PIN | | | DESCRIPTION | | | |
|-----|-----------------|-----|--------|--|--|--|--|
| NO. | NAME | I/O | TYPE | DESCRIPTION | | | |
| 10 | TD_P_D | I/O | Analog | Differential Transmit and Receive Signals | | | |
| 11 | TD_M_D | I/O | Analog | Differential Transmit and Receive Signals | | | |
| 12 | RBIAS | I | _ | Bias Resistor Connection. An 11k Ω +/-1% resistor must be connected from RBIAS to GND. | | | |
| 13 | VDDA1P8_1 | ı | Power | No external supply is required for this pin in two-supply mode. When unused, no connections can be made to these pins. In three-supply mode, an external 1.8V(+/-5%) supply can be connected to these pins. When using an external supply, each pin requires a $1\mu F$ and $0.1\mu F$ capacitor to GND. | | | |
| 14 | SON | 0 | Analog | Differential SGMII or Fiber Data Output: This signal carries data from the PHY to the MAC, fiber transceiver, or link partner in SGMII and fiber modes. This pin is AC-coupled to the distant device through a 0.1µF capacitor. This pin provides LVDS signals, additional components can be required for the optical transceiver. | | | |
| 15 | SOP | 0 | Analog | Differential SGMII or Fiber Data Output: This signal carries data from the PHY to the MAC, fiber transceiver, or link partner in SGMII and fiber modes. This pin is AC-coupled to the distant device through a 0.1µF capacitor. This pin provides LVDS signals, additional components can be required for the optical transceiver | | | |
| 16 | SIP | ı | Analog | Differential SGMII or Fiber Data Input: This signal carries data from the MAC, fiber transceiver, or link partner, to the PHY in SGMII and fiber modes. This pin is AC-coupled to the distant device through a 0.1µF capacitor. This pin accepts LVDS signals, additional components can be required for the optical transceiver | | | |
| 17 | SIN | ı | Analog | Differential SGMII or Fiber Data Input: This signal carries data from the MAC, fiber transceiver, or link partner, to the PHY in SGMII and fiber modes. This pin is AC-coupled to the distant device through a 0.1µF capacitor. This pin accepts LVDS signals, additional components can be required for the optical transceiver | | | |
| 18 | VDDIO | I | Power | I/O Power: 1.8V (±5%), 2.5V (±5%) or 3.3V (±5%). Each pin requires a 1μF and 0.1μF capacitor to GND | | | |
| 19 | хо | 0 | Clock | CRYSTAL OSCILLATOR OUTPUT: Second terminal for 25MHz crystal. Must be left floating if a clock oscillator is used. | | | |
| 20 | XI | I | Clock | CRYSTAL OSCILLATOR INPUT: 25MHz oscillator or crystal input. | | | |
| 21 | JTAG_CLK/TX_ER | ı | WPU | JTAG TEST CLOCK: IEEE 1149.1 Test Clock input, primary clock source for all test logic input and output controlled by the testing entity. MII Mode: In MII mode, this pin is configured as TX_ER pin and is sourced from MAC to PHY. Use of this pin is optional. | | | |
| 22 | JTAG_TDO/GPIO_1 | 0 | _ | JTAG TEST DATA OUTPUT: IEEE 1149.1 Test Data Output pin, the most recent test results are scanned out of the device via TDO. General Purpose I/O: This signal provides a multi-function configurable I/O. Please refer to the GPIO_MUX_CTRL register for details. | | | |
| 23 | JTAG_TMS | I | WPU | JTAG TEST MODE SELECT: IEEE 1149.1 Test Mode Select pin, the TMS pin sequences the Tap Controller (16-state FSM) to select the desired test instruction. TI recommends applying 3 clock cycles with JTAG_TMS high to reset the JTAG. | | | |
| 24 | JTAG_TDI/SD | ı | WPU | JTAG TEST DATA INPUT: IEEE 1149.1 Test Data Input pin, test data is scanned into the device via TDI. SD: In 1000Base-X and 100Base-FX mode, this pin acts as Signal Detect. SD is an active low pin. This must be connected to Signal Detect of optical transceiver. | | | |
| 25 | TX_D3 | ı | WPD | | | | |
| 26 | TX_D2 | I | WPD | TRANSMIT DATA: Signal TX_D[3:0] carries data from the MAC to the PHY in RGMII | | | |
| 27 | 27 TX_D1 I | | WPD | mode and MII mode. Data is synchronous to the transmit clock. In RGMII mode GTX_CLK is the transmit clock and in MII mode TX_CLK is the transmit clock. | | | |
| 28 | TX_D0 | I | WPD | | | | |
| 29 | GTX_CLK/TX_CLK | I/O | WPD | RGMII TRANSMIT CLOCK: This continuous clock signal is sourced from the MAC layer to the PHY. Nominal frequency is 125MHz in 1000Mbps mode. This pin is Input in RGMII mode. MII TRANSMIT CLOCK: In MII mode, this pin provides a 25MHz reference clock for 100Mbps speed and a 2.5MHz reference clock for 10Mbps speed. This pin is output in MII mode. This pin is GTX_CLK by default and can be changed to TX_CLK by register configurations. | | | |



Table 5-1. RGZ Package (VQFN) Pin Functions (continued)

| | PIN | | | Package (VQFN) Pin Functions (continued) |
|-----|---------------|-----|------------|---|
| NO. | NAME | I/O | TYPE | DESCRIPTION |
| 30 | VDDIO | ı | Power | I/O Power: 1.8V (±5%), 2.5V (±5%) or 3.3V (±5%). Each pin requires a 1μF and 0.1μF capacitor to GND |
| 31 | VDD1P1 | ı | Power | 1.1V Digital Supply (+/-10%). Each pin requires a 1µF and 0.1µF capacitor to GND. |
| 32 | RX_CLK | 0 | Strap, WPD | RECEIVE CLOCK: Provides the recovered receive clocks for different modes of operation: 125MHz in 1000Mbps RGMII mode. |
| 33 | RX_D0 | 0 | Strap, WPD | |
| 34 | RX_D1 | 0 | Strap, WPD | RECEIVE DATA: Signal RX_D[3:0] carries data from the PHY to the MAC in RGMII |
| 35 | RX_D2 | 0 | Strap, WPD | mode and in MII mode. Symbols received on the cable are decoded and presented on these pins synchronous to RX CLK. |
| 36 | RX_D3 | 0 | Strap, WPD | _ |
| 37 | TX_CTRL/TX_EN | I | WPD | TRANSMIT CONTROL: In RGMII mode, TX_CTRL combines the transmit enable and the transmit error signal inputs from the MAC using both clock edges. TX_EN: In MII mode, this pin functions as TX_EN. |
| 38 | RX_CTRL/RX_DV | 0 | WPD | RECEIVE CONTROL: In RGMII mode, the receive data available and receive error are combined (RXDV_ER) using both rising and falling edges of the receive clock (RX_CLK). RX_DV: In MII mode, this pin functions as RX_DV. |
| 39 | VDD1P1 | ı | Power | 1.1V Digital Supply (+/-10%). Each pin requires a 1µF and 0.1µF capacitor to GND. |
| 40 | CLK_OUT | 0 | Clock | CLOCK OUTPUT: Output clock |
| 41 | MDIO | I/O | _ | MANAGEMENT DATA I/O: Bi-directional management instruction/data signal that can be sourced by the management station or the PHY. This open-drain pin requires a 1.5kΩ pull-up resistor. |
| 42 | MDC | I | _ | MANAGEMENT DATA CLOCK: Synchronous clock to the MDIO serial management input/output data. This clock can be asynchronous to the MAC transmit and receive clocks. The maximum clock rate is 25MHz. There is no minimum clock rate. |
| 43 | RESET_N | I | _ | RESET_N: This pin is an active-low reset input that initializes or re-initializes all the internal registers of the DP83869. Asserting this pin low for at least 1μs forces a reset process to occur. This pin is in IO voltage domain. A 100Ω resistor and 47uF capacitor are required to be connected in series between RESET_N pin and Ground. |
| 44 | INT_N/PWDN_N | I/O | _ | INTERRUPT / POWER DOWN: The default function of this pin is POWER DOWN. POWER DOWN: This is an Active Low Input. Asserting this signal low enables the power-down mode of operation. In this mode the device powers down and consumes minimum power. Register access is available through the Management Interface to configure and power up the device. INTERRUPT: The interrupt pin is an open-drain, active low output signal indicating an interrupt condition has occurred. Register access is required to determine which event caused the interrupt. TI recommends using an external $2.2k\Omega$ resistor connected to the VDDIO supply. When register access is disabled through pin option, the interrupt is asserted for 500ms before self-clearing. |
| 45 | LED_2/GPIO_0 | I/O | Strap, WPD | LED_2: Part of VIO voltage domain. General Purpose I/O: This signal provides a multi-function configurable I/O. Please refer to the GPIO_MUX_CTRL register for details. |
| 46 | LED_1/RX_ER | 0 | Strap, WPD | LED_1: Part of VIO voltage domain. MII Mode: In MII mode this pin is configured as RX_ER. This pin is asserted high synchronously to rising edge of RX_CLK. Use of this pin is optional. |
| 47 | LED_0 | 0 | Strap, WPD | LED_0: This pin is part of the VDDIO voltage domain |
| 48 | VDDA1P8_2 | I | Power | No external supply is required for this pin in two-supply mode. When unused, no connections can be made to these pins. In three-supply mode, an external 1.8V(+/-5%) supply can be connected to these pins. When using an external supply, each pin requires a $1\mu F$ and $0.1\mu F$ capacitor to GND. |

Product Folder Links: DP83869HM

Pin Functionality definitions are given below:

• I: Input

• O: Output

I/O: Input/Output



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- Strap: Multifunctional bootstrap pins
- WPD: Weak Pull Down Resistor (internal)
- WPU: Weak Pull Up Resistor (internal)
- Power: Power Supply Pins
- Analog: Analog pins



Table 5-2. Pin States-1

| | COPPER MODE | | | | | | | | |
|--------|----------------------|-----------|-----------|-----------|-----------|------------|-----------|-----------|-----------|
| PIN NO | PIN NAME | RES | SET | N | 111 | RG | MII | SG | MII |
| | | PIN STATE | PULL/HI-Z | PIN STATE | PULL/HI-Z | PIN STATE | PULL/HI-Z | PIN STATE | PULL/HI-Z |
| 14 | SON | 0 | Hi-Z | 0 | Hi-Z | 0 | Hi-Z | 0 | 50Ω |
| 15 | SOP | 0 | Hi-Z | 0 | Hi-Z | 0 | Hi-Z | 0 | 50Ω |
| 16 | SIP | I | Hi-Z | I | Hi-Z | I | Hi-Z | I | 50Ω |
| 17 | SIN | I | Hi-Z | I | Hi-Z | I | Hi-Z | I | 50Ω |
| 21 | JTAG_CLK/ TX_ER | I | PU | I | PU | I | PU | I | PU |
| 22 | JTAG_TDO / GPIO_1 | I | PD | 0 | Hi-Z | 0 | Hi-Z | 0 | Hi-Z |
| 23 | JTAG_TMS | I | PU | I | PU | I | PU | I | PU |
| 24 | JTAG_TDI / SD | I | PU | I | PU | I | PU | I | PU |
| 25 | TX_D3 | Į | PD | I | PD | Į | PD | I | PD |
| 26 | TX_D2 | Į | PD | I | PD | I | PD | I | PD |
| 27 | TX_D1 | I | PD | I | PD | I | PD | I | PD |
| 28 | TX_D0 | Į | PD | I | PD | I | PD | I | PD |
| 29 | GTX_CLK / TX_CLK | I | PD | 0 | PD | I | PD | I | PD |
| 32 | RX_CLK | I | PD | 0 | Hi-Z | O (125MHz) | Hi-Z | I | PD |
| 33 | RX_D0 | Į | PD | 0 | Hi-Z | 0 | Hi-Z | I | PD |
| 34 | RX_D1 | I | PD | 0 | Hi-Z | 0 | Hi-Z | I | PD |
| 35 | RX_D2 | I | PD | 0 | Hi-Z | 0 | Hi-Z | I | PD |
| 36 | RX_D3 | I | PD | 0 | Hi-Z | 0 | Hi-Z | I | PD |
| 37 | TX_CTRL / TX_EN | I | PD | I | PD | I | PD | I | PD |
| 38 | RX_CTRL / RX_DV | I | PD | 0 | Hi-Z | 0 | Hi-Z | I | Hi-Z |
| 40 | CLK_OUT | O (25MHz) | Hi-Z | O (25MHz) | Hi-Z | O (25MHz) | Hi-Z | O (25MHz) | Hi-Z |
| 41 | MDIO | I | Hi-Z | I/O | Hi-Z | I/O | Hi-Z | I/O | Hi-Z |
| 42 | MDC | I | Hi-Z | I | Hi-Z | I | Hi-Z | I | Hi-Z |
| 43 | RESET_N | I | PU | I | PU | I | PU | I | PU |
| 44 | INT_N / PWDN_N | I | PU | I/O | PU/OD-PU | I/O | PU/OD-PU | I/O | PU/OD-PU |
| 45 | LED_2 / GPIO_0 | I | PD | I/O | Hi-Z | I/O | Hi-Z | I/O | Hi-Z |
| 46 | LED_1/ RX_ER | I | PD | 0 | Hi-Z | 0 | Hi-Z | 0 | Hi-Z |
| 47 | LED_0 | I | PD | 0 | Hi-Z | 0 | Hi-Z | 0 | Hi-Z |



Table 5-3. Pin States-2

| | | MEDIA | NIVERTOR | | BRIDGI | E MODE | |
|--------|----------------------|-----------|-----------|-----------|-----------|-----------|-----------|
| PIN NO | PIN NAME | MEDIA CC | ONVERTOR | RGMII T | O SGMII | SGMII T | O RGMII |
| | | PIN STATE | PULL/HI-Z | PIN STATE | PULL/HI-Z | PIN STATE | PULL/HI-Z |
| 14 | SON | 0 | 50Ω | 0 | 50Ω | 0 | 50Ω |
| 15 | SOP | 0 | 50Ω | 0 | 50Ω | 0 | 50Ω |
| 16 | SIP | I | 50Ω | I | 50Ω | I | 50Ω |
| 17 | SIN | I | 50Ω | I | 50Ω | I | 50Ω |
| 21 | JTAG_CLK/ TX_ER | ı | PU | I | PU | 1 | PU |
| 22 | JTAG_TDO / GPIO_1 | 0 | Hi-Z | 0 | Hi-Z | 0 | Hi-Z |
| 23 | JTAG_TMS | I | PU | I | PU | I | PU |
| 24 | JTAG_TDI / SD | I | PU | I | PU | I | PU |
| 25 | TX_D3 | ı | PD | I | PD | I | PD |
| 26 | TX_D2 | ı | PD | I | PD | I | PD |
| 27 | TX_D1 | I | PD | I | PD | I | PD |
| 28 | TX_D0 | I | PD | I | PD | I | PD |
| 29 | GTX_CLK / TX_CLK | I | PD | I | PD | I | PD |
| 32 | RX_CLK | I | PD | 0 | Hi-Z | 0 | Hi-Z |
| 33 | RX_D0 | ı | PD | 0 | Hi-Z | 0 | Hi-Z |
| 34 | RX_D1 | ı | PD | 0 | Hi-Z | 0 | Hi-Z |
| 36 | RX_D2 | I | PD | 0 | Hi-Z | 0 | Hi-Z |
| 36 | RX_D3 | I | PD | 0 | Hi-Z | 0 | Hi-Z |
| 37 | TX_CTRL / TX_EN | I | PD | I | PD | I | PD |
| 38 | RX_CTRL / RX_DV | I | PD | 0 | Hi-Z | 0 | Hi-Z |
| 40 | CLK_OUT | O (25MHz) | Hi-Z | O (25MHz) | Hi-Z | O (25MHz) | Hi-Z |
| 41 | MDIO | I/O | Hi-Z | I/O | Hi-Z | I/O | Hi-Z |
| 42 | MDC | I | Hi-Z | I | Hi-Z | 1 | Hi-Z |
| 43 | RESET_N | I | PU | I | PU | I | PU |
| 44 | INT_N / PWDN_N | I/O | PU/OD-PU | I/O | PU/OD-PU | I/O | PU/OD-PU |
| 45 | LED_2 / GPIO_0 | I/O | Hi-Z | I/O | Hi-Z | I/O | Hi-Z |
| 46 | LED_1 / RX_ER | 0 | Hi-Z | 0 | Hi-Z | 0 | Hi-Z |
| 47 | LED_0 | 0 | Hi-Z | 0 | Hi-Z | 0 | Hi-Z |



Table 5-4. Pin States-3

| PIN NO | PIN NAME | | PWDN | MII IS | MII ISOLATE | | |
|--------|-------------------|------------|-----------|-----------|-------------|--|--|
| | | PIN STATE | PULL/HI-Z | PIN STATE | PULL/HI-Z | | |
| 14 | SON | 0 | 50Ω | 0 | 50Ω | | |
| 15 | SOP | 0 | 50Ω | 0 | 50Ω | | |
| 16 | SIP | I | 50Ω | 1 | 50Ω | | |
| 17 | SIN | 1 | 50Ω | 1 | 50Ω | | |
| 21 | JTAG_CLK/ TX_ER | I/O | PU | 1 | PU | | |
| 22 | JTAG_TDO / GPIO_1 | 0 | Hi-Z | 0 | Hi-Z | | |
| 23 | JTAG_TMS | 1 | PU | 1 | PU | | |
| 24 | JTAG_TDI / SD | 1 | PU | 1 | PU | | |
| 25 | TX_D3 | 1 | PD | 1 | PD | | |
| 26 | TX_D2 | 1 | PD | 1 | PD | | |
| 27 | TX_D1 | 1 | PD | 1 | PD | | |
| 28 | TX_D0 | 1 | PD | 1 | PD | | |
| 29 | GTX_CLK / TX_CLK | 1 | PD | 1 | PD | | |
| 32 | RX_CLK | O (2.5MHz) | Hi-Z | 1 | PD | | |
| 33 | RX_D0 | 0 | Hi-Z | 1 | PD | | |
| 34 | RX_D1 | 0 | Hi-Z | 1 | PD | | |
| 36 | RX_D2 | 0 | Hi-Z | I | PD | | |
| 36 | RX_D3 | 0 | Hi-Z | I | PD | | |
| 37 | TX_CTRL / TX_EN | 1 | PD | I | PD | | |
| 38 | RX_CTRL / RX_DV | 0 | Hi-Z | 1 | PD | | |
| 40 | CLK_OUT | O (25MHz) | Hi-Z | O (25MHz) | Hi-Z | | |
| 41 | MDIO | 1 | Hi-Z | I | Hi-Z | | |
| 42 | MDC | 1 | Hi-Z | I | Hi-Z | | |
| 43 | RESET_N | 1 | PU | I | PU | | |
| 44 | INT_N / PWDN_N | I/O | PU/OD-PU | I/O | PU/OD-PU | | |
| 45 | LED_2 / GPIO_0 | 0 | Hi-Z | 0 | Hi-Z | | |
| 46 | LED_1 / RX_ER | 0 | Hi-Z | 0 | Hi-Z | | |
| 47 | LED_0 | 0 | Hi-Z | 0 | Hi-Z | | |

Note: Please leave Hi-Z pins floating or NC. If needed, please connect Hi-Z pins to GND with $10k\Omega$ pull-down resistor.

6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)(1)

| | PARAMETER | MIN | MAX | UNIT |
|---------------------|--------------------------------|------|----------------|------|
| Supply voltage | VDD1P1 | -0.5 | 1.4 | V |
| | VDD1P8 | -0.5 | 2.16 | V |
| | VDD2P5 | -0.5 | 3 | V |
| | VDDIO (3V3) | -0.5 | 3.8 | V |
| | VDDIO (2V5) | -0.5 | 3 | V |
| | VDDIO (1V8) | -0.5 | 2.1 | V |
| Pins | MDI | -0.5 | 6.5 | V |
| Pins | MAC Interface, MDIO, MDC, GPIO | -0.5 | VDDIO + 0.3 | V |
| Pins | INT/PWDN, RESET | -0.5 | VDDIO + 0.3 | V |
| Pins | JTAG | -0.5 | VDDIO + 0.3 | V |
| Storage temperature | Tstg | -60 | 150 | С |

⁽¹⁾ Stresses beyond those listed under Absolute Maximum Rating may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Condition. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

6.2 ESD Ratings

| | | Parameter | | VALUE | UNIT |
|--------------------|---|---|-------------------------|---------|------|
| | Human-body model (HBM), per | All pins except MDI | +/-2500 | | |
| | V _(ESD) V(ESD) Electrostatic discharge | ANSI/ESDA/JEDEC JS-001(1) | MDI pins ⁽²⁾ | +/-8000 | |
| V _(ESD) | | Charged-device model (CDM), per JEDEC specification JESD22- C101 ⁽³⁾ | All Pins | +/-1500 | V |
| | | IEC 61000-4-2 contact discharge | MDI pins | +/-8000 | V |

⁽¹⁾ JEDEC document JEP155 states that 500V HBM allows safe manufacturing with a standard ESD control process. Manufacturing with less than 500V HBM is possible with the necessary precautions. Pins listed as ±8kV and/or ± 2kV can actually have higher performance.

6.3 Recommended Operating Conditions

| | Parameter | MIN | NOM | MAX | UNIT |
|----------------|--|-------|-----|-------|------|
| | Digital Supply Voltage, 1.8V operation | 1.71 | 1.8 | 1.89 | |
| VDDIO | Digital Supply Voltage, 2.5V operation | 2.375 | 2.5 | 2.625 | V |
| | Digital Supply Voltage, 3.3V operation | 3.15 | 3.3 | 3.45 | |
| VDD1P1 | Digital Supply | 0.99 | 1.1 | 1.21 | V |
| VDDA1P8 | Analog Supply | 1.71 | 1.8 | 1.89 | V |
| VDDA2P5 | Analog Supply | 2.375 | 2.5 | 2.625 | V |
| T _A | Operating Ambient Temperature | -40 | | 125 | °C |
| T _j | Operating Junction Temperature | -40 | | 140 | °C |

⁽²⁾ MDI Pins tested as per IEC 61000-4-2 standards.

⁽³⁾ JEDEC document JEP157 states that 250V CDM allows safe manufacturing with a standard ESD control process. Manufacturing with less than 250V CDM is possible with the necessary precautions. Pins listed as ±500V can actually have higher performance.



6.4 Thermal Information

| | THERMAL METRIC ⁽¹⁾ | 48PIN VQFN | UNIT |
|-----------------------|--|------------|------|
| $R_{\theta JA}$ | Junction-to-ambient thermal resistance | 30.8 | °C/W |
| R _{θJC(top)} | Junction-to-case (top) thermal resistance | 18.7 | °C/W |
| R _{0JC(bot)} | Junction-to-case (bottom) thermal resistance | 1.4 | °C/W |
| R _{0JB} | Junction-to-board thermal resistance | 7.5 | °C/W |
| Ψ_{JT} | Junction-to-top characterization parameter | 0.3 | °C/W |
| Ψ_{JB} | Junction-to-board characterization parameter | 7.5 | °C/W |

⁽¹⁾ For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

6.5 Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-------|--|---|------|-------|----------|------|
| 1000E | Base-X/100Base-FX/SGMII INPUT | | | | | |
| | Input differential voltage tolerance | SI_P and SI_N, AC coupled | 0.3 | 0.5 | 2.0 | V |
| | Receiver differential input impedance (DC) | | 80 | 100 | 120 | Ω |
| | Frequency tolerance | SI_P and SI_N, AC coupled | -100 | | +100 | ppm |
| 1000E | Base-X OUTPUT | | | | ' | |
| | Clock signal duty cycle | SO_P and SO_N, AC coupled, 0101010101 pattern | 48 | | 52 | % |
| | Vod fall time (20%-80%) | SO_P and SO_N, AC coupled, 0101010101 pattern | 100 | | 200 | ps |
| | Vod rise time (20%-80%) | SO_P and SO_N, AC coupled, 0101010101 pattern | 100 | | 200 | ps |
| | Total Ouput Jitter | SO_P and SO_N, AC coupled | | 192 | | ps |
| | Output Differential Voltage | SO_P and SO_N, AC coupled | 1060 | 1100 | 1140 | mV |
| 100B | ase-FX OUTPUT | | | | ' | |
| | Clock signal duty cycle at 625MHz | SO_P and SO_N, AC coupled | | | 55 | % |
| | Vod fall time (20%-80%) | SO_P and SO_N, AC coupled | | | 330 | ps |
| | Vod rise time (20%-80%) | SO_P and SO_N, AC coupled | | | 330 | ps |
| | Jitter | SO_P and SO_N, AC coupled | | | 192 | ps |
| | Output Differential Voltage | SO_P and SO_N, AC coupled | 450 | | 910 | mV |
| SGMI | I OUTPUT | | | | ' | |
| | Clock signal duty cycle at 625MHz | SO_P and SO_N, AC coupled, 0101010101 pattern | 48 | | 52 | % |
| | Vod fall time (20%-80%) | SO_P and SO_N, AC coupled, 0101010101 pattern | 100 | | 200 | ps |
| | Vod rise time (20%-80%) | SO_P and SO_N, AC coupled, 0101010101 pattern | 100 | | 200 | ps |
| | Output Jitter | SO_P and SO_N, AC coupled | | | 300 | ps |
| | Output Differential Voltage | SO_P and SO_N, AC coupled | 1060 | 1100 | 1140 | mV |
| IEEE | Tx CONFORMANCE (1000BaseT) | | | - | | |
| | Output Differential Voltage | Normal Mode, All channels | 0.67 | 0.745 | 0.82 | V |
| IEEE | Tx CONFORMANCE (100BaseTx) | | | | <u>'</u> | |
| | Output Differential Voltage | Normal Mode, Channels A and B | 0.95 | 1.00 | 1.05 | V |
| IEEE | Tx CONFORMANCE (10BaseTe) | | | | | |
| | Output Differential Voltage | | | 1.75 | | V |

Product Folder Links: *DP83869HM*



| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|----------|-----------------------------|--|-----|-----|-----|------|
| POWER | CONSUMPTION Copper mode (10 | 0m cable) | | | 1 | |
| | RGMII to Copper (1G) | | | 483 | | mW |
| | RGMII to Copper (100M) | | | 215 | | mW |
| | RGMII to Copper (10M) | | | 260 | | mW |
| . | MII to Copper (100M) | Room Temperature, Nominal supply | | 212 | | mW |
| Total | MII to Copper (10M) | voltages | | 261 | | mW |
| | SGMII to Copper (1G) | | | 496 | | mW |
| | SGMII to Copper (100M) | | | 251 | | mW |
| | SGMII to Copper (10M) | | | 294 | | mW |
| | RGMII to Copper (1G) | | | 131 | 195 | mA |
| | RGMII to Copper (100M) | | | 47 | 110 | mA |
| | RGMII to Copper (10M) | | | 37 | 100 | mA |
| | MII to Copper (100M) | | | 43 | 110 | mA |
| I(1V1) | MII to Copper (10M) | Room Temperature, 1.1V supply voltage | | 36 | 95 | mA |
| | SGMII to Copper (1G) | | | 141 | 220 | mA |
| | SGMII to Copper (100M) | | | 60 | 125 | mA |
| | SGMII to Copper (10M) | | | 50 | 112 | mA |
| | RGMII to Copper (1G) | | | 52 | 55 | mA |
| | RGMII to Copper (100M) | | | 21 | 26 | mA |
| | RGMII to Copper (10M) | | | 11 | 15 | mA |
| | MII to Copper (100M) | | | 21 | 26 | mA |
| I(1V8) | MII to Copper (10M) | Room Temperature, 1.8V supply voltage | | 10 | 15 | mA |
| | SGMII to Copper (1G) | | | 55 | 60 | mA |
| | SGMII to Copper (100M) | | | 24 | 28 | mA |
| | SGMII to Copper (10M) | | | 14 | 18 | mA |
| | RGMII to Copper (1G) | | | 86 | 100 | mA |
| | RGMII to Copper (100M) | | | 46 | 50 | mA |
| | RGMII to Copper (10M) | | | 76 | 90 | mA |
| 1/01/51 | MII to Copper (100M) | Decre Terrorestore 2.51/ somehoveltere | | 45 | 52 | mA |
| I(2V5) | MII to Copper (10M) | Room Temperature, 2.5V supply voltage | | 78 | 92 | mA |
| | SGMII to Copper (1G) | | | 93 | 100 | mA |
| | SGMII to Copper (100M) | | | 53 | 58 | mA |
| | SGMII to Copper (10M) | | | 82 | 95 | mA |
| | RGMII to Copper (1G) | | | 30 | 80 | mA |
| | RGMII to Copper (100M) | | | 13 | 22 | mA |
| | RGMII to Copper (10M) | | | 10 | 16 | mA |
| I(VDDIO | MII to Copper (100M) | Doom Tomographics 2.207 completely | | 15 | 66 | mA |
| =3.3V) | MII to Copper (10M) | Room Temperature, 3.3V supply voltage | | 11 | 38 | mA |
| | SGMII to Copper (1G) | | | 10 | 16 | mA |
| | SGMII to Copper (100M) | | | 10 | 16 | mA |
| | SGMII to Copper (10M) | | | 10 | 16 | mA |



over operating free-air temperature range (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | MIN TYP | MAX | UNIT |
|-------------------|------------------------|---|---------|-----|------|
| | RGMII to Copper (1G) | | 17 | 30 | mA |
| I(VDDIO | RGMII to Copper (100M) | | 6 | 12 | mA |
| | RGMII to Copper (10M) | | 5 | 10 | mA |
| | MII to Copper (100M) | D. T. | 8 | 15 | mA |
| =1.8V) | MII to Copper (10M) | Room Temperature, 1.8V supply voltage | 5 | 10 | mA |
| | SGMII to Copper (1G) | | 5 | 10 | mA |
| | SGMII to Copper (100M) | | 5 | 10 | mA |
| | SGMII to Copper (10M) | | 5 | 10 | mA |
| POWER | CONSUMPTION Fiber mode | | | | |
| | RGMII to 1000Base-X | | 142 | | mW |
| Total | RGMII to 100Base-FX | Room Temperature, Nominal supply voltages | 111 | | mW |
| | MII to 100Base-FX | Voltages | 107 | | mW |
| | RGMII to 1000Base-X | | 52 | | mA |
| I(1V1) | RGMII to 100Base-FX | Room Temperature, 1.1V supply voltage | 44 | | mA |
| | MII to 100Base-FX | | 41.8 | | mA |
| | RGMII to 1000Base-X | | 14 | | mA |
| I(1V8) | RGMII to 100Base-FX | Room Temperature, 1.8V supply voltage | 14 | | mA |
| | MII to 100Base-FX | | 12 | | mA |
| | RGMII to 1000Base-X | | 11 | | mA |
| I(2V5) | RGMII to 100Base-FX | Room Temperature, 2.5V supply voltage | 10 | | mA |
| | MII to 100Base-FX | | 10 | | mA |
| | RGMII to 1000Base-X | | 32 | | mA |
| I(VDDIO =3.3V) | RGMII to 100Base-FX | Room Temperature, 3.3V supply voltage | 14 | | mA |
| -3.3V) | MII to 100Base-FX | | 16 | | mA |
| | RGMII to 1000Base-X | | 18 | | mA |
| I(VDDIO =1.8V) | RGMII to 100Base-FX | Room Temperature, 1.8V supply voltage | 7 | | mA |
| -1.0V) | MII to 100Base-FX | | 8 | | mA |
| POWER | CONSUMPTION R2S mode | | | | |
| | RGMII to SGMII (1G) | | 142 | | mW |
| Total | RGMII to SGMII (100M) | Room Temperature, Nominal supply voltages | 120 | | mW |
| | RGMII to SGMII (10M) | voltages | 117 | | mW |
| | RGMII to SGMII (1G) | | 52 | | mA |
| I(1V1) | RGMII to SGMII (100M) | Room Temperature, 1.1V supply voltage | 50 | | mA |
| | RGMII to SGMII (10M) | | 49 | | mA |
| | RGMII to SGMII (1G) | | 14 | | mA |
| I(1V8) | RGMII to SGMII (100M) | Room Temperature, 1.8V supply voltage | 13 | | mA |
| | RGMII to SGMII (10M) | | 14 | | mA |
| | RGMII to SGMII (1G) | | 11 | | mA |
| I(2V5) | RGMII to SGMII (100M) | Room Temperature, 2.5V supply voltage | 11 | | mA |
| | RGMII to SGMII (10M) | | 11 | | mA |
| | RGMII to SGMII (1G) | | 32 | | mA |
| I(VDDIO =3.3V) | RGMII to SGMII (100M) | Room Temperature, 3.3V supply voltage | 15 | | mA |
| -3.3V) | RGMII to SGMII (10M) | | 12 | | mA |

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| | PARAMETER | TEST CONDITIONS | MIN TYP | MAX | UNIT |
|--------------------|--------------------------------|---|------------------|------------------|------|
| | RGMII to SGMII (1G) | | 18 | | mA |
| I(VDDIO =1.8V) | RGMII to SGMII (100M) | Room Temperature, 1.8V supply voltage | 8 | | mA |
| 1.0 0) | RGMII to SGMII (10M) | | 6 | | mA |
| POWER (| CONSUMPTION S2R mode | ' | | | |
| | SGMII to RGMII (1G) | | 142 | | mW |
| Total | SGMII to RGMII (100M) | Room Temperature, Nominal supply voltages | 121 | | mW |
| | SGMII to RGMII (10M) | voltages | 117 | | mW |
| | SGMII to RGMII (1G) | | 52 | | mA |
| I(1V1) | SGMII to RGMII (100M) | Room Temperature, 1.1V supply voltage | 49 | | mA |
| | SGMII to RGMII (10M) | | 49 | | mA |
| | SGMII to RGMII (1G) | | 14 | | mA |
| I(1V8) | SGMII to RGMII (100M) | Room Temperature, 1.8V supply voltage | 14 | | mA |
| | SGMII to RGMII (10M) | | 14 | | mA |
| | SGMII to RGMII (1G) | | 11 | | mA |
| I(2V5) | SGMII to RGMII (100M) | Room Temperature, 2.5V supply voltage | 11 | | mA |
| | SGMII to RGMII (10M) | | 11 | | mA |
| | SGMII to RGMII (1G) | | 33 | | mA |
| I(VDDIO =3.3V) | SGMII to RGMII (100M) | Room Temperature, 3.3V supply voltage | 16 | | mA |
| 0.01) | SGMII to RGMII (10M) | | 13 | | mA |
| | SGMII to RGMII (1G) | | 18 | | mA |
| I(VDDIO =1.8V) | SGMII to RGMII (100M) | Room Temperature, 1.8V supply voltage | 8 | | mA |
| -1.0 <i>V</i>) | SGMII to RGMII (10M) | | 6 | | mA |
| POWER (| CONSUMPTION Cu-Fiber mode (100 | m cable) | | 1 | |
| Takal | 1000Base-TX to 1000Base-FX | Room Temperature, Nominal supply | 495 | | mW |
| Total | 100Base-TX to 100Base-FX | voltage | 243 | | mW |
| 1/41/41 | 1000Base-TX to 1000Base-FX | Door Town costume 4.41/ complex celtars | 142 | | mA |
| I(1V1) | 100Base-TX to 100Base-FX | Room Temperature, 1.1V supply voltage | 55 | | mA |
| 1/41/01 | 1000Base-TX to 1000Base-FX | Door Town out we 4 0) / our plus of town | 55 | | mA |
| I(1V8) | 100Base-TX to 100Base-FX | Room Temperature, 1.8V supply voltage | 24 | | mA |
| 1/0)/5) | 1000Base-TX to 1000Base-FX | Dear Terror continue 2.51/ complex colteges | 93 | | mA |
| I(2V5) | 100Base-TX to 100Base-FX | Room Temperature, 2.5V supply voltage | 52 | | mA |
| I(VDDIO | 1000Base-TX to 1000Base-FX | Doom Tomporature 2 21/ supply valtage | 9 | | mA |
| =3.3V) | 100Base-TX to 100Base-FX | Room Temperature, 3.3V supply voltage | 10 | | mA |
| I(VDDIO | 1000Base-TX to 1000Base-FX | Doom Tomporature 1 9)/ cumply voltage | 4 | | mA |
| =1.8V) | 100Base-TX to 100Base-FX | Room Temperature, 1.8V supply voltage | 5 | | mA |
| POWER (| CONSUMPTION Low power modes | | | | |
| Total | IEEE Power Down | | 76 | | mW |
| | Active Sleep | Room Temperature, Nominal Voltages | 165 | | mW |
| | RESET | | 82 | | mW |
| воотѕті | RAP DC CHARACTERISTICS (4 Leve | el) (PHY address pins) | | 1 | |
| V _{MODE0} | Mode 0 Strap Voltage Range | | 0 | 0.093 x VDDIO | V |
| V _{MODE1} | Mode 1 Strap Voltage Range | | 0.136 x VDDIO | 0.184 x VDDIO | V |



| | PARAMETER | TEST CONDITIONS | MIN | TYP MAX | UNIT |
|--------------------|----------------------------------|-----------------|------------------|------------------|----------|
| V _{MODE2} | Mode 2 Strap Voltage Range | | 0.219 x VDDIO | 0.280 x VDDIO | V |
| V _{MODE3} | Mode 3 Strap Voltage Range | | 0.6 x VDDIO | 0.888 x VDDIO | ٧ |
| воотѕт | RAP DC CHARACTERISTICS (2 Level) | | | | |
| V _{MODE0} | Mode 0 Strap Voltage Range | | 0 | 0.18 x VDDIO | V |
| V _{MODE1} | Mode 1 Strap Voltage Range | | 0.5 x VDDIO | 0.88 x VDDIO | ٧ |



| | PARAMETER | TEST CONDITIONS | MIN | TYP MA | X UNIT |
|---------------------|--|---|----------------|--------------|---------------------------------------|
| IO CHA | RACTERISTICS | | | | |
| V _{IH} | High Level Input Voltage | VDDIO = 3.3V ±5% | 2 | | V |
| V _{IL} | Low Level Input Voltage | VDDIO = 3.3V ±5% | | 0. | 8 V |
| V _{OH} | High Level Output Voltage | I _{OH} = -2mA, VDDIO = 3.3V ±5% | 2.4 | | V |
| V _{OL} | Low Level Output Voltage | I _{OL} = 2mA, VDDIO = 3.3V ±5% | | 0. | 4 V |
| V _{IH} | High Level Input Voltage | VDDIO = 2.5V ±5% | 1.7 | | V |
| V _{IL} | Low Level Input Voltage | VDDIO = 2.5V ±5% | | 0. | 7 V |
| V _{OH} | High Level Output Voltage | I _{OH} = -2mA, VDDIO = 2.5V ±5% | 2 | | V |
| V _{OL} | Low Level Output Voltage | I _{OL} = 2mA, VDDIO = 2.5V ±5% | | 0. | 4 V |
| V _{IH} | High Level Input Voltage | VDDIO = 1.8V ±5% | 0.65*VD DIO | | V |
| V _{IL} | Low Level Input Voltage | VDDIO = 1.8V ±5% | | 0.35*V DI | · · · · · · · · · · · · · · · · · · · |
| V _{OH} | High Level Output Voltage | I _{OH} = -2mA, VDDIO = 1.8V ±5% | VDDIO-0 .45 | | V |
| V _{OL} | Low Level Output Voltage | I _{OL} = 2mA, VDDIO = 1.8V ±5% | | 0.4 | 5 V |
| I _{IH} | Input High Current | T _A = -40°C to 125°C, VIN=VDDIO | -20 | 2 | 0 μΑ |
| I _{IL} | Input Low Current | T _A = -40°C to 125°C, VIN=GND | -20 | 2 | 0 μΑ |
| lozh | Tri-state Output High Current | T _A = -40°C to 125°C, VOUT=VDDIO | -20 | 2 | 0 μΑ |
| lozl | Tri-state Output Low Current | T _A = -40°C to 125°C, VOUT=GND | -20 | 2 | 0 μΑ |
| R _{pulldn} | Internal Pull Down Resistor | | 6.75 | 9 11.2 | 5 kΩ |
| XI V _{IH} | High Level Input Voltage | | 1.2 | VDDI | O V |
| XI V _{IL} | Low Level Input Voltage | | | 0. | 6 V |
| C _{IN} | Input Capacitance XI | | | 1 | pF |
| C _{IN} | Input Capacitance INPUT PINS | | | 5 | pF |
| C _{OUT} | Output Capacitance XO | | | 1 | pF |
| C _{OUT} | Output Capacitance OUTPUT PINS | | | 5 | pF |
| R _{series} | Integrated MAC Series Termination Resistor | RX_D[3:0], RX_ER, RX_DV, RX_CLK | | 50 | Ω |



6.6 Timing Requirements

| | PARAMETER | MIN | NOM | MAX | UNIT |
|--------------------------|--|------|------|------|------|
| POWER-UF | P TIMING (2, 3 supply mode) | | | | |
| T1 | Last Supply power up To Reset Release: External or via R-C network | 200 | | | ms |
| T2 | Powerup to SMI ready: Post power-up stabilization time prior to MDC preamble for register access | | 200 | | ms |
| Т3 | Powerup to Strap latchin: Hardware configuration pins transition to output drivers | | 200 | | ms |
| RESET TIM | ING | | | | |
| T1 | Reset to SMI ready: Post reset stabilization time prior to MDC preamble for register access | 30 | | | us |
| Т3 | RESET PULSE Width: Miminum Reset pulse width to be able to reset | 720 | | | ns |
| T4 | Reset to FLP | | 1750 | | ms |
| T4 | Reset to 100M signaling (strapped mode) | | 194 | | us |
| T4 | Reset to 1G signaling (strapped mode) | | 194 | | us |
| T4 | Reset to Fiber 100M signaling | | 248 | | us |
| T4 | Reset to Fiber 1G ANEG signaling | | 235 | | us |
| T4 | Reset to Fiber 1G Forced signaling | | 235 | | us |
| T4 | Reset to MAC clock (Cu mode) | | 195 | | us |
| T4 | Reset to MAC clock (Fi mode) | | 248 | | us |
| T4 | Reset to MAC clock (S2R) | | 248 | | us |
| T4 | Reset to MAC clock (R2S) | | 248 | | us |
| COPPER L | INK TIMING | | | | |
| T4 | Loss of Idles to Link LED low in Fast link down mode (100M) | | 4.3 | 10 | us |
| T1 | Loss of Idles to Link LED low in Fast link down mode (1000M) | | 7 | 10 | us |
| MII TIMING | (100M) | | | ' | |
| T1 | TX_CLK High / Low Time | 16 | 20 | 24 | ns |
| T2 | TX_D[3:0], TX_ER, TX_EN Setup to TX_CLK | 10 | | | ns |
| T3 | TX_D[3:0], TX_ER, TX_EN Hold from TX_CLK | 0 | | | ns |
| T1 | RX_CLK High / Low Time | 16 | 20 | 24 | ns |
| T2 | RX_D[3:0], RX_ER, RX_DV Delay from RX_CLK rising | 10 | | 30 | ns |
| RGMII OUT | PUT TIMING (1G) | | | | |
| T _{skewT} | Data to Clock Output Skew (Non-Delay Mode) | -600 | | 600 | ps |
| T _{skewT(Delay} | Data to Clock Output Setup (Delay Mode) | 1.4 | | 2.6 | ns |
| T _{setupT} | Data to Clock Output Setup (Delay Mode) | 1.2 | | | ns |
| T _{holdT} | Data to Clock Output Hold (Delay Mode) | 1.2 | | | ns |
| T _{cyc} | Clock Cycle Duration | 7.2 | 8 | 8.8 | ns |
| | Duty Cycle | 45 | 50 | 55 | % |
| | Rise / Fall Time (20% to 80%) | | | 0.75 | ns |
| RGMII INPL | JT TIMING (1G) | | | | |
| T _{setupR} | TX data to clock input setup (Non-Delay Mode) | 1 | | | ns |
| T _{holdR} | TX clock to data input hold (Non-Delay Mode) | 1 | | | ns |
| | TX data to clock input setup (Delay Mode, 2ns delay) | -1 | | | ns |
| | TX clock to data input hold (Delay Mode, 2ns delay) | 3 | | | ns |
| SMI TIMINO | 6 | | | | |
| T1 | MDC to MDIO (Output) Delay Time | 0 | | 10 | ns |
| T2 | MDIO (Input) to MDC Setup Time | 10 | | | ns |



6.6 Timing Requirements (continued)

| PARAMETER | | MIN | NOM | MAX | UNIT |
|-----------|-------------------------------|-----|-----|-----|------|
| T3 | MDIO (Input) to MDC Hold Time | 10 | | | ns |
| T4 | MDC Frequency | | 2.5 | 25 | MHz |



6.6 Timing Requirements (continued)

| | PARAMETER | MIN | NOM | MAX | UNIT |
|----------|--|------|-----|------|------|
| OUTPUT | CLOCK TIMING (25MHz clockout) | , | | | |
| | Frequency (PPM) | -100 | | 100 | - |
| | Duty Cycle | 40 | | 60 | % |
| | Rise Time | | | 5000 | ps |
| | Fall Time | | | 5000 | ps |
| | Frequency | | 25 | | MHz |
| | Jitter (Long Term) | | | 375 | ps |
| OUTPUT | CLOCK TIMING (SyncE 125/5 MHz recovered clock) | | | | |
| | Frequency (PPM) | -100 | | 100 | ppm |
| | Duty Cycle | 40 | | 60 | % |
| | Rise time | | | 2500 | ps |
| | Fall Time | | | 2500 | ps |
| | Jitter (Long Term) | | | 1000 | ps |
| 25MHz IN | PUT CLOCK tolerance | | | | |
| | Frequency Tolerance | -100 | | +100 | ppm |
| | Rise / Fall Time (10%-90%) | | | 8 | ns |
| | Jitter Tolerance (Accumulated : TIE over 100K cycles) | | 75 | | ps |
| | Duty Cycle | 40 | | 60 | % |
| TRANSMI | T LATENCY TIMING | | | | |
| Copper | RGMII to Cu (100M): Rising edge TX_CLK with assertion TX_CTRL to SSD symbol on MDI | | 169 | | ns |
| Copper | RGMII to Cu (1G): Roundtrip Latency (Transmit + Receive) | | | 384 | ns |
| RECEIVE | LATENCY TIMING | | | ' | |
| Copper | Cu to RGMII (100M): SSD symbol on MDI to a) Rising edge of RX_DV with assertion of RX_CTRL b) Rising edge of RX_DV with assertion of RX_Dx | | 192 | | ns |
| | 1 | | | | |

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6.7 Timing Diagrams

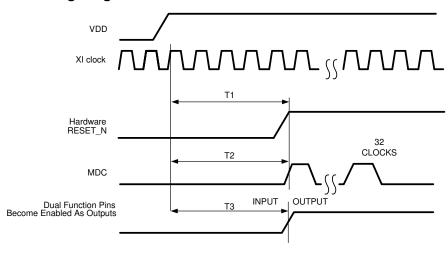


Figure 6-1. Power-Up Timing

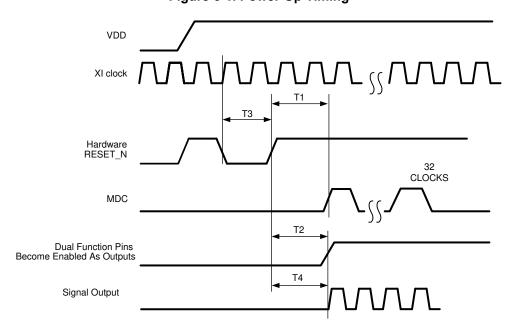


Figure 6-2. Reset Timing



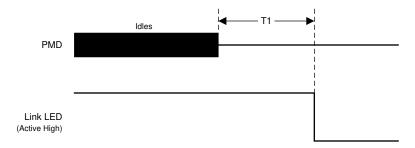


Figure 6-3. Copper Link Timing

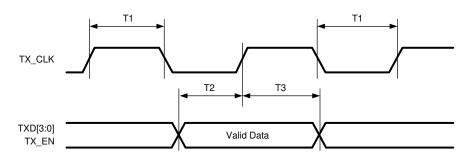


Figure 6-4. 100Mbps MII Transmit Timing

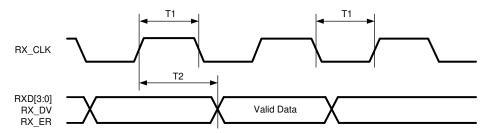


Figure 6-5. 100Mbps MII Receive Timing

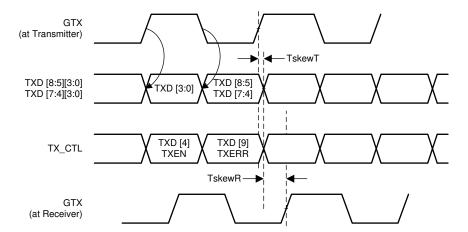


Figure 6-6. RGMII Transmit Multiplexing and Timing Diagram

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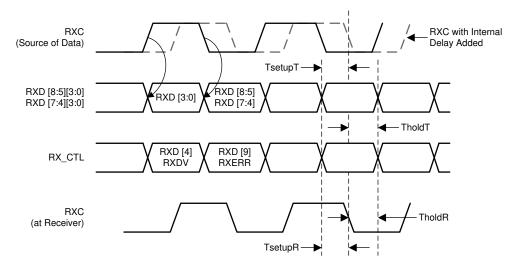


Figure 6-7. RGMII Receive Multiplexing and Timing Diagram

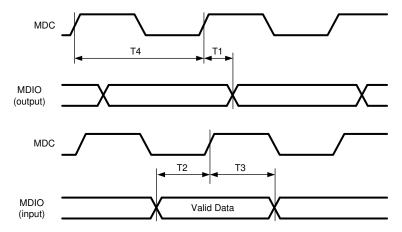
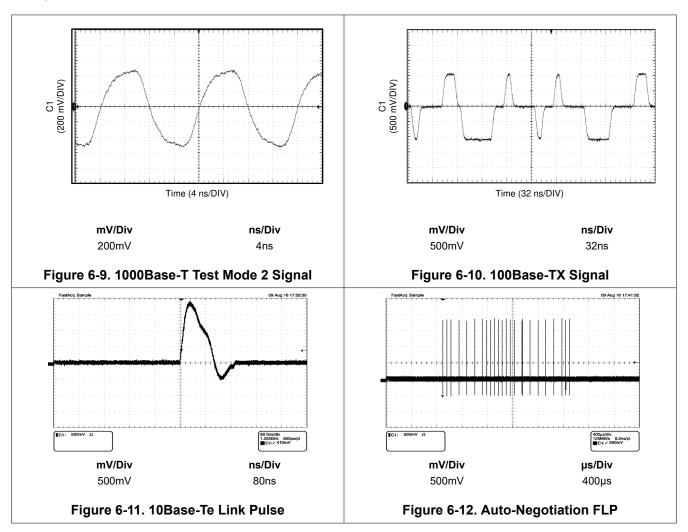


Figure 6-8. Serial Management Interface Timing



6.8 Typical Characteristics



7 Detailed Description

7.1 Overview

The DP83869HM is a fully-featured Gigabit Physical Layer transceiver with support for Fiber and Copper Ethernet standards. The DP83869HM can support IEEE802.3 10BASE-Te, 100BASE-TX, and 1000BASE-T Copper Ethernet protocols, along with 100BASE-FX and 1000BASE-X Fiber Ethernet protocols.

The DP83869HM is designed for easy implementation of 10Mbps, 100Mbps, and 1000Mbps Ethernet LANs. In Copper mode, the PHY can interface with twisted-pair media through magnetics. In Fiber Mode, the DP83869HM can interface with Fiber Optic Transceivers. This device interfaces directly to the MAC layer through the Reduced GMII (RGMII) or Serial GMII (SGMII). SGMII is available only in copper Ethernet mode. MII mode is supported for 10M and 100M speeds.

The DP83869HM supports media convertor mode to interface between copper and fiber Ethernet interface. Media convertor is available for 100M and 1000M speeds.

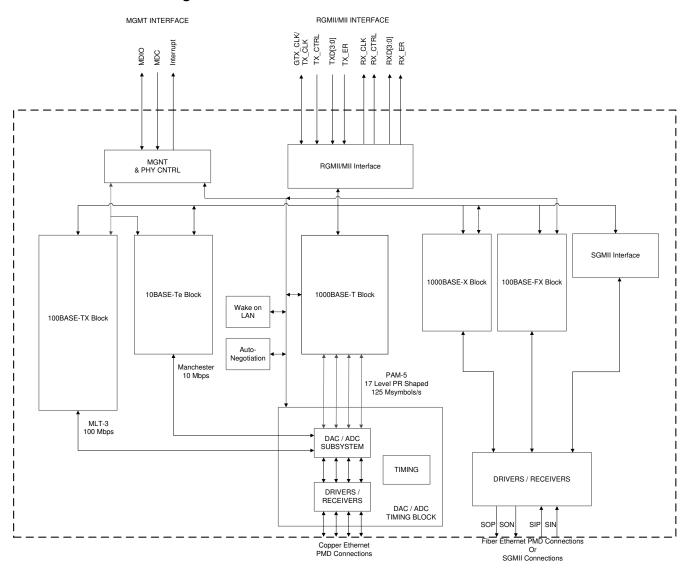
The DP83869HM can also support bridge mode to interface between SGMII and RGMII.

The DP83869HM offers low latency. This device provides IEEE 1588 Start of Frame Delimiter indication. The DP83869HM has option to provide recovered clock for synchronous Ethernet application.

The DP83869HM has a TDR cable diagnostic feature for fault detection on the Ethernet cable.



7.2 Functional Block Diagram



7.3 Feature Description

7.3.1 WoL (Wake-on-LAN) Packet Detection

Wake-on-LAN provides a mechanism to detect specific frames and notify the connected MAC through either a register status change, GPIO indication, or an interrupt flag. The WoL feature within the DP83869HM allows for connected devices placed above the Physical Layer to remain in a low power state until frames with the qualifying credentials are detected. Supported WoL frame types include: Magic Packet, Magic Packet with SecureOn, and Custom Pattern Match. When a qualifying WoL frame is received, the DP83869HM WoL logic circuit is able to generate a user-defined event (either pulses or level change) through any of the GPIO pins or a status interrupt flag to inform a connected controller that a wake event has occurred.

The Wake-on-LAN feature includes the following functionality:

- · Identification of magic packets in all supported speeds
- · Wake-up interrupt generation upon receiving a valid magic packet
- · CRC checking of magic packets to prevent interrupt generation for invalid packets

In addition to the basic magic packet support, the DP83869HM also supports:

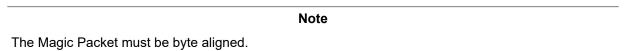
- Magic packets that include a SecureOn password
- Pattern match one configurable 64-byte pattern of that can wake up the MAC similar to magic packet
- · Independent configuration for Wake on Broadcast and Unicast packet types.

Note

DP838xx Wake-on-LAN app note provides further details and examples of Wake-on-LAN

7.3.1.1 Magic Packet Structure

When configured for Magic Packet mode, the DP83869HM scans all incoming frames addressed to the node for a specific data sequence. This sequence identifies the frame as a Magic Packet frame.



A Magic Packet frame must also meet the basic requirements for the LAN technology chosen, such as SOURCE ADDRESS, DESTINATION ADDRESS (which can be the receiving station's IEEE address or a BROADCAST address), and CRC.

The specific Magic Packet sequence consists of 16 duplications of the IEEE address of this node, with no breaks or interruptions, followed by a SecureOn password if security is enabled. This sequence can be located anywhere within the packet, but must be preceded by a synchronization stream. The synchronization stream is defined as 6 bytes of FFh.



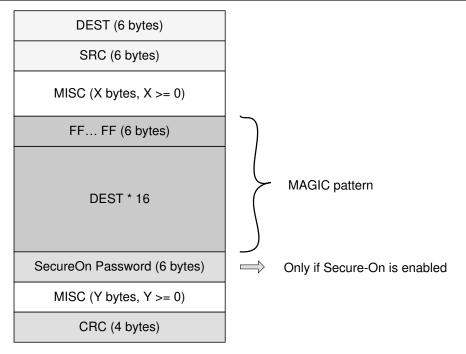


Figure 7-1. Magic Packet Structure

7.3.1.2 Wake-on-LAN Configuration and Status

Table 7-1. Magic Packet Detection Registers

| REGISTER NAME | DP83869 ADDRESS |
|--------------------------------------|-----------------|
| Receive Configuration Register | Reg 0x134 |
| Receive Status Register | Reg 0x135 |
| MAC Destination Address Registers | Reg 0x136-0x138 |
| Receive Secure-ON Password Registers | Reg 0x139-0x13B |
| Byte Mask | Reg 0x15C-0x15F |

7.3.2 Start of Frame Detect for IEEE 1588 Time Stamp

The DP83869HM supports an IEEE 1588 indication pulse at the SFD (start frame delimiter) for the receive and transmit paths. The pulse can be delivered to various pins. The pulse indicates the actual time the symbol is presented on the lines (for transmit), or the first symbol received (for receive). The exact timing of the pulse can be adjusted through register. Each increment of phase value is an 8ns step.

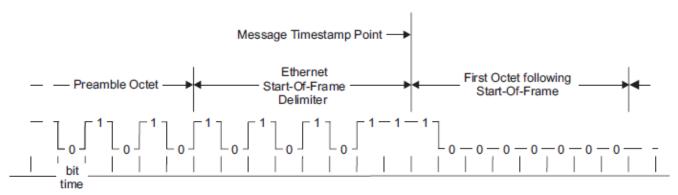


Figure 7-2. IEEE 1588 Message Timestamp Point

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The SFD pulse output can be configured using the GPIO Mux Control register GPIO_MUX_CTRL (register address 1E0h). The ENHANCED_MAC_SUPPORT bit in RXCFG (register address 134h) must also be set to allow output of the SFD.

7.3.2.1 SFD Latency Variation and Determinism

Time stamping packet transmission and reception using the RX_CTRL and TX_CTRL signals of RGMII is not accurate enough for latency sensitive protocols. SFD pulses offers system designers a method to improve the accuracy of packet time stamping. The SFD pulse, while varying less than RGMII signals inherently, still exhibits latency variation due to the defined architecture of 1000BASE-T. This section provides a method to determine when an SFD latency variation has occurred and how to compensate for the variation in system software to improve timestamp accuracy.

In the following section the terms baseline latency and SFD variation are used. Baseline latency is the time measured between the TX_SFD pulse to the RX_SFD pulse of a connected link partner, assuming an Ethernet cable with all 4 pairs perfectly matched in propagation time. In the scenario where all 4 pairs being perfectly matched, a 1000BASE-T PHY do not have to align the 4 received symbols on the wire and do not introduce extra latency due to alignment.

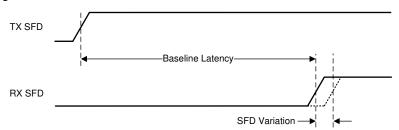


Figure 7-3. Baseline Latency and SFD Variation in Latency Measurement

SFD variation is additional time added to the baseline latency before the RX_SFD pulse when the PHY must introduce latency to align the 4 symbols from the Ethernet cable. Variation can occur when a new link is established either by cable connection, auto-negotiation restart, PHY reset, or other external system effects. During a single, uninterrupted link, the SFD variation remains constant.

The DP83869HM can limit and report the variation applied to the SFD pulse while in the 1000Mb operating mode. Before a link is established in 1000Mb mode, the Sync FIFO Control Register (register address E9h) must be set to value 0xDF22. The below SFD variation compensation method can only be applied after the Sync FIFO Control Register has been initialized and a new link has been established. Setting the Sync FIFO Control register value and then performing a software restart by setting the SW_RESTART bit[14] in the Control Register (register address 1Fh) if a link is already present is acceptable.

7.3.2.1.1 1000Mb SFD Variation in Leader Mode

When the DP83869HM is operating in 1000Mb leader mode, variation of the RX_SFD pulse can be estimated using the Skew FIFO Status register (register address 55h) bit[7:4]. The value read from the Skew FIFO Status register bit[7:4] must be multiplied by 8ns to estimate the RX_SFD variation added to the baseline latency.

Example: While operating in leader 1000Mb mode, a value of 0x2 is read from the Skew FIFO register bit[7:4]. 2 × 8ns = 16ns is subtracted from the TX SFD to RX SFD measurement to determine the baseline latency.

7.3.2.1.2 1000Mb SFD Variation in Follower Mode

When the DP83869HM is operating in 1000Mb follower mode, the variation of the RX_SFD pulse can be determined using the Skew FIFO Status register (register address 55h) bit[3:0]. The value read from the Skew FIFO Status register bit[3:0] must be multiplied by 8ns to estimate the RX_SFD variation added to the baseline latency.

Example: While operating in follower 1000Mb mode, a value of 0x1 is read from the Skew FIFO register bit[3:0]. 1 × 8ns = 8ns is subtracted from the TX_SFD to RX_SFD measurement to determine the baseline latency.

7.3.2.1.3 100-Mb SFD Variation

The latency variation in 100-Mb mode of operation is determined by random process and does not require any register readout or system level compensation of SFD pulses.

7.3.3 Clock Output

The DP83869HM has several internal clocks, including the local reference clock, the Ethernet transmit clock, and the Ethernet receive clock. An external crystal or oscillator provides the stimulus for the local reference clock. The local reference clock acts as the central source for all clocking in the device.

The local reference clock is embedded into the transmit network packet traffic and is recovered from the network packet traffic at the receiver node. The receive clock is recovered from the received Ethernet packet data stream and is locked to the transmit clock in the partner.

Using the I/O Configuration register (address 170h), the DP83869HM can be configured to output these internal clocks through the CLK_OUT pin. By default, the output clock is synchronous to the XI oscillator / crystal input. The default output clock is designed for use as the reference clock of another DP83869HM device. Through registers, the output clock can be configured to be synchronous to the receive data at the 125MHz data rate or at the divide by 5 rate of 25MHz. The output clock can also be configured to output the line driver transmit clock. When operating in 1000Base-T mode, the output clock can be configured for any of the four transmit or receive channels.

Please note that when clock output of DP83869HM is being used as a clock input for another device, for example two DP83869HM in daisy chain, then the primary DP83869HM must not be reset via the RESET pin. If reset is required, then reset must be performed via software. The output clock can be disabled using the CLK_O_DISABLE bit of the I/O Configuration register.

7.3.4 Loopback Mode

There are several options for Loopback that test and verify various functional blocks within the PHY. Enabling loopback mode allows in-circuit testing of the digital and analog data paths. Generally, the DP83869HM can be configured to one of the Near-end loopback modes or to the Far-end (reverse) loopback. MII Loopback is configured using the BMCR (register address 0h). All other loopback modes are enabled using the BIST_CONTROL (register address 16h). Except where otherwise noted, loopback modes are supported for all speeds (10/100/1000) and all MAC interfaces (SGMII and RGMII).

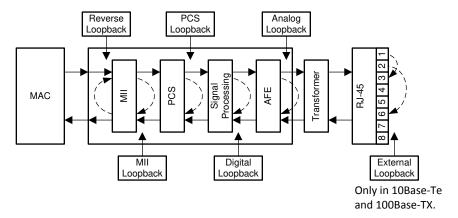


Figure 7-4. Loopbacks

7.3.4.1 Near-End Loopback

Near-end loopback provides the ability to loop the transmitted data back to the receiver through the digital or analog circuitry. The point at which the signal is looped back is selected using loopback control bits with several options being provided.

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When configuring loopback modes, the Loopback Configuration Register (LOOPCR), address FEh, must be set to 0xE720.

To maintain the desired operating mode, Auto-Negotiation must be disabled before selecting the Near-End Loopback mode. This constraint does not apply for external-loopback mode.

Auto-MDIX must be disabled before selecting the Near-End Loopback mode. MDI or MDIX configuration must be manually configured.

7.3.4.1.1 MII Loopback

MII Loopback is the shallowest loop through the PHY. MII Loopback is a useful test mode to validate communications between the MAC and the PHY. While in MII Loopback mode, the data is looped back and can be configured through the register to transmit onto the media. In 100Base-TX mode after MII loopback is enabled through register 0h, write 0x4 to register 16h for proper operation of MII Loopback.

7.3.4.1.2 PCS Loopback

PCS Loopback occurs in the PCS layer of the PHY. No signal processing is performed when using PCS Loopback.

7.3.4.1.3 Digital Loopback

Digital Loopback includes the entire digital transmit – receive path. Data is looped back prior to the analog circuitry.

7.3.4.1.4 Analog Loopback

Analog Loopback includes the entire analog transmit-receive path. For proper operation in Analog Loopback mode, attach 100Ω terminations to the copper side when operating in Copper mode and 100Ω termination on fiber side when operating in Fiber mode.

7.3.4.1.5 External Loopback

When operating in 10BASE-Te or 100Base-T mode, signals can be looped back at the RJ-45 connector by wiring the transmit pins to the receive pins. Due to the nature of the signaling in 1000Base-T mode, this type of external loopback is not supported. Analog loopback provides a way to loop data back in the analog circuitry when operating in 1000Base-T mode.

7.3.4.1.6 Far-End (Reverse) Loopback

Far-end (Reverse) Loopback is a special test mode to allow testing the PHY from the link-partner side. In this mode, data that is received from the link partner passes through the PHY's receiver is looped back at the MAC interface and is transmitted back to the link partner. While in Reverse Loopback mode, all data signals that come from the MAC are ignored. Through register configuration, data can also be transmitted onto the MAC Interface.

The availability of Loopback depends on the operational mode of the PHY. The Link Status in these loopback modes is also affected by the operational mode. Table 7-2 lists out the exceptions where Loopbacks are not available.

Table 7-2. Loopback Availability Exception

| OP MODE | LOOPBACK | EXCEPTION |
|--------------------|----------|------------------|
| Copper | PCS | 10M |
| | MII | 100M |
| Fiber | PCS | 100M |
| | Analog | 100M, 1000M |
| | PCS | 10M, 100M, 1000M |
| SGMII to RGMII | Digital | 10M, 100M, 1000M |
| 3GIVIII (U KGIVIII | Analog | 10M, 100M, 1000M |
| | External | 10M, 100M, 1000M |

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Table 7-2. Loopback Availability Exception (continued)

| OP MODE | LOOPBACK | EXCEPTION |
|-----------------|----------|---------------------------------|
| RGMII to SGMII | PCS | 10M, 100M, 1000M |
| | External | 10M, 100M, 1000M |
| Media Convertor | MII | 100M, 1000M |
| | Analog | 100M on Fiber Interface |
| | External | 100M on Fiber Interface |
| | | 100M, 1000M on Copper Interface |

7.3.5 BIST Configuration

The device incorporates an internal PRBS Built-In Self Test (BIST) circuit to accommodate in-circuit testing or diagnostics. The BIST circuit can be used to test the integrity of the transmit and receive data paths. The BIST can be performed using both internal loopback (digital or analog) or external loopback using a cable fixture. The BIST simulates pseudo-random data transfer scenarios in format of real packets and Inter-Packet Gap (IPG) on the lines. The BIST allows full control of the packet lengths and of the IPG.

The BIST is implemented with independent transmit and receive paths, with the transmit block generating a continuous stream of a pseudo-random sequence. The device generates a 15-bit pseudo-random sequence for the BIST. The received data is compared to the generated pseudo-random data by the BIST Linear Feedback Shift Register (LFSR) to determine the BIST pass or fail status. The number of error bytes that the PRBS checker received is stored in the PRBS_TX_CHK_CTRL register (39h). The status of whether the PRBS checker is locked to the incoming receive bit stream, whether the PRBS has lost sync, and whether the packet generator is busy, can be read from the GEN_STATUS2 register (17h). While the lock and sync indications are required to identify the beginning of proper data reception, for any link failures or data corruption, the best indication is the contents of the error counter in the PRBS_TX_CHK_CTRL register (39h). The number of received bytes are stored in PRBS_TX_CHK_BYTE_CNT (3Ah).

The PRBS test can be put in a continuous mode by using the BIST_CONTROL register (16h). In continuous mode, when one of the PRBS counters reaches the maximum value, the counter starts counting from zero again. PRBS mode is not applicable in Bridge Modes and must not be used.

BIST Configuration Example:

- 1. Enable Digital Loopback
 - a. Write 0xE720 to register 0x00FE
 - b. Write 0x0140 to register 0x0000
 - c. Write 0x5028 to register 0x0010
 - d. Write 0x0004 to register 0x0016
- 2. Wait for link-up
 - a. PHY link status goes high, regardless if there is a cable connected or not.
- 3. Enable PRBS Transmit and checker towards copper
 - a. Write 0xF004 to register 0x00016
- 4. Wait for PRBS Lock
 - a. Wait for register 0x0017[11] to go high
- 5. Read the packet statistics
 - a. Write 0x0201 to register 0x0072 to latch the statistics
 - b. Read the registers below
 - i. 0x0071 (PRBS Byte Count)
 - ii. 0x0072 (bit[7:0] Error Count)
 - iii. 0x01A8 (Packet Count)
 - iv. 0x01A9 (Packet Count)

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7.3.6 Interrupt

The DP83869HM can be configured to generate an interrupt when changes of internal status occur. The interrupt allows a MAC to act upon the status in the PHY without polling the PHY registers. The interrupt source can be selected through the interrupt registers, MICR (12h) and FIBER_INT_EN (C18h). The interrupt status can be read from ISR (13h) and FIBER_INT_STTS (C19h) registers. Some interrupts are enabled by default and can be disabled through register access. Both the interrupt status registers must be read to clear pending interrupts. New interrupts are not routed to the interrupt pin until the pending interrupts are cleared.

7.3.7 Power-Saving Modes

DP83869HM supports four power saving modes. The details are provided below.

7.3.7.1 IEEE Power Down

The PHY is powered down but access to the PHY through MDIO-MDC pins is retained. This mode can be activated by asserting external PWDN pin or by setting bit 11 of BMCR (Register 0h).

The PHY can be taken out of this mode by a power cycle, software reset, or by clearing the bit 11 in BMCR register. However, the external PWDN pin must be deasserted. If the PWDN pin is kept asserted then the PHY remains in power down.

7.3.7.2 Active Sleep

In this mode, all the digital and analog blocks are powered down. The PHY is automatically powered up when a link partner is detected. This mode is useful for saving power when the link partner is down or inactive, but PHY cannot be powered down. In Active Sleep mode, the PHY still routinely sends NLP to the link partner. This mode can be active by writing 10b to bits [9:8] for PHYCR (Register 10h). Sleep mode cannot be used when Auto-MDIX is on.

7.3.7.3 Passive Sleep

This is just like Active sleep except the PHY does not send NLP. This mode can be activated by writing 11b to bits [9:8] PHYCR (Register 10h). Sleep mode cannot be used when Auto-MDIX is on.

7.3.8 Mirror Mode

In some applications, the orientation of the cable connector can require Copper PMD traces to cross over each other. This complicates the board layout. The DP83869HM can resolve this issue by implementing mirroring of the ports inside the device.

In 10/100 operation, the mapping of the port mirroring is shown in Table 7-3. When using mirror mode in 100Mbps mode, TI recommends that the user read register 0xA1 and write the same value in register A0h.

Table 7-3. Mirror Port Configurations in 10/100 Operation

| MDI MODE | MIRROR PORT CONFIGURATION |
|----------|---------------------------|
| MDI | $A \to D$ |
| | $B \to C$ |
| MDIX | $A \rightarrow D$ |
| | $B \to C$ |

In Gigabit operation, the mapping of the port mirroring is shown in Table 7-4.

Table 7-4. Mirror Port Configurations in Gigabit Operation

| indicate in minitary and a companion of a guide a paradian. | | |
|---|---------------------------|--|
| MDI MODE | MIRROR PORT CONFIGURATION | |
| MDI or MDIX | $A \rightarrow D$ | |
| | $B \to C$ | |
| | $C \rightarrow B$ | |
| | $D \to A$ | |

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Mirror mode can be enabled through strap or through register configuration using the Port Mirror Enable bit in the CFG4 register (address 31h). In Mirror mode, the polarity of the signals is also reversed.

7.3.9 Speed Optimization

Speed optimization, also known as link downshift, enables fallback to 100M operation after multiple consecutive failed attempts at Gigabit link establishment. Such a case can occur if cabling with only four wires (two twisted pairs) are connected instead of the standard cabling with eight wires (four twisted pairs).

The number of failed link attempts before falling back to 100M operation is configurable. By default, four failed link attempts are required before falling back to 100M.

In enhanced mode, fallback to 100M can occur after one failed link attempt if energy is not detected on the C and D channels. Speed optimization also supports fallback to 10M if link establishment fails in Gigabit and in 100M mode.

Speed optimization can be enabled through register configuration.

7.3.10 Cable Diagnostics

With the vast deployment of Ethernet devices, the need for reliable, comprehensive and user-friendly cable diagnostic tool is more important than ever. The wide variety of cables, topologies, and connectors deployed results in the need to non-intrusively identify and report cable faults. The DP83869HM offers Time Domain Reflectometry (TDR) for Cable Diagnostics.

7.3.10.1 TDR

The DP83869HM uses Time Domain Reflectometry (TDR) to determine the quality of the cables, connectors, and terminations in addition to estimating the cable length. Some of the possible problems that can be diagnosed include opens, shorts, cable impedance mismatch, bad connectors, termination mismatches, cross faults, cross shorts, and any other discontinuities along the cable.

The DP83869HM transmits a test pulse of known amplitude down each of the two pairs of an attached cable. The transmitted signal continues down the cable and reflects from each cable imperfection, fault, bad connector, and from the end of the cable. After the pulse transmission, the DP83869HM measures the return time and amplitude of all these reflected pulses. This technique enables measuring the distance and magnitude (impedance) of non-terminated cables (open or short), discontinuities (bad connectors), improperly-terminated cables, and crossed pairs wires with ±1m accuracy.

The DP83869HM also uses data averaging to reduce noise and improve accuracy. The DP83869HM can record up to five reflections within the tested pair. If more than 5 reflections are recorded, the DP83869HM saves the first 5 of them. If a cross fault is detected, the TDR saves the first location of the cross fault and up to 4 reflections in the tested channel. The DP83869HM TDR can measure cables beyond 100m in length.

For all TDR measurements, the transformation between time of arrival and physical distance is done by the external host using minor computations (such as multiplication, addition, and lookup tables). The host must know the expected propagation delay of the cable, which depends, among other things, on the cable category (for example, CAT5, CAT5e, or CAT6).

TDR measurement is allowed in the DP83869HM in the following scenarios:

- While Link partner is disconnected cable is unplugged at the other side
- Link partner is connected but remains *quiet* (for example, in power-down mode)
- TDR can be automatically activated when the link fails or is dropped by setting bit 7 of register 9h (CFG1). The results of the TDR run after the link fails are saved in the TDR registers.

Software can read these registers at any time to apply post processing on the TDR results. This mode is designed for cases when the link is dropped due to cable disconnections. After a link failure, for instance, the line is quiet to allow a proper function of the TDR.

Product Folder Links: DP83869HM

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7.3.11 Fast Link Drop

The DP83869HM includes advanced link-down capabilities that support various real-time applications. The link down mechanism is configurable and includes enhanced modes that allow extremely fast reaction times to link drops.

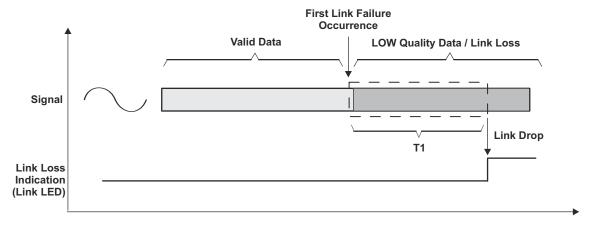


Figure 7-5. Fast Link Drop Mechanism

As described in Figure 7-5, the link loss mechanism is based on a time window search period in which the signal behavior is monitored. The T1 window is set by default to reduce typical link drops to less than 1ms in 100M and 0.5ms in 1000M mode.

The DP83869HM supports enhanced modes that shorten the window called Fast Link Down mode. In this mode, the T1 window is shortened significantly, in most cases less than 10µs. In this period of time, there are several criteria allowed to generate link loss event and drop the link:

- 1. Loss of descrambler sync
- 2. Receive errors
- 3. MLT3 errors
- 4. Mean Squared Error (MSE)
- 5. Energy loss

The Fast Link Down functionality allows the use of each of these options separately or in any combination. Note that because this mode enables extremely quick reaction time, the device is more exposed to temporary bad link quality scenarios.

7.3.12 Jumbo Frames

Conventional Ethernet frames have a maximum size of about 1518 bytes. Jumbo Frames are special packets with size higher than 1518 bytes, often ranging into several thousands of bytes. Jumbo frames allow Ethernet systems to transfer large chunks of data in a single frame reducing the processor overhead and increasing bandwidth efficiency. DP83869 supports Jumbo frames in 1000Mbps and 100Mbps speeds.

7.4 Device Functional Modes

7.4.1 Copper Ethernet

7.4.1.1 1000BASE-T

The DP83869HM supports the 1000BASE-T standard as defined by the IEEE 802.3 standard. In 1000M mode, the PHY uses four MDI channels for communication. The 1000BASE-T can work in Auto-Negotiation mode. The PHY can be configured in 1000BASE-T through the register settings (Section 7.4.8) or strap settings (Section 7.5.1.2).

7.4.1.2 100BASE-TX

The DP83869HM supports the 100BASE-TX standard as defined by the IEEE 802.3 standard. In 100M mode, the PHY uses two MDI channels for communication. The 100BASE-TX can work in Auto-Negotiation mode or in force mode. The PHY can be configured in 100BASE-TX through the register settings (Section 7.4.8) or strap settings (Section 7.5.1.2). When using DP83869 in force 100Base-TX mode, the PHY is required to have Robust Auto-MDIX feature enabled from register 1Eh.

7.4.1.3 10BASE-Te

The DP83869HM supports the 10BASE-Te standard as defined by the IEEE 802.3 standard. In 100M mode, the PHY uses two MDI channels for communication. The 10BASE-Te can work in Auto-Negotiation mode or in force mode. The PHY can be configured in 10BASE-Te through the register settings (Section 7.4.8) or strap settings (Section 7.5.1.2).

7.4.2 Fiber Ethernet

7.4.2.1 1000BASE-X

The DP83869HM supports the 1000Base-X Fiber Ethernet protocol as defined in IEEE 802.3 standard. In 1000M Fiber mode, the PHY uses two differential channels for communication. In fiber mode, the speed is not decided through auto-negotiation. Both sides of the link must be configured to the same operating speed. The PHY can be configured to operate in 1000BASE-X through the register settings (Section 7.4.8) or strap settings (Section 7.5.1.2).

7.4.2.2 100BASE-FX

The DP83869HM supports the 100Base-FX Fiber Ethernet protocol as defined in IEEE 802.3 standard. In 100M Fiber mode, the PHY uses two differential channels for communication. In fiber mode, the speed is not decided through auto-negotiation. Both sides of the link must be configured to the same operating speed. The PHY can be configured to operate in 100BASE-X through register settings (Section 7.4.8) or strap settings (Section 7.5.1.2).

7.4.3 Serial GMII (SGMII)

The Serial Gigabit Media Independent Interface (SGMII) provides a means of conveying network data and port speed between a 100/1000 PHY and a MAC with significantly less signal pins (4 or 6 pins) than required for GMII (24 pins) or RGMII (12 pins). The SGMII interface uses 1.25Gbps LVDS differential signaling which has the added benefit of reducing EMI emissions relative to GMII or RGMII.

Because the internal clock and data recovery circuitry (CDR) of DP83869HM can detect the transmit timing of the SGMII data, TX CLK is not required. The DP83869HM supports only 4-wire SGMII mode. Two differential pairs are used for the transmit and receive connections. Clock and data recovery are performed in the MAC and in the PHY, so no additional differential pair is required for clocking.

The 1.25Gbps rate of SGMII is excessive for 100Mbps and 10Mbps operation. When operating in 100Mbps mode, the PHY elongates the frame by replicating each frame byte 10 times and when in 10Mbps mode the PHY elongates the frame by replicating each frame byte 100 times. This frame elongation takes place above the IEEE 802.3 PCS layer, thus the start of frame delimiter only appears once per frame.

The SGMII interface includes Auto-Negotiation capability. Auto-Negotiation provides a mechanism for control information to be exchanged between the PHY and the MAC. This allows the interface to be automatically configured based on the media speed mode resolution on the MDI side. In MAC loopback mode, the SGMII

Product Folder Links: DP83869HM

speed is determined by the MDI speed selection. The SGMII interface works in both Auto-Negotiation and forced speed mode during the MAC loopback operation. SGMII Auto-Negotiation is the default mode of the operation.

The SGMII Auto-Negotiation process can be disabled and the SGMII speed mode can be forced to the MDI resolved speed. The SGMII forced speed mode can be enabled with the MDI auto-negotiation or MDI manual speed mode. SGMII Auto-Negotiation can be disabled through the SGMII_AUTONEG_EN register bit in the CFG2 register (address 14h).

The 10M_SGMII_RATE_ADAPT bit (bit 7) of 10M_SGMII_CFG register (16Fh) needs to be cleared for enabling 10M SGMII operation.

SGMII is enabled through a resistor strap option. See Section 7.5.1 for details.

All SGMII connections must be AC-coupled through an 0.1µF capacitor.

The connection diagrams for 4-wire SGMII is shown in Figure 7-6.

Note

MII Isolate (bit 10 in register 0h) does not isolate SGMII pins. SGMII can be disabled through register 1DFh for isolating SGMII pins.

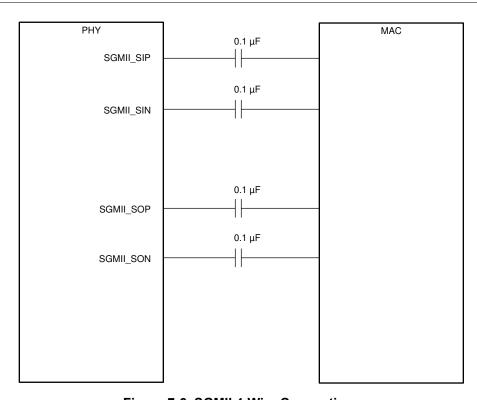


Figure 7-6. SGMII 4-Wire Connections

7.4.4 Reduced GMII (RGMII)

The Reduced Gigabit Media Independent Interface (RGMII) is designed to reduce the number of pins required to interconnect the MAC and PHY (12 pins for RGMII relative to 24 pins for GMII). To accomplish this goal, the data paths and all associated control signals are reduced and are multiplexed. Both rising and trailing edges of the clock are used. For Gigabit operation, the GTX_CLK and RX_CLK clocks are 125MHz, and for 10 and 100Mbps operation, the clock frequencies are 2.5MHz and 25MHz, respectively.

For more information about RGMII timing, see the *RGMII Interface Timing Budgets* application report (SNLA243).

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7.4.4.1 1000Mbps Mode Operation

All RGMII signals are positive logic. The 8-bit data is multiplexed by taking advantage of both clock edges. The lower 4 bits are latched on the positive clock edge and the upper 4 bits are latched on trailing clock edge. The control signals are multiplexed into a single clock cycle using the same technique.

To reduce power consumption of RGMII interface, (TX_EN - TX_ER) and (RX_DV - RX_ER) are encoded in a manner that minimizes transitions during normal network operation. TX_CTRL pin denotes TX_EN on rising edge of GTX_CLK and denotes a logic derivative of TX_EN and TX_ER on the falling edge of GTX_CLK. RX_CTRL denotes RX_DV on rising edge of RX_CLK and denotes a logic derivative of RX_DV and RX_ER on the falling edge of RX CLK. The encoding for the TX_ER and RX_ER is given in Equation 1 and Equation 2:

$$TX_ER = GMII_TX_ER (XOR) GMII_TX_EN$$
 (1)

where

• GMII_TX_ER and GMII_TX_EN are logical equivalent signals in GMII standard.

$$RX_ER = GMII_RX_ER (XOR) GMII_RX_DV$$
 (2)

where

• GMII RX ER, and GMII RX DV are logical equivalent signals in GMII standard.

When receiving a valid frame with no error, $RX_CTRL = True$ is generated as a logic high on the rising edge of RX_CLK and $RX_CTRL = False$ is generated as a logic high at the falling edge of RX_CLK. When no frame is being received, $RX_CTRL = False$ is generated as a logic low on the rising edge of RX_CLK and $RX_CTRL = False$ is generated as a logic low on the falling edge of RX_CLK.

The TX_CTRL is treated in a similar manner. During normal frame transmission, the signal stays at a logic high for both edges of GTX_CLK and during the period between frames where no error is indicated, the signal stays low for both edges.

7.4.4.2 1000Mbps Mode Timing

The DP83869HM provides configurable clock skew for the GTX_CLK and RX_CLK to optimize timing across the interface. The transmit and receive paths can be optimized independently. Both the transmit and receive path support 16 programmable RGMII delay modes through register configuration.

The timing paths can either be configured for Aligned mode or Shift mode. In Aligned mode, no clock skew is introduced. In Shift mode, the clock skew can be introduced in 0.5ns increments or in 0.25ns increments (through register configuration). Configuration of the Aligned mode or Shift mode is accomplished through the RGMII Control Register (RGMIICTL), address 32h. In Shift mode, the clock skew can be adjusted using the RGMII Delay Control Register (RGMIIDCTL), address 86h. By default, RGMII shift mode is activated. Both transmit and receive signals are delayed by 2ns.

7.4.4.3 10 and 100Mbps Mode

When the RGMII interface is operating in the 100Mbps mode, the RGMII clock rate is reduced to 25MHz. For 10Mbps operation, the clock is further reduced to 2.5MHz. In the RGMII 10/100 mode, the transmit clock RGMII TX_CLK is generated by the MAC and the receive clock RGMII RX_CLK is generated by the PHY. During the packet receiving operation, the RGMII RX_CLK can be stretched on either the positive or negative pulse to accommodate the transition from the free-running clock to a data synchronous clock domain. When the speed of the PHY changes, a similar stretching of the positive or negative pulses is allowed. No glitch is allowed on the clock signals during clock speed transitions.

This interface operates at 10 and 100Mbps speeds the same way the interface does at 1000Mbps mode with the exception that the data can be duplicated on the falling edge of the appropriate clock.

The MAC holds the RGMII TX_CLK low until the MAC makes sure that the MAC is operating at the same speed as the PHY.

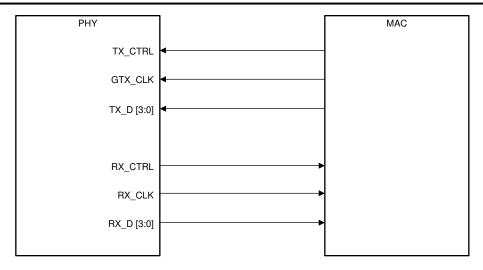


Figure 7-7. RGMII Connections

7.4.5 Media Independent Interface (MII)

DP83869HM also supports MII mode when the PHY is working in 100M and 10M speeds. The user must provide that the PHY links in either 100Mbps or 10Mbps mode. MII mode cannot be used in 1000Mbps mode. When using auto-negotiation to resolve MDI speed, TI recommends to turn off the gigabit speed advertisement through register 0x9 to make sure that the PHY does not link up at 1000Mbps speed. The Media Independent Interface is a synchronous 4-bit wide nibble data interface that connects the PHY to the MAC in 100BASE-FX, 100BASE-TX and 10BASE-Te modes. The RX_ER signal must be properly muxed by setting Register 18h to equal 0xE. The MII is fully compliant with IEEE 802.3-2002 clause 22.

The MII signals are summarized in Table 7-5:

Table 7-5. MII Signals

| FUNCTION | PINS |
|------------------------------|--------------|
| Deta Signala | TX_D[3:0] |
| Data Signals | RX_D[3:0] |
| Transmit and Receive Signals | TX_EN, TX_ER |
| Transmit and Receive Signals | RX_DV, RX_ER |



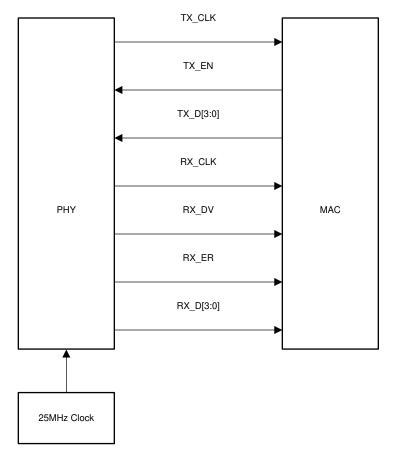


Figure 7-8. MII Signaling

Note

MII mode cannot be enabled via straps alone. Register configuration is also needed.

Steps to configure DP83869HM to MII Mode:

- 1. Write Reg 0x18 = 0xE
- 2. Choose MDI Interface
 - a. Copper:
 - i. Write Reg 0x1DF = 0x60
 - b. Fiber:
 - i. Write Reg 0x1DF = 0x62
- 3. Strap DP83869HM according to Table 7-6

Table 7-6. Strap Table for MII Mode

| PIN NAME | STRAP NAME | PIN NUMBER | PIN STRAP CONNECTION |
|-------------------|------------|------------|---|
| JTAG_TDO / GPIO_1 | OPMODE_0 | 22 | OPEN |
| RX_D3 | OPMODE_1 | 36 | MII to Copper: OPEN MII to Fiber: 2.49kΩ Pull-up to VDDIO |
| RX_D2 | OPMODE_2 | 35 | OPEN |

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7.4.6 Bridge Modes

The DP83869HM supports Bridge modes to translate data between two MAC interface types. Bridge mode is activated through straps or register configuration. The two types of Bridge mode supported by DP83869HM are:

- RGMII-to-SGMII mode
- SGMII-to-RGMII mode

7.4.6.1 RGMII-to-SGMII Mode

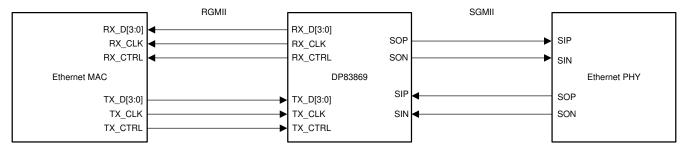


Figure 7-9. DP83869HM RGMII-to-SGMII Bridge

In RGMII-to-SGMII mode Ethernet MAC is connected to the RGMII pins of the DP83869HM and PHY is connected to the SGMII pins of the DP83869. In this mode, DP83869HM configures SGMII in Auto Mode. In Auto mode, the RGMII side automatically adjusts to the link-up speed on the SGMII side. In case where the PHY is does not have a link, the RGMII clock frequency defaults to 2.5MHz.

After auto-negotiation is completed on the PHY side, the link capabilities are communicated to DP83869HM over the SGMII interface. However, this information is conveyed to the Ethernet MAC through RGMII Inband signaling and RX CLK adjustment. The MAC can also read this information from the DP83869.

In Bridge mode, the DP83869HM SMI acts as follower mode to MAC.

7.4.6.2 SGMII-to-RGMII Mode

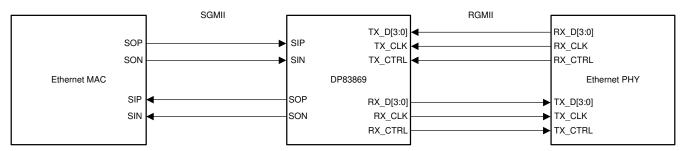


Figure 7-10. DP83869HM SGMII-to-RGMII Bridge

In SGMII-to-RGMII mode, Ethernet MAC is connected to the SGMII pins of the DP83869HM and PHY is connected to the RGMII pins of the DP83869. In this mode, DP83869HM configures SGMII in Auto. In Auto mode, SGMII adapts the link speed based on RGMII.

After auto-negotiation is completed on the PHY side, the link capabilities are communicated to DP83869HM over the RGMII interface. However, this information needs to be conveyed to the Ethernet MAC as well. The MAC can read this information from the DP83869HM through the registers.

In SGMII-to-RGMII Bridge mode, the DP83869 acts as RGMII MAC for the Ethernet PHY. The DP83869 RX pins acts as output pins from the DP83869 to the Ethernet PHY TX pins, and the DP83869 TX pins acts as input pins for the Ethernet PHY RX pins.

In both Bridge modes, PRBS mode of the PHY is not applicable and must not be used.

LEDs, if used, indicates status on the RGMII side in both Bridge Modes.

7.4.7 Media Convertor Mode

In media convertor mode, DP83869HM translates data between copper and fiber interface for 1000M and 100M speeds. Media convertor mode can be activated through the straps. The DP83869HM supports Unmanaged Media Convertor mode.



Figure 7-11. Media Convertor Mode

In Unmanaged mode, Media Convertor can still be activated via straps but register configuration option are also used for enhanced features like changing LED configuration, Capabilities programming broadcasted in Auto-Neg etc can need configuration and are supported through register programming. Register access to the PHY is retained. This provides additional flexibility to use other features supported by the PHY.

Copper interface supports auto-negotiation, but the user has to make sure that the speed negotiated on the copper side matches the speed fixed on the fiber side. In cases of speed mismatch between copper and fiber, interface data transmission can not be successful.

The DP83869HM also supports Link Loss Pass Through in 100M and 1000M mode. In a network containing two media convertors where the link is dropped on one end of the system, a link loss indication is passed through all the way to the far end. The Link Loss Pass-Through is enabled or disabled through straps. An example is shown in Figure 7-12.

- 1. A fault occurs on copper link at position 1 at Near End Link Partner.
- 2. Media Converter disables Fiber TX link at position 2.
- 3. The Media Converter in the system loses link at position 3.
- 4. The second Media Converter disables copper link and the far end link partner loses the copper link.



Figure 7-12. Link Loss Pass-Through

7.4.8 Register Configuration for Operational Modes

The operational modes of DP83869HM are configured through the OPMODE[0], OPMODE[1], OPMODE[2] straps. When operational modes are changed through register access, additional configurations are necessary apart from 1DFh. The following sections contain necessary information for changing operational modes through the registers. For modes not listed below, only configuring register 1DFh is sufficient.

7.4.8.1 RGMII-to-Copper Ethernet Mode

Required register configuration when switching to RGMII-to-Copper mode using software:

- Write 0x0040 to register 1DFh // Set Operation Mode to RGMII to Copper
- Write 0x1140 to register 0h // Reset BMCR
- Write 0x01E1 to register 4h // Advertise 100Base-TX and 10Base-T ability
- Write 0x0300 to register 9h // Reset GEN CFG1
- Write 0x5048 to register 10h // Reset PHY CONTROL
- Write 0x4000 to register 1Fh // Software Reset

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7.4.8.2 RGMII-to-1000Base-X Mode

- Write 0x0041 to register 1DFh // Set Operation Mode to RGMII to 1000Base-X
- Write 0x1140 to register C00h // Reset FX_CTRL
- Write 0x4000 to register 1Fh// Software Reset

7.4.8.3 RGMII-to-100Base-FX Mode

- Write 0x0042 to register 1DFh // Set Operation Mode to RGMII to 100Base-FX
- Write 0x2100 to register C00h // Set Speed to 100Mbps
- Write 0x4000 to register 1Fh // Software Reset

7.4.8.4 RGMII-to-SGMII Bridge Mode

- Write 0x0043 to register 1DFh // Set Operation Mode to RGMII-to-SGMII.
- Write 0x1140 to register C00h // Reset FX CTRL
- Write 0x4000 to register 1Fh // Software Reset

7.4.8.5 1000M Media Convertor Mode

- Write 0x0044 to register 1DFh // Set Operation Mode to 1000Base-T to 1000Base-X
- Write 0x1140 to register 0h // Reset BMCR
- Write 0x5048 to register 10h // Reset PHY CONTROL
- Write 0x1140 to register C00h // Reset FX CTRL
- Write 0x4000 to register 1Fh // Software Reset

7.4.8.6 100M Media Convertor Mode

- Write 0x0045 to register 1DFh // Set Operation Mode to 100Base-T to 100Base-FX
- Write 0x1140 to register 0h // Reset BMCR
- Write 0x5048 to register 10h // Reset PHY CONTROL
- Write 0x000E to register 18h // Mux LED 1 to function as RX ER
- Write 0x4000 to register 1Fh // Software Reset

7.4.8.7 SGMII-to-Copper Ethernet Mode

- Write 0x0046 to register 1DFh // Set Operation Mode to SGMII to Copper
- Write 0x1140 to register 0h // Reset BMCR
- Write 0xB00 to register 9h // Advertise 1000Base-T ability
- Write 0x5048 to register 10h // Reset PHY_CONTROL
- Write 0x1140 to register C00h // Reset FX CTRL
- Write 0x4000 to register 1Fh // Software Reset

7.4.9 Serial Management Interface

The Serial Management Interface (SMI), provides access to the DP83869HM internal register space for status information and configuration. The SMI is compatible with IEEE 802.3-2002 clause 22. The implemented register set consists of the registers required by the IEEE 802.3, plus several others to provide additional visibility and controllability of the DP83869HM device.

The SMI includes the MDC management clock input and the management MDIO data pin. The MDC clock is sourced by the external management entity, also called Station (STA), and can run at a maximum clock rate of 25MHz. MDC is not expected to be continuous, and can be turned off by the external management entity when the bus is idle.

The MDIO is sourced by the external management entity and by the PHY. The data on the MDIO pin is latched on the rising edge of the MDC clock. The MDIO pin requires a pullup resistor (2.2k Ω) which, during IDLE and turnaround, pulls MDIO high.

Up to 16 PHYs can share a common SMI bus. To distinguish between the PHYs, a 4-bit address is used. During power-up reset, the DP83869HM latches the PHY ADD configuration pins to determine the PHY address.

The management entity must not start an SMI transaction in the first cycle after power-up reset. To maintain valid operation, the SMI bus must remain inactive at least one MDC cycle after hard reset is deasserted. In normal MDIO transactions, the register address is taken directly from the management-frame reg_addr field, thus allowing direct access to 32 16-bit registers (including those defined in IEEE 802.3 and vendor specific). The data field is used for both reading and writing. The Start code is indicated by a <01> pattern. This pattern makes sure that the MDIO line transitions from the default idle line state. Turnaround is defined as an idle bit time inserted between the Register Address field and the Data field. To avoid contention during a read transaction, no device can actively drive the MDIO signal during the first bit of turnaround. The addressed DP83869HM drives the MDIO with a zero for the second bit of turnaround and follows this with the required data. Figure 7-13 shows the timing relationship between MDC and the MDIO as driven and received by the Station (STA) and the DP83869HM (PHY) for a typical register read access.

For write transactions, the station-management entity writes data to the addressed DP83869, thus eliminating the requirement for MDIO turnaround. The turnaround time is filled by the management entity by inserting <10>. Figure 7-13 shows the timing relationship for a typical MII register write access. The frame structure and general read and write transactions are shown in Table 7-7, Figure 7-13, and Figure 7-14.

Table 7-7. Typical MDIO Frame Format

| TYPICAL MDIO FRAME FORMAT | <idle><start><op code=""><device addr=""><reg addr=""><turnaround><data<<idle></data<<idle></turnaround></reg></device></op></start></idle> |
|---------------------------|---|
| Read Operation | <idle><01><10><aaaa><rrrr><z0><xxxx th="" xx<="" xxxx=""></xxxx></z0></rrrr></aaaa></idle> |
| Write Operation | <idle><01<01><aaaa><rrrr><10><xxxx td="" xx<="" xxxx=""></xxxx></rrrr></aaaa></idle> |

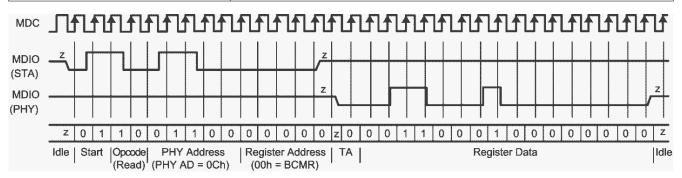


Figure 7-13. Typical MDC/MDIO Read Operation

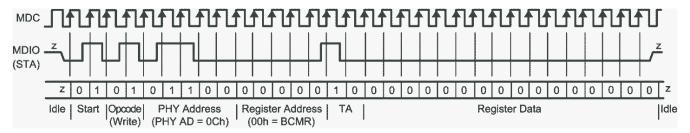


Figure 7-14. Typical MDC/MDIO Write Operation

7.4.9.1 Extended Register Space Access

The DP83869HM's SMI function supports read or write access to the extended register set using registers REGCR (0x0D) and ADDAR (0x0E) and the MDIO Manageable Device (MMD) indirect method defined in IEEE 802.3ah Draft for clause 22 for accessing the clause 45 extended register set.

The standard register set, MDIO registers 0 to 31, is accessed using the normal direct-MDIO access or the indirect method, except for register REGCR (0x0D) and ADDAR (0x0E), which is accessed only using the normal MDIO transaction. The SMI function ignores indirect accesses to these registers.

REGCR (0x0D) is the MDIO Manageable MMD access control. In general, register REGCR(4:0) is the device address (DEVAD) that directs any accesses of ADDAR (0x0E) register to the appropriate MMD.

The PHY'S supports one MMD device address. The vendor-specific device address DEVAD[4:0] = 11111 is used for general MMD register accesses.

All accesses through registers REGCR and ADDAR must use the correct DEVAD. Transactions with other DEVAD are ignored. REGCR[15:14] holds the access function: address (00), data with no post increment (01), data with post increment on read and writes (10) and data with post increment on writes only (11).

Table 7-8. REGCR DEVAD Functions

| REGCR[15:14] | FUNCTION |
|--------------|--|
| 00 | Accesses to register ADDAR modify the extended register 'set address' register. This address register must always be initialized to access any of the registers within the extended register set. |
| 01 | Accesses to register ADDAR access the register within the extended register set selected by the value in the address register. |
| 10 | Access to register ADDAR access the register within the extended register set selected by the value in the address register. After that access is complete, for both reads and writes, the value in the address register is incremented. |
| 11 | Access to register ADDAR access the register within the extended register set selected by the value in the address register. After that access is complete, for write accesses only, the value in the address register is incremented. For read accesses, the value of the address register remains unchanged. |

The following sections describe how to perform operations on the extended register set using register REGCR and ADDAR. The descriptions use the device address for general MMD register accesses (DEVAD[4:0] = 11111).

7.4.9.1.1 Read (No Post Increment) Operation

To read a register in the extended register set:

| INSTRUCTION | EXAMPLE: READ 0x0170 |
|--|-------------------------------------|
| 1. Write the value 0x001F (address function field = 00, DEVAD = 31) to register REGCR. | Write register 0x0D to value 0x001F |
| 2. Write the desired register address to register ADDAR. | Write register 0x0E to value 0x0170 |
| 3. Write the value 0x401F (data, no post increment function field = 01, DEVAD = 31) to register REGCR. | Write register 0x0D to value 0x401F |
| 4. Read the content of the desired extended register set register to register ADDAR. | Read register 0x0E |

Subsequent reads from register ADDAR (step 4) continue reading the register selected by the value in the address register.

Note

Steps (1) and (2) can be skipped if the address register is already configured.

7.4.9.1.2 Write (No Post Increment) Operation

To write a register in the extended register set:

| INSTRUCTION | EXAMPLE: SET REG 0x0170 = 0C50 |
|--|-------------------------------------|
| 1. Write the value 0x001F (address function field = 00, DEVAD = 31) to register REGCR (0x0D). | Write register 0x0D to value 0x001F |
| 2. Write the desired register address to register ADDAR (0x0E). | Write register 0x0E to value 0x0170 |
| 3. Write the value 0x401F (data, no post increment function field = 01, DEVAD = 31) to register REGCR. | Write register 0x0D to value 0x401F |
| 4. Write the content of the desired extended register set register to register ADDAR. | Write register 0x0E to value 0x0C50 |



Subsequent writes to register ADDAR (step 4) continue to rewrite the register selected by the value in the address register.

Note

Steps (1) and (2) can be skipped if the address registeris already configured.

7.4.10 Auto-Negotiation

All 1000BASE-T PHYs are required to support Auto-Negotiation. The Auto-Negotiation function in 1000BASE-T has three primary purposes:

- Auto-Negotiation of Speed and Duplex Selection
- Auto-Negotiation of Leader or Follower Resolution
- Auto-Negotiation of Pause or Asymmetrical Pause Resolution

7.4.10.1 Speed and Duplex Selection - Priority Resolution

The Auto-Negotiation function provides a mechanism for exchanging configuration information between the two ends of a link segment. This mechanism is implemented by exchanging Fast Link Pulses (FLP). FLPs are burst pulses that provide the signaling used to communicate the abilities between two devices at each end of a link segment. For further details regarding Auto-Negotiation, refer to Clause 28 of the IEEE 802.3 specification. The DP83869HM supports 1000BASE-T, 100BASE-TX, and 1000BASE-T modes of operation. The process of Auto-Negotiation makes sure that the highest performance protocol is selected (that is, priority resolution) based on the advertised abilities of the Link Partner and the local device.

7.4.10.2 Leader and Follower Resolution

If 1000BASE-T mode is selected during the priority resolution, the second goal of Auto-Negotiation is to resolve Leader or Follower configuration. The Leader mode priority is given to the device that supports multiport nodes, such as switches and repeaters. Single node devices such as DTE or NIC card takes lower Leader mode priority.

7.4.10.3 Pause and Asymmetrical Pause Resolution

When Full-Duplex operation is selected during priority resolution, the Auto-Negotiation also determines the Flow Control capabilities of the two link partners. Flow control is originally introduced to force a busy station's Link Partner to stop transmitting data in Full-Duplex operation. Unlike Half-Duplex mode of operation where a link partner can be forced to back off by simply generating collisions, the Full-Duplex operation needed a mechanism to slow down transmission from a link partner in the event that the receiving station's buffers are becoming full. A new MAC control layer is added to handle the generation and reception of Pause Frames. Each MAC Controller has to advertise whether the MAC is capable of processing Pause Frames. In addition, the MAC Controller advertises if Pause frames can be handled in both directions, that is, receive and transmit. If the MAC Controller only generates Pause frames but does not respond to Pause frames generated by a link partner, this is called Asymmetrical Pause. The advertisement of Pause and Asymmetrical Pause capabilities is enabled by writing 1 to bits 10 and 11 of ANAR (register address 4h). The link partner's Pause capabilities is stored in ANLPAR (register address 5h) bits 10 and 11. The MAC Controller has to read from ANLPAR to determine which Pause mode to operate. The PHY layer is not involved in Pause resolution other than simply advertising and reporting of Pause capabilities.

7.4.10.4 Next Page Support

The DP83869HM supports the Auto-Negotiation Next Page protocol as required by IEEE 802.3 clause 28.2.4.1.7. The ANNPTR 7h allows for the configuration and transmission of the Next Page. Refer to clause 28 of the IEEE 802.3 standard for detailed information regarding the Auto-Negotiation Next Page function.

7.4.10.5 Parallel Detection

The DP83869HM supports the Parallel Detection function as defined in the IEEE 802.3 specification. Parallel Detection requires the 10/100Mbps receivers to monitor the receive signal and report link status to the Auto-Negotiation function. Auto-Negotiation uses this information to configure the correct technology in the event

that the Link Partner does not support Auto-Negotiation, yet is transmitting link signals that the 10BASE-Te or 100BASE-X PMA recognize as valid link signals.

If the DP83869HM completes Auto-Negotiation as a result of Parallel Detection without Next Page operation, bits 5 and 7 of ANLPAR (register address 5h) are set to reflect the mode of operation present in the Link Partner. Note that bits 4:0 of the ANLPAR are also set to 00001 based on a successful parallel detection to indicate a valid 802.3 selector field. Software determines that the negotiation is completed through Parallel Detection by reading 0 in bit 0 of ANER (register address 6h) after Auto-Negotiation Complete—bit 5 of BMSR (register address 1h)—is set. If the PHY is configured for parallel detect mode and any condition other than a good link occurs, the parallel detect fault—bit 4 of ANER (register address 6h)—sets.

7.4.10.6 Restart Auto-Negotiation

If a link is established by successful Auto-Negotiation and then lost, the Auto-Negotiation process resumes to determine the configuration for the link. This function makes sure that a link can be re-established if the cable becomes disconnected and reconnected. After Auto-Negotiation is completed, Auto-Negotiation can be restarted at any time by writing 1 to bit 9 of the BMCR (register address 0h). A restart Auto-Negotiation request from any entity, such as a management agent, causes DP83869HM to halt data transmission or link pulse activity until the break_link_timer expires. Consequently, the Link Partner goes into link fail mode and the resume Auto-Negotiation. The DP83869HM resumes Auto-Negotiation after the break_link_timer has expired by transmitting FLP (Fast Link Pulse) bursts.

7.4.10.7 Enabling Auto-Negotiation Through Software

If Auto-Negotiation is disabled by MDIO access, and the user desires to restart Auto-Negotiation, this can be accomplished by software access. Bit 12 of BMCR (register address 0h) must be cleared and then set for Auto-Negotiation operation to take place.

If Auto-Negotiation is disabled by strap option, Auto-Negotiation cannot be re-enabled.

7.4.10.8 Auto-Negotiation Complete Time

Parallel detection and Auto-Negotiation typically take 2-3 seconds to complete. In addition, Auto-Negotiation with next page exchange takes approximately 2-3 seconds to complete, depending on the number of next pages exchanged. Refer to Clause 28 of the IEEE 802.3 standard for a full description of the individual timers related to Auto-Negotiation.

7.4.10.9 Auto-MDIX Resolution

The DP83869HM can determine if a *straight* or *crossover* cable is used to connect to the link partner. Auto-MDIX feature can automatically re-assign channel A and B to establish link with the link partner, (and channel C and D in 1000BASE-T mode). Auto-MDIX resolution precedes the actual Auto-Negotiation process that involves exchange of FLPs to advertise capabilities. Automatic MDI/MDIX is described in IEEE 802.3 Clause 40, section 40.8.2. This is not a required implementation for 10BASE-Te and 100BASE-TX.

Auto-MDIX can be enabled or disabled by strap, using the AMDIX Disable strap, or by register configuration, using bit 6 of the PHYCR register (address 10h). When Auto-MDIX is disabled, the PMA is forced to either MDI (*straight*) or MDIX (*crossed*). Manual configuration of MDI or MDIX can also be accomplished by strap, using the Force MDI/X strap, or by register configuration, using bit 5 of the PHYCR register.

For 10/100, Auto-MDIX is independent of Auto-Negotiation. Auto-MDIX works in both Auto-Negotiation mode and manual forced speed mode.

7.5 Programming

7.5.1 Strap Configuration

The DP83869HM uses many of the functional pins as strap options to place the device into specific modes of operation. The values of these pins are sampled at power up or hard reset. During software resets, the strap options are internally reloaded from the values sampled at power up or hard reset. The strap option pin assignments are defined below.

Configuration of the device can be done through the strap pins or through the management register interface. A pullup resistor and/or a pulldown resistor of suggested values can be used to set the voltage ratio of the strap pin input and the supply to select one of the possible selected modes.

The MAC interface pins must support I/O voltages of 3.3V, 2.5V, and 1.8V. As the strap inputs are implemented on these pins, the straps must also support operation at 3.3V, 2.5V, and 1.8V supplies depending on what voltage is selected for I/O. RX D0 and RX D1 pins are 4 level strap pins. All other strap pins have two levels.

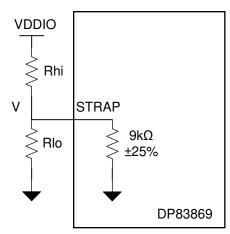


Figure 7-15. Strap Circuit

Table 7-9 4-I evel Strap Resistor Ratio

| | Table 7-3. 4-Level Ottap Resistor Ratio | | | | | | |
|-------|---|-------------------|---------------|-----------------------|----------|--|--|
| MODE | TARGET VOLTAGE | | | RECOMMENDED RESISTORS | | | |
| WIODE | Vmin (V) | Vtyp (V) Vmax (V) | | Rhi (kΩ) | Rlo (kΩ) | | |
| 0 | 0 | 0 | 0.093 × VDDIO | OPEN | OPEN | | |
| 1 | 0.136 × VDDIO | 0.165 × VDDIO | 0.184 × VDDIO | 10 | 2.49 | | |
| 2 | 0.219 × VDDIO | 0.255 × VDDIO | 0.280 × VDDIO | 5.76 | 2.49 | | |
| 3 | 0.6 × VDDIO | 0.783 × VDDIO | 0.888 × VDDIO | 2.49 | OPEN | | |

Table 7-10. 2-Level Strap Resistor Ratio

| | the state of the s | | | | | | |
|------|--|----------------|--------------|------------|--------------|--|--|
| MODE | | TARGET VOLTAGE | | RECOMMENDE | ED RESISTORS | | |
| WODE | Vmin (V) | Vtyp (V) | Vmax (V) | Rhi (kΩ) | Rlo (kΩ) | | |
| 0 | 0 | | 0.18 x VDDIO | OPEN | OPEN | | |
| 1 | 0.5 x VDDIO | | 0.88 x VDDIO | 2.49 | OPEN | | |

7.5.1.1 Straps for PHY Address

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Table 7-11. PHY Strap Table

| PIN NAME | STRAP NAME | PIN NUMBER | DEFAULT | | | |
|----------|--------------|------------|---------|--------|----------|----------|
| | | | | | PHY_ADD1 | PHY_ADD0 |
| | | | | MODE 0 | 0 | 0 |
| RX_D0 | PHY_ADD[1:0] | 33 | 00 | MODE 1 | 0 | 1 |
| | | | | MODE 2 | 1 | 0 |
| | | | | MODE 3 | 1 | 1 |

Table 7-11. PHY Strap Table (continued)

| ranie i militir duale (dominiada) | | | | | | | |
|-----------------------------------|--------------|------------|---------|--------|----------|----------|--|
| PIN NAME | STRAP NAME | PIN NUMBER | DEFAULT | | | | |
| | | | | | PHY_ADD3 | PHY_ADD2 | |
| | | | | MODE 0 | 0 | 0 | |
| RX_D1 | PHY_ADD[3:2] | 34 | 00 | MODE 1 | 0 | 1 | |
| | | | | MODE 2 | 1 | 0 | |
| | | | | MODE 3 | 1 | 1 | |

7.5.1.2 Strap for DP83869HM Functional Mode Selection

Table 7-12. Functional Mode Strap Table

| Table 7 12.1 anotional mode of ap Table | | | | | | | |
|---|----------------|------------|---------|---------------|---------------|---------------|---|
| PIN NAME | STRAP NAME | PIN NUMBER | DEFAULT | OPMO DE[2] | OPMO DE[1] | OPMO DE[0] | FUNCTIONAL MODES |
| JTAG_TDO/ GPIO 1 | OPMODE[0] | 22 | 0 | 0 | 0 | 0 | RGMII to Copper (1000Base-T/ 100Base-TX/10Base-Te) |
| GFIO_1 | | | | 0 | 0 | 1 | RGMII to 1000Base-X |
| RX D3 | DV DO ODMODEMI | 36 | 0 | 0 | 1 | 0 | RGMII to 100Base-FX |
| KA_D3 | OPMODE[1] | | | 0 | 1 | 1 | RGMII-SGMII Bridge Mode |
| | | | | 1 | 0 | 0 | 1000Base-T to 1000Base-X |
| | | | | 1 | 0 | 1 | 100Base-TX to 100Base-FX |
| RX_D2 | OPMODE[2] | 35 | 0 | 1 | 1 | 0 | SGMII to Copper (1000Base-T/ 100Base-TX/10Base-Te) |
| | | | | 1 | 1 | 1 | JTAG for boundary scan |

7.5.1.3 LED Default Configuration Based on Device Mode

Based on the straped OP_MODE, the following table summarizes the default of LED0, LED1 and LED2.

Table 7-13. LED Defaults

| OP_MODE[2:0] | Mode Description | LED0 Default | LED1 Default | LED2 Default |
|--------------|--|---|--------------------------------------|--------------------|
| 000 | RGMII to Copper (1000Base-TX/ 100Base-TX/10-T) | 10/100M/1G Link-up: Stable ON | 1G Link-up: Stable ON | TX and RX Activity |
| 001 | RGMII to 1000Base-X | Fiber Link-up: Stable ON | TX Activity | RX Activity |
| 010 | RGMII to 100Base-FX | Fiber Link-up: Stable ON | TX Activity | RX Activity |
| 011 | RGMII to SGMII | SGMII Link-up from 10/100M/1G: Stable ON | SGMII 1G Link-up: Stable ON | TX and RX Activity |
| 100 | Copper to 1000Base-X | Copper Link Status Link established: Stable ON Link dropped to 100M or half duplex: LED blink (error Condition) | Fiber Link established: Stable ON | TX and RX Activity |
| 101 | Copper to 100Base-FX | Copper Link Status Link established: Stable ON Link dropped to 100M or half duplex: LED blink (error Condition) | Fiber Link established: Stable ON | TX and RX Activity |
| 110 | SGMII to Copper (1000Base-TX/ 100Base-TX/10-T) | 10/100M/1G Link-up: Stable ON | 1G Link-up: Stable ON | TX and RX Activity |



7.5.1.4 Straps for RGMII/SGMII to Copper

Table 7-14. Copper Ethernet Strap Table

| | in a special control of the second se | | | | | | | | | | | | | |
|----------|--|------------|---------|--------------|---------------|---------------|---|----|----|---|---|---|---|------------------------------------|
| PIN NAME | STRAP NAME | PIN NUMBER | DEFAULT | | | | | | | | | | | |
| | | | | ANEG_ DIS | ANEGS EL_1 | ANEGS EL_0 | FUNCTION | | | | | | | |
| LED_0 | ANEG_DIS | 47 | 0 | 0 | 0 | 0 | Auto-negotiation, 1000/100/10 advertised, Auto MDI-X | | | | | | | |
| | | | | 0 | 0 | 1 | Auto-negotiation, 1000/100 advertised, Auto MDI-X | | | | | | | |
| | | GSEL_0 46 | 0 | 0 | 1 | 0 | Auto-negotiation, 100/10 advertised, Auto-MDI-X | | | | | | | |
| LED_1 | ANEGSEL_0 | | | 0 | 1 | 1 | NA | | | | | | | |
| | | | | 1 | 0 | 0 | NA | | | | | | | |
| | | | | 1 | 0 | 1 | NA | | | | | | | |
| LED_2 | ANEGSEL_1 | 45 | 45 | 45 | 45 | 45 | 45 | 45 | 45 | 0 | 1 | 1 | 0 | Forced 100M, full duplex, MDI mode |
| | | | | 1 | 1 | 1 | Forced 100M, full duplex, MDI-X mode | | | | | | | |
| DV CTDI | MIRROR EN | 38 | 0 | | 0 | | Port Mirroring Disabled | | | | | | | |
| RX_CTRL | WIIRROR_EN | 30 | | | 1 | | Port Mirroring Enabled | | | | | | | |

7.5.1.5 Straps for RGMII to 1000Base-X

Table 7-15. 1000Base-X Strap Table

| PIN NAME | STRAP NAME | PIN NUMBER | DEFAULT | | | | | |
|----------------|---------------|--------------|---------|------------------|---------------------------------------|--|--|--|
| LED 0 | ANEG DIS | 47 | 47 0 - | | Fiber Auto-negotiation ON | | | |
| LED_0 ANEG_DIS | 47 | U | 1 | Fiber Force mode | | | | |
| LED 1 | ANECSEL O. 46 | ANEGSEL_0 46 | 0 | 0 | Signal Detect disable on Pin 24 | | | |
| LED_I ANEG | ANEGSEL_0 | | U | 1 | Configure Pin 24 as Signal Detect Pin | | | |

7.5.1.6 Straps for RGMII to 100Base-FX

Table 7-16, 100Base-X Strap Table

| | Table 1 101 100 2 alou 7, out up 1 able | | | | | | | |
|----------------|---|------------|---------|---------------------------------|---|---|---------------------------------------|--|
| PIN NAME | STRAP NAME | PIN NUMBER | DEFAULT | | | | | |
| LED 1 | ANECSEL O 46 | 46 0 — | 0 | Signal Detect disable on Pin 24 | | | | |
| LED_1 ANEGSEL_ | ANEGSEL_0 | | 40 0 | 0 | 0 | 1 | Configure Pin 24 as Signal Detect Pin | |

7.5.1.7 Straps for Bridge Mode (SGMII-RGMII)

Table 7-17. Bridge Mode Strap Table

| PIN NAME | STRAP NAME | PIN NUMBER | DEFAULT | | |
|----------|------------|------------|---------|---|--|
| RX CTRL | MIRROR EN | 38 | 0 | 0 | SGMII to RGMII (SGMII : MAC I/F, RGMII : Phy I/F) |
| KX_CTKL | WIINKON_EN | 36 | 0 | 1 | RGMII to SGMII (RGMII : MAC I/F, SGMII : Phy I/F) |

7.5.1.8 Straps for 100M Media Convertor

Table 7-18, 100M Media Convertor Strap Table

| | Table 1 To 100 mould converte chap table | | | | | | |
|----------|--|------------|---------|-----------|-----------|---|--|
| PIN NAME | STRAP NAME | PIN NUMBER | DEFAULT | | | | |
| LED_1 | ANEGSEL_0 | 46 | 0 | ANEGSEL_1 | ANEGSEL_0 | | |
| LED 2 | ANEGSEL 1 | 45 | 0 | 0 | 0 | Copper : Auto-negotiation (100/10 Advertised), Auto MDIX | |
| LLD_Z | ANEGSEL_I | 43 | O | 1 | 1 | Copper : Auto Negotiation (100 Advertised), Auto MDIX | |

Table 7-18. 100M Media Convertor Strap Table (continued)

| rabio i ioi iooni modia convertor chap rabio (continuou) | | | | | | | | | | | | | | |
|--|----------------|------------|---------|------------------------------|-----------------------------|----|----|----|---|------|---|--|---|-----------------------|
| PIN NAME | STRAP NAME | PIN NUMBER | DEFAULT | | | | | | | | | | | |
| RX CTRL | CTRL MIRROR EN | 38 | 0 | 0 | Copper: Mirror Disable | | | | | | | | | |
| KX_CIKL | WIRKOR_EN | 30 | 36 | 30 | 36 0 | 30 | 30 | 30 | U | 36 0 | 5 | | 1 | Copper: Mirror Enable |
| BY CLK | LINIK LOSS | 32 | 0 | 0 | Link Loss Pass Thru Enabled | | | | | | | | | |
| RX_CLK LINK_LOSS | 32 | U | 1 | Link Loss Pass Thru Disabled | | | | | | | | | | |

7.5.1.9 Straps for 1000M Media Convertor

Table 7-19. 1000M Media Strap Table

| Table 7 Tel Teeem media ettap Table | | | | | | | |
|-------------------------------------|---------------|------------|---------|-----------|-----------|--|---|
| PIN NAME | STRAP NAME | PIN NUMBER | DEFAULT | | | | |
| LED 0 | ANEG DIS | 47 | 0 | (|) | Fiber Auto Negotiation | |
| LED_0 | ANEG_DIS | 47 | U | | 1 | Fiber Force Mode | |
| LED_1 | ANEGSEL_0 | 46 | 0 | ANEGSEL_1 | ANEGSEL_0 | | |
| LED 2 | ANEGSEL 1 | 45 | 0 | 0 | 0 | Copper : Auto-negotiation (1000/100 Advertised), Auto MDIX | |
| LED_2 | ANEGSEL_I | 45 | U | U | 1 | 1 | Copper : Auto Negotiation (1000 Advertised), Auto MDIX |
| RX_CTRL | MIRROR_EN | 38 | 0 | (|) | Copper: Mirror Disable | |
| | | | | 1 | | Copper: Mirror Enable | |
| RX_CLK | LINK_LOSS | 32 | 0 | 0 | | Link Loss Pass Thru Enabled | |
| | | | | | 1 | Link Loss Pass Thru Disabled | |

Note

In 1000M media converter mode, Cu Auto-negotiation does not downgrade to 100Mbps if LP supports only 100Mbps and link can fail.

7.5.2 LED Configuration

The DP83869HM supports three configurable Light Emitting Diode (LED) pins: LED_0, LED_1, and LED_2. Several functions can be multiplexed onto the LEDs for different modes of operation. Based on the strapped OPMODE[2:0], the default function of each LED can change. Please see "LED Default Configuration Based on Device Mode" for more information. LED operation mode can be selected using the LEDS_CFG1 register (address 18h).

Because the LED output pins are also used as straps, the external components required for strapping and LED usage must be considered to avoid contention. Specifically, when the LED outputs are used to drive LEDs directly, the active state of each output driver is dependent on the logic level sampled by the corresponding AN input upon power up or reset.

If a given strap input is resistively pulled low then the corresponding output is configured as an active high driver. Conversely, if a given strap input is resistively pulled high, then the corresponding output is configured as an active low driver.

Refer to Figure 7-16 for an example of strap connections to external components. In this example, the strapping results in Mode 0 for LED_0 and Mode 1 for LED_1.

The adaptive nature of the LED outputs helps to simplify potential implementation issues of these dual purpose pins.



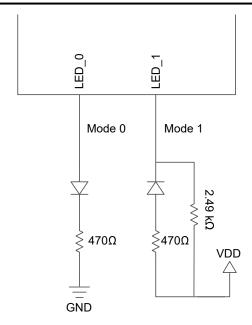


Figure 7-16. Example Strap Connections

The following conditions must be accounted when using LEDs:

- In RGMII-to-SGMII bridge mode with force speeds, Link LED function cannot be used.
- In both Bridge modes, LEDs can be configured to indicate TX only or RX only activity. LED indicates activity
 with respect to RGMII when the PHY is in Bridge mode.
- In 1000Mbps media convertor mode, the link LED corresponds to 1000M link on Copper interface. If link speed is changed then Link LED cannot be used.
- In 100Mbps media convertor mode, the link LED corresponds to 100M link on Copper interface. If link speed is changed then Link LED cannot be used.

7.5.3 Reset Operation

The DP83869HM needs external control over RESET_N pin during power up. If RESET_N pin is connected to host controller, then the PHY must be held in reset for a minimum of 200ms after the last supply powers up as shown in . If host controller cannot be Figure 6-1 connected to RESET_N then a 100Ω resistor and 47μ F capacitor are required to be connected in series between RESET_N pin and ground as shown in Figure 7-17. During normal operation, the device can be reset by a hardware or software reset.

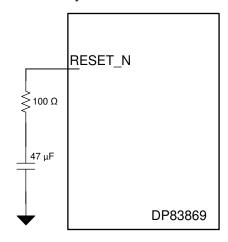


Figure 7-17. RESET N Circuit

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7.5.3.1 Hardware Reset

A hardware reset is accomplished by applying a low pulse, with a duration of at least 1µs, to the RESET_N pin. This resets the device such that all registers are reinitialized to default values and the hardware configuration values are re-latched into the device (similar to the power up or reset operation).

7.5.3.2 IEEE Software Reset

An IEEE registers software reset is accomplished by setting the reset bit (bit 15) of the BMCR register (address 0h). This bit resets the IEEE-defined standard registers.

7.5.3.3 Global Software Reset

A global software reset is accomplished by setting bit 15 of register CTRL (address 1Fh) to 1. This bit resets all the internal circuits in the PHY including IEEE-defined registers and all the extended registers. The global software resets the device such that all registers are reset to default values and the hardware configuration values are maintained.

7.5.3.4 Global Software Restart

A global software restart is accomplished by setting bit 14 of register CTRL (1Fh) to 1. This action resets all the PHY circuits except the registers in the Register File.



7.6 Register Maps

For Fiber Operations (RGMII-to-1000Base-X and RGMII-to-100Base-FX), Fiber register location 0Cxxh get mapped to 0xxxxh address location to comply with IEEE Specifications.

7.6.1 DP83869 Registers

Table 7-20 lists the memory-mapped registers for the DP83869 registers. All register offset addresses not listed in Table 7-20 should be considered as reserved locations and the register contents should not be modified.

Table 7-20. DP83869 Registers

| Offset | Acronym | Register Name | Section |
|--------|-----------------------|--|---------|
| 0h | BMCR | Basic Mode Control Register | Go |
| 1h | BMSR | Basic Mode Status Register | Go |
| 2h | PHYIDR1 | PHY Identifier Register Number 1 | Go |
| 3h | PHYIDR2 | PHY Identifier Register Number 2 | Go |
| 4h | ANAR | Auto-Negotiation Advertisement Register | Go |
| 5h | ALNPAR | Auto-Negotiation Link Partner Ability Register | Go |
| 6h | ANER | Auto-Negotiate Expansion Register | Go |
| 7h | ANNPTR | Auto-Negotiation Next Page Transmit Register | Go |
| 8h | ANLNPTR | Auto-Negotiation Link Partner Next Page Receive Register | Go |
| 9h | GEN_CFG1 | Configuration Register 1 | Go |
| Ah | GEN_STATUS1 | Status Register 1 | Go |
| Dh | REGCR | Register Control Register | Go |
| Eh | ADDAR | Address or Data Register | Go |
| Fh | 1KSCR | 1000BASE-T Status Register | Go |
| 10h | PHY_CONTROL | PHY Control Register | Go |
| 11h | PHY_STATUS | PHY Status Register | Go |
| 12h | INTERRUPT_MASK | MII Interrupt Control Register | Go |
| 13h | INTERRUPT_STATUS | Interrupt Status Register | Go |
| 14h | GEN_CFG2 | Configuration Register 2 | Go |
| 15h | RX_ERR_CNT | | Go |
| 16h | BIST_CONTROL | BIST Control Register | Go |
| 17h | GEN_STATUS2 | Status Register 2 | Go |
| 18h | LEDS_CFG1 | LED Configuration Register 1 | Go |
| 19h | LEDS_CFG2 | LED Configuration Register 2 | Go |
| 1Ah | LEDS_CFG3 | LED Configuration Register 3 | Go |
| 1Eh | GEN_CFG4 | Configuration Register 3 | Go |
| 1Fh | GEN_CTRL | Control Register | Go |
| 25h | ANALOG_TEST_CTRL | Testmode Channel Control Register | Go |
| 2Ch | GEN_CFG_ENH_AMIX | | Go |
| 2Dh | GEN_CFG_FLD | | Go |
| 2Eh | GEN_CFG_FLD_THR | | Go |
| 31h | GEN_CFG3 | Configuration Register 4 | Go |
| 32h | RGMII_CTRL | RGMII Control Register | Go |
| 33h | RGMII_CTRL2 | | Go |
| 37h | SGMII_AUTO_NEG_STATUS | SGMII Autonegotiation Status Register | Go |
| 39h | PRBS_TX_CHK_CTRL | | Go |
| 3Ah | PRBS_TX_CHK_BYTE_CNT | | Go |

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Table 7-20. DP83869 Registers (continued)

| Offset Acronym Register Name Section 43h G.008T_REGO Go 4Fh SERDES_SYNC_STS Go 56h STROP_STS Strop Status Register Go 56h STRAP_STS Strop Status Register Go 77h DBG_PRBS_BYTE_CNT Go 72h DBG_PRBS_BRYE_CNT Go 78h DBG_PRB_BER_CNT Go 77h DBG_PRB_BER_CNT Go 77h DBG_PRB_BER_CNT Go 76h DBG_PRS_BRYE_CNT Go 76h DBG_PRS_BRYE_CNT Go 76h DBG_PRS_BRYE_CNT Go 76h DBG_PRS_BRYE_CNT Go 86h ANA_LD_PRBB_CNT Go 86h ANA_LD_TRUER_PRBS Go 60 ANA_LD_FILTER_TUNE_CD Go 60 ANA_LD_FILTER_TUNE_CD Go 60h ANA_LD_FILTER_TUNE_CD Go 60h ANA_LD_FILTER_TUNE_CD Go 60h ANA_LD_FILTER_TUN | | | DP83869 Registers (continued) | |
|--|--------|----------------------------|--|---------|
| ### SERDES_SYNC_STS Skew FIFO Status Register Go 66h G_1000ET PMA_STATUS Skew FIFO Status Register Go 77th DBG_PRBS_BYTE_CNT Go 77th DBG_PRBS_BYTE_CNT Go 77th DBG_PRBS_BERR_CNT Go 77th DBG_PRBS_BERR_CNT Go 77th DBG_PRT_LEN_PRBS Go 77th DBG_PKT_LEN_PRBS Go 88th ANA_COMIL_DCTRL RGMII Delay Control Register in Shift Mode Go 88th ANA_LO_TXG_FINE_GAINSEL_AB Go A0th ANA_LO_TXG_FINE_GAINSEL_CD Go A1th ANA_LO_TXG_FINE_GAINSEL_CD Go A2th ANA_LO_FILTER_TUNE_AB Go A2th ANA_LO_FILTER_TUNE_CD Go C6th ANA_LO_FILTER_TUNE_CD Go C6th ANA_PLL_PROG_PI Go C6th ANA_PLL_PROG_PI Go C6th ANA_PLL_PROG_PI Go C6th ANA_PLL_PROG_PI Go C6th ANA_FINE_COMIN_CO | Offset | Acronym | Register Name | Section |
| 55h G_1000BT_PMA_STATUS Skew FIFO Status Register Go 6Eh STRAP_STS Strap Status Register Go 71h DBG_PRBS_ERR_CNT Go 72h DBG_PRBS_ERR_CNT Go 7ch DBG_PRBS_ERR_CNT Go 7ch DBG_PRS_ERR_CNT Go 7ch DBG_PRS_ERR_CNT Go 7ch DBG_PRS_ERR_CNT Go 7ch DBG_PRS_ERR_CNT Go 7ch DBG_DRS_ERR_CNT Go 7ch DBG_DRS_ERR_CNT Go 7ch DBG_DRS_ERR_ERR_CNT Go Ach ANA_LD_ELER_TUNE Go ADA ANA_LD_ELER_TUNE_CALL RG Ath ANA_LD_ITCER_TUNE_CALL Go A3h ANA_LD_FILTER_TUNE_CD Go C6h ANA_ELLER_TUNE_CD </td <td>43h</td> <td></td> <td></td> <td>Go</td> | 43h | | | Go |
| 6Eh STRAP_STS Strap Status Register Go 71h DBG_PRBS_ENTE_CNT Go 72h DBG_PRBS_ERR_CNT Go 75h DBG_PRS_ERR_CNT Go 76h DBG_PRS_ERR_CNT Go 76h DBG_PLG_LEN Go 86h ANA_ROMIL DLL_CTRL RGMII Delay Control Register in Shift Mode Go A0h ANA_LD_TXG_FINE_GAINSEL_AB Go A1h ANA_LD_TIXE_FINE_GAINSEL_CD Go A2h ANA_LD_FILTER_TUNE_AB Go A3h ANA_LD_FILTER_TUNE_CD Go A3h ANA_LD_FILTER_TUNE_CD Go C6h ANA_LD_FROC.PI Go B6h SGMI_TESTMODE Go E9h DSP_HYBRID_CFC2 Sync FIFO Control Register Go E9h DSP_HYBRID_CFC2 Sync FIFO Control Register Go 134h RXF_CFG Go Go E9h DSP_HYBRID_CFC2 Sync FIFO Control Register Go 135h RXF_STATUS Go | | , | | |
| 71h DBG_PRBS_BYTE_CNT GO 72h DBG_PRBS_ERR_CNT GO 78h DBG_PRS_ERR_CNT GO 77ch DBG_PRS_ERR_CNT GO 77ch DBG_PRS_ERR_CNT GO 86h ANA_CRGMII_DLL_CTRL RGMII Delay Control Register in Shift Mode GO 86h ANA_RGMII_DLL_CTRL RGMINSEL_AB GO A0h ANA_LD_TKG_FINE_GAINSEL_AB GO A1h ANA_LD_TKG_FINE_GAINSEL_CD GO A2h ANA_LD_TLTER_TUNE_AB GO A3h ANA_LD_FILTER_TUNE_CD GO C6h ANA_PLL_PROG_PI GO C6h ANA_PLL_PROG_PI GO D6h SGMII_TESTMODE GO E9h DSP_HYBRII_CFG2 Sync_FIFO Control Register GO C7h APRICE_CFG2 Sync_FIFO Control Register GO C8h ARA_PLL_PROG_PI GO C8h RXF_STATUS GO C8h RXF_PMATCH_DATA1 GO C8h RXF_SCRON_PASS1 GO C8h RXF_PMATCH_DATA2 GO C8h RXF_SCRON_PASS2 GO C8h RXF_SCRON_PASS3 GO C8h RXF_SCRON_PASS3 GO C8h RXF_SCRON_PASS3 GO C8h RXF_SCRON_PASS3 GO C8h RXF_STATUS GO C8h RXF_SCRON_PASS3 GO C8h RXF | 55h | | | Go |
| 72h DBG_PRS_ERR_CNT Go 78h DBG_PK_LEN_PRBS Go 76h DBG_PK_LEN Go 86h ANA RGMII DL_CTRL RGMII Delay Control Register in Shift Mode Go A0h ANA LO_FILER_GAINSEL_CD Go A1h ANA_LD_FILER_GAINSEL_CD Go A2h ANA_LD_FILER_TUNE_AB Go A3h ANA_LD_FILER_TUNE_CD Go C6h ANA_NEL_PROG_PI Go D6h SGMII_TESTMODE Go E9h DSP_HYBRID_CFG2 Sync FIFO Control Register Go FEh LOOPCR Loopback Configuration Register Go 134h RXF_CFG Go 135h RXF_STATUS Go 136h RXF_PMATCH_DATA1 Go 137h RXF_PMATCH_DATA2 Go 138h RXF_SCRON_PASS1 Go 138h RXF_SCRON_PASS2 Go 138h RXF_SCRON_PASS3 Go 136h RXF_PATTERN_1 Go 13 | 6Eh | STRAP_STS | Strap Status Register | Go |
| 7Bh DBG_PKT_LEN_PRBS Go 7Ch DBG_JEG_LEN Go 86h ANA_RGMII_DLL_CTRL RGMII Delay Control Register in Shift Mode Go A0h ANA_LD_TXG_FINE_GAINSEL_CB Go A1h ANA_LD_FILTER_TUNE_AB Go A2h ANA_LD_FILTER_TUNE_CD Go C6h ANA_LD_FILTER_TUNE_CD Go C6h ANA_PLL_PROG_PI Go D6h SGMII TESTMODE Go E9h DSP_HYBRID_CFG2 Sync FIFO Control Register Go E9h LOOPCR Loopback Configuration Register Go FEh LOOPCR Loopback Configuration Register Go 13sh RXF_CFG Go 13sh RXF_PMATCH_DATA1 Go 13sh RXF_PMATCH_DATA2 Go 13sh RXF_PMATCH_DATA3 Go 13sh RXF_SCRON_PASS1 Go 13sh RXF_SCRON_PASS2 Go 13sh RXF_SCRON_PASS3 Go 13ch RXF_PATTERN_1 | 71h | DBG_PRBS_BYTE_CNT | | Go |
| 7Ch DBG IPG LEN Go 86h ANA, RGMII DLL_CTRL RGMII Delay Control Register in Shift Mode Go A0h ANA_LD_TXG_FINE_GAINSEL_CD Go A2h ANA_LD_FILTER_TUNE_AB Go A3h ANA_LD_FILTER_TUNE_CD Go C6h ANA_PLL_PROG_PI Go D6h SGMII_TESTMODE Go E9h DSP_HYBRID_CFG2 Sync FIFO Control Register Go FEh LOOPCR Loopback Configuration Register Go 134h RXF_CFG Go 135h RXF_STATUS Go 136h RXF_PMATCH_DATA1 Go 137h RXF_PMATCH_DATA2 Go 138h RXF_SCRON_PASS1 Go 139h RXF_SCRON_PASS2 Go 138h RXF_SCRON_PASS3 Go 13Ch RXF_PATTERN_1 Go 13Ch RXF_PATTERN_2 Go 13Ch RXF_PATTERN_5 Go 13Ch RXF_PATTERN_1 Go 14Ch< | 72h | DBG_PRBS_ERR_CNT | | Go |
| 86h ANA_RGMII_DLL_CTRL RGMII Delay Control Register in Shift Mode Go A0h ANA_LD_TXG_FINE_GAINSEL_AB Go A1h ANA_LD_TXG_FINE_GAINSEL_CD Go A2h ANA_LD_FILTER_TUNE_CB Go A3h ANA_LD_FILTER_TUNE_CD Go C6h ANA_PLL_PROG_PI Go D6h SGMII_TESTMODE Go E9h DSP_HYBRID_CFG2 Sync FIFO Control Register Go FEh LOOPCR Loopback Configuration Register Go 134h RXF_CFG Go 135h RXF_GTATUS Go 136h RXF_PMATCH_DATA1 Go 137h RXF_PMATCH_DATA2 Go 138h RXF_PMATCH_DATA3 Go 139h RXF_SCRON_PASS1 Go 139h RXF_SCRON_PASS2 Go 139h RXF_SCRON_PASS3 Go 130h RXF_PATTERN_3 Go 130h RXF_PATTERN_3 Go 136h RXF_PATTERN_5 Go | 7Bh | DBG_PKT_LEN_PRBS | | Go |
| A0h ANA_LD_TXG_FINE_GAINSEL_AB A1h ANA_LD_TXG_FINE_GAINSEL_CD G0 A2h ANA_LD_FILTER_TUNE_AB G0 A3h ANA_LD_FILTER_TUNE_CD G0 C6h ANA_PLL_PROG_PI G0 C6h ANA_PLL_PROG_PI G0 C6h SGMII_TESTMODE G0 E9h DSP_HYBRID_CFG2 Sync FIFO Control Register G0 FEH LOOPCR Loopback Configuration Register G0 134h RXF_CFG G0 135h RXF_STATUS G0 136h RXF_PMATCH_DATA1 G0 137h RXF_PMATCH_DATA2 G0 138h RXF_PMATCH_DATA3 G0 139h RXF_SCRON_PASS1 G0 138h RXF_SCRON_PASS2 G0 138h RXF_SCRON_PASS3 G0 136h RXF_PATTERN_1 G0 137h RXF_PATTERN_1 G0 137h RXF_PATTERN_3 G0 138h RXF_PATTERN_3 G0 138h RXF_PATTERN_4 G0 138h RXF_PATTERN_5 G0 138h RXF_PATTERN_5 G0 138h RXF_PATTERN_6 G0 141h RXF_PATTERN_7 G0 144h RXF_PATTERN_8 G0 144h RXF_PATTERN_1 G0 145h RXF_PATTERN_1 G0 146h RXF_PATTERN_1 G0 147h RXF_PATTERN_1 G0 148h RXF_PATTERN_1 | 7Ch | DBG_IPG_LEN | | Go |
| A1h ANA_LD_TXG_FINE_GAINSEL_CD Go A2h ANA_LD_FILTER_TUNE_AB Go A3h ANA_LD_FILTER_TUNE_CD Go C6h ANA_PLL_PROG_PI Go D6h SGMII_TESTMODE Go E9h DSP_HYBRID_CFG2 Sync FIFO Control Register Go FEh LOOPCR Loopback Configuration Register Go 134h RXF_CFG Go 135h RXF_STATUS Go 136h RXF_MATCH_DATA1 Go 137h RXF_PMATCH_DATA2 Go 138h RXF_PMATCH_DATA3 Go 139h RXF_SCRON_PASS1 Go 13Ah RXF_SCRON_PASS2 Go 136h RXF_PATTERN_1 Go 130h RXF_PATTERN_2 Go 136h RXF_PATTERN_3 Go 136h RXF_PATTERN_5 Go 136h RXF_PATTERN_5 Go 147h RXF_PATTERN_6 Go 142h RXF_PATTERN_9 Go 144h RXF_PATTERN_10 Go 145h | 86h | ANA_RGMII_DLL_CTRL | RGMII Delay Control Register in Shift Mode | Go |
| A2h ANA_LD_FILTER_TUNE_AB Go A3h ANA_LD_FILTER_TUNE_CD Go C6h ANA_PL_PROG_PI Go D6h SGMII_TESTMODE Go E9h DSP_HYBRID_CFG2 Sync FIFO Control Register Go FEh LOOPCR Loopback Configuration Register Go 134h RXF_CFG Go 135h RXF_STATUS Go 136h RXF_PMATCH_DATA1 Go 137h RXF_PMATCH_DATA2 Go 138h RXF_PMATCH_DATA3 Go 139h RXF_SCRON_PASS1 Go 13Ah RXF_SCRON_PASS2 Go 13Ah RXF_PATTERN_1 Go 13Ch RXF_PATTERN_2 Go 13Ch RXF_PATTERN_3 Go 13Ch RXF_PATTERN_3 Go 13Ch RXF_PATTERN_4 Go 13Ch RXF_PATTERN_5 Go 14Dh RXF_PATTERN_6 Go 14Dh RXF_PATTERN_9 Go 144h RXF_PATTERN_10 Go 145h RX | A0h | ANA_LD_TXG_FINE_GAINSEL_AB | | Go |
| A3h ANA_LD_FILTER_TUNE_CD Go C6h ANA_PLL_PROG_PI Go D6h SGMII_TESTMODE Go E9h DSP_HYBRID_CFG2 Sync FIFO Control Register Go FEh LOOPCR Loopback Configuration Register Go 134h RXF_CFG Go 135h RXF_STATUS Go 136h RXF_PMATCH_DATA1 Go 137h RXF_PMATCH_DATA2 Go 138h RXF_PMATCH_DATA3 Go 138h RXF_SCRON_PASS1 Go 134h RXF_SCRON_PASS2 Go 136h RXF_SCRON_PASS3 Go 136h RXF_PATTERN_1 Go 130h RXF_PATTERN_2 Go 136h RXF_PATTERN_3 Go 136h RXF_PATTERN_3 Go 140h RXF_PATTERN_5 Go 144h RXF_PATTERN_6 Go 144h RXF_PATTERN_8 Go 144h RXF_PATTERN_10 Go | A1h | ANA_LD_TXG_FINE_GAINSEL_CD | | Go |
| C6h ANA_PLL_PROG_PI Go D6h SGMII_TESTMODE Go E9h DSP_HYBRID_CFG2 Sync FIFO Control Register Go FEh LOOPCR Loopback Configuration Register Go 134h RXF_CFG Go 135h RXF_STATUS Go 136h RXF_PMATCH_DATA1 Go 137h RXF_PMATCH_DATA2 Go 138h RXF_PMATCH_DATA3 Go 138h RXF_PMATCH_DATA3 Go 134h RXF_PAMACH_DATA3 Go 134h RXF_SCRON_PASS1 Go 134h RXF_SCRON_PASS2 Go 135h RXF_PATTERN_1 Go 136h RXF_PATTERN_1 Go 137h RXF_PATTERN_3 Go 137h RXF_PATTERN_6 Go | A2h | ANA_LD_FILTER_TUNE_AB | | Go |
| D6h SGMII_TESTMODE Go E9h DSP_HYBRID_CFG2 Sync FIFO Control Register Go FEh LOOPCR Loopback Configuration Register Go 134h RXF_CFG Go 135h RXF_STATUS Go 136h RXF_PMATCH_DATA1 Go 137h RXF_PMATCH_DATA2 Go 138h RXF_PMATCH_DATA3 Go 138h RXF_SCRON_PASS1 Go 134h RXF_SCRON_PASS2 Go 136h RXF_PATTERN_1 Go 13Ch RXF_PATTERN_1 Go 13Ch RXF_PATTERN_2 Go 13Ch RXF_PATTERN_3 Go 13Fh RXF_PATTERN_4 Go 140h RXF_PATTERN_6 Go 144h RXF_PATTERN_6 Go 144h RXF_PATTERN_9 Go 144h RXF_PATTERN_9 Go 144h RXF_PATTERN_10 Go 144h RXF_PATTERN_11 Go <td< td=""><td>A3h</td><td>ANA_LD_FILTER_TUNE_CD</td><td></td><td>Go</td></td<> | A3h | ANA_LD_FILTER_TUNE_CD | | Go |
| E9h DSP_HYBRID_CFG2 Sync FIFO Control Register Go FEh LOOPCR Loopback Configuration Register Go 134h RXF_CFG Go 135h RXF_STATUS Go 136h RXF_PMATCH_DATA1 Go 137h RXF_PMATCH_DATA2 Go 138h RXF_PMATCH_DATA3 Go 139h RXF_SCRON_PASS1 Go 134h RXF_SCRON_PASS2 Go 13Ah RXF_SCRON_PASS3 Go 13Ch RXF_PATTERN_1 Go 13Dh RXF_PATTERN_2 Go 13Fh RXF_PATTERN_3 Go 13Fh RXF_PATTERN_4 Go 140h RXF_PATTERN_5 Go 141h RXF_PATTERN_6 Go 142h RXF_PATTERN_1 Go 143h RXF_PATTERN_1 Go 144h RXF_PATTERN_1 Go 145h RXF_PATTERN_1 Go 146h RXF_PATTERN_11 Go <t< td=""><td>C6h</td><td>ANA_PLL_PROG_PI</td><td></td><td>Go</td></t<> | C6h | ANA_PLL_PROG_PI | | Go |
| FEh LOOPCR Loopback Configuration Register Go 134h RXF_CFG Go 135h RXF_STATUS Go 136h RXF_PMATCH_DATA1 Go 137h RXF_PMATCH_DATA2 Go 138h RXF_PMATCH_DATA3 Go 139h RXF_SCRON_PASS1 Go 134h RXF_SCRON_PASS2 Go 136h RXF_PATTERN_1 Go 13Ch RXF_PATTERN_2 Go 13Ch RXF_PATTERN_2 Go 13Ch RXF_PATTERN_3 Go 13Fh RXF_PATTERN_3 Go 140h RXF_PATTERN_5 Go 141h RXF_PATTERN_5 Go 142h RXF_PATTERN_8 Go 144h RXF_PATTERN_10 Go 144h RXF_PATTERN_11 Go 146h RXF_PATTERN_11 Go 147h RXF_PATTERN_12 Go 148h RXF_PATTERN_13 Go 149h RXF_PATTERN_15 | D6h | SGMII_TESTMODE | | Go |
| 134h RXF_CFG Go 135h RXF_STATUS Go 136h RXF_PMATCH_DATA1 Go 137h RXF_PMATCH_DATA2 Go 138h RXF_PMATCH_DATA3 Go 139h RXF_SCRON_PASS1 Go 13Ah RXF_SCRON_PASS2 Go 13Bh RXF_PATTERN_1 Go 13Ch RXF_PATTERN_2 Go 13Dh RXF_PATTERN_3 Go 13Fh RXF_PATTERN_3 Go 140h RXF_PATTERN_6 Go 141h RXF_PATTERN_5 Go 142h RXF_PATTERN_6 Go 143h RXF_PATTERN_9 Go 144h RXF_PATTERN_9 Go 144h RXF_PATTERN_10 Go 146h RXF_PATTERN_11 Go 147h RXF_PATTERN_12 Go 148h RXF_PATTERN_15 Go 149h RXF_PATTERN_16 Go 149h RXF_PATTERN_15 Go 149h RXF_PATTERN_16 Go 140h RXF_PA | E9h | DSP_HYBRID_CFG2 | Sync FIFO Control Register | Go |
| 135h RXF_STATUS Go 136h RXF_PMATCH_DATA1 Go 137h RXF_PMATCH_DATA2 Go 138h RXF_PMATCH_DATA3 Go 139h RXF_SCRON_PASS1 Go 13Ah RXF_SCRON_PASS2 Go 13Bh RXF_SCRON_PASS3 Go 13Ch RXF_PATTERN_1 Go 13Dh RXF_PATTERN_2 Go 13Eh RXF_PATTERN_3 Go 13Fh RXF_PATTERN_4 Go 140h RXF_PATTERN_5 Go 141h RXF_PATTERN_6 Go 142h RXF_PATTERN_7 Go 143h RXF_PATTERN_8 Go 144h RXF_PATTERN_9 Go 145h RXF_PATTERN_10 Go 146h RXF_PATTERN_11 Go 147h RXF_PATTERN_12 Go 148h RXF_PATTERN_15 Go 149h RXF_PATTERN_15 Go 140h RXF_PATTERN_16 Go 140h RXF_PATTERN_16 Go 140h <t< td=""><td>FEh</td><td>LOOPCR</td><td>Loopback Configuration Register</td><td>Go</td></t<> | FEh | LOOPCR | Loopback Configuration Register | Go |
| 136h RXF_PMATCH_DATA1 Go 137h RXF_PMATCH_DATA2 Go 138h RXF_PMATCH_DATA3 Go 139h RXF_SCRON_PASS1 Go 13Ah RXF_SCRON_PASS2 Go 13Bh RXF_SCRON_PASS3 Go 13Ch RXF_PATTERN_1 Go 13Dh RXF_PATTERN_2 Go 13Eh RXF_PATTERN_3 Go 13Fh RXF_PATTERN_4 Go 140h RXF_PATTERN_5 Go 141h RXF_PATTERN_6 Go 142h RXF_PATTERN_7 Go 143h RXF_PATTERN_8 Go 144h RXF_PATTERN_9 Go 145h RXF_PATTERN_10 Go 146h RXF_PATTERN_11 Go 147h RXF_PATTERN_12 Go 148h RXF_PATTERN_13 Go 149h RXF_PATTERN_15 Go 149h RXF_PATTERN_15 Go 140h RXF_PATTERN_15 Go 140h RXF_PATTERN_16 Go 140h | 134h | RXF_CFG | | Go |
| 137h RXF_PMATCH_DATA2 Go 138h RXF_PMATCH_DATA3 Go 139h RXF_SCRON_PASS1 Go 13Ah RXF_SCRON_PASS2 Go 13Bh RXF_SCRON_PASS3 Go 13Ch RXF_PATTERN_1 Go 13Dh RXF_PATTERN_2 Go 13Fh RXF_PATTERN_3 Go 13Fh RXF_PATTERN_4 Go 140h RXF_PATTERN_5 Go 141h RXF_PATTERN_6 Go 142h RXF_PATTERN_7 Go 143h RXF_PATTERN_8 Go 144h RXF_PATTERN_9 Go 145h RXF_PATTERN_10 Go 146h RXF_PATTERN_11 Go 147h RXF_PATTERN_12 Go 148h RXF_PATTERN_13 Go 149h RXF_PATTERN_14 Go 140h RXF_PATTERN_15 Go 148h RXF_PATTERN_16 Go 148h RXF_PATTERN_16 Go 140h RXF_PATTERN_18 Go 140h | 135h | RXF_STATUS | | Go |
| 138h RXF_PMATCH_DATA3 Go 139h RXF_SCRON_PASS1 Go 13Ah RXF_SCRON_PASS2 Go 13Bh RXF_SCRON_PASS3 Go 13Ch RXF_PATTERN_1 Go 13Dh RXF_PATTERN_2 Go 13Fh RXF_PATTERN_3 Go 13Fh RXF_PATTERN_4 Go 140h RXF_PATTERN_5 Go 141h RXF_PATTERN_6 Go 142h RXF_PATTERN_8 Go 143h RXF_PATTERN_8 Go 144h RXF_PATTERN_10 Go 145h RXF_PATTERN_10 Go 146h RXF_PATTERN_11 Go 147h RXF_PATTERN_12 Go 148h RXF_PATTERN_13 Go 149h RXF_PATTERN_14 Go 140h RXF_PATTERN_15 Go 14Bh RXF_PATTERN_16 Go 14Ch RXF_PATTERN_17 Go 14Dh RXF_PATTERN_18 Go | 136h | RXF_PMATCH_DATA1 | | Go |
| 139h RXF_SCRON_PASS1 Go 13Ah RXF_SCRON_PASS2 Go 13Bh RXF_SCRON_PASS3 Go 13Ch RXF_PATTERN_1 Go 13Dh RXF_PATTERN_2 Go 13Eh RXF_PATTERN_3 Go 13Fh RXF_PATTERN_4 Go 140h RXF_PATTERN_5 Go 141h RXF_PATTERN_6 Go 142h RXF_PATTERN_7 Go 143h RXF_PATTERN_8 Go 144h RXF_PATTERN_9 Go 146h RXF_PATTERN_10 Go 146h RXF_PATTERN_11 Go 147h RXF_PATTERN_12 Go 148h RXF_PATTERN_13 Go 149h RXF_PATTERN_14 Go 14h RXF_PATTERN_15 Go 14h RXF_PATTERN_16 Go 14h RXF_PATTERN_17 Go 14h RXF_PATTERN_18 Go 14Dh RXF_PATTERN_18 Go 14Dh RXF_PATTERN_19 Go | 137h | RXF_PMATCH_DATA2 | | Go |
| 13Ah RXF_SCRON_PASS2 Go 13Bh RXF_SCRON_PASS3 Go 13Ch RXF_PATTERN_1 Go 13Dh RXF_PATTERN_2 Go 13Eh RXF_PATTERN_3 Go 13Fh RXF_PATTERN_4 Go 140h RXF_PATTERN_5 Go 141h RXF_PATTERN_5 Go 142h RXF_PATTERN_6 Go 142h RXF_PATTERN_7 Go 143h RXF_PATTERN_8 Go 144h RXF_PATTERN_9 Go 145h RXF_PATTERN_10 Go 146h RXF_PATTERN_11 Go 147h RXF_PATTERN_12 Go 148h RXF_PATTERN_13 Go 149h RXF_PATTERN_14 Go 14Ah RXF_PATTERN_15 Go 14Bh RXF_PATTERN_16 Go 14Ch RXF_PATTERN_17 Go 14Dh RXF_PATTERN_18 Go 14Dh RXF_PATTERN_19 Go | 138h | RXF_PMATCH_DATA3 | | Go |
| 13Bh RXF_SCRON_PASS3 Go 13Ch RXF_PATTERN_1 Go 13Dh RXF_PATTERN_2 Go 13Eh RXF_PATTERN_3 Go 13Fh RXF_PATTERN_4 Go 140h RXF_PATTERN_5 Go 141h RXF_PATTERN_6 Go 142h RXF_PATTERN_7 Go 143h RXF_PATTERN_8 Go 144h RXF_PATTERN_9 Go 145h RXF_PATTERN_10 Go 146h RXF_PATTERN_11 Go 147h RXF_PATTERN_12 Go 148h RXF_PATTERN_13 Go 149h RXF_PATTERN_14 Go 14Ah RXF_PATTERN_15 Go 14Bh RXF_PATTERN_16 Go 14Ch RXF_PATTERN_17 Go 14Dh RXF_PATTERN_18 Go 14Dh RXF_PATTERN_19 Go | 139h | RXF_SCRON_PASS1 | | Go |
| 13Ch RXF_PATTERN_1 Go 13Dh RXF_PATTERN_2 Go 13Eh RXF_PATTERN_3 Go 13Fh RXF_PATTERN_4 Go 140h RXF_PATTERN_5 Go 141h RXF_PATTERN_6 Go 142h RXF_PATTERN_7 Go 143h RXF_PATTERN_8 Go 144h RXF_PATTERN_9 Go 145h RXF_PATTERN_10 Go 146h RXF_PATTERN_11 Go 147h RXF_PATTERN_12 Go 148h RXF_PATTERN_13 Go 149h RXF_PATTERN_14 Go 14Ah RXF_PATTERN_15 Go 14Bh RXF_PATTERN_16 Go 14Ch RXF_PATTERN_17 Go 14Dh RXF_PATTERN_18 Go 14Dh RXF_PATTERN_18 Go | 13Ah | RXF_SCRON_PASS2 | | Go |
| 13Dh RXF_PATTERN_2 Go 13Eh RXF_PATTERN_3 Go 13Fh RXF_PATTERN_4 Go 140h RXF_PATTERN_5 Go 141h RXF_PATTERN_6 Go 142h RXF_PATTERN_7 Go 143h RXF_PATTERN_8 Go 144h RXF_PATTERN_9 Go 145h RXF_PATTERN_10 Go 146h RXF_PATTERN_11 Go 147h RXF_PATTERN_12 Go 148h RXF_PATTERN_13 Go 149h RXF_PATTERN_14 Go 14Ah RXF_PATTERN_15 Go 14Bh RXF_PATTERN_16 Go 14Ch RXF_PATTERN_17 Go 14Dh RXF_PATTERN_18 Go 14Eh RXF_PATTERN_19 Go | 13Bh | RXF_SCRON_PASS3 | | Go |
| 13Eh RXF_PATTERN_3 Go 13Fh RXF_PATTERN_4 Go 140h RXF_PATTERN_5 Go 141h RXF_PATTERN_6 Go 142h RXF_PATTERN_7 Go 143h RXF_PATTERN_8 Go 144h RXF_PATTERN_9 Go 145h RXF_PATTERN_10 Go 146h RXF_PATTERN_11 Go 147h RXF_PATTERN_12 Go 148h RXF_PATTERN_13 Go 149h RXF_PATTERN_14 Go 14Bh RXF_PATTERN_15 Go 14Bh RXF_PATTERN_16 Go 14Ch RXF_PATTERN_17 Go 14Dh RXF_PATTERN_18 Go 14Eh RXF_PATTERN_19 Go | 13Ch | RXF_PATTERN_1 | | Go |
| 13Fh RXF_PATTERN_4 Go 140h RXF_PATTERN_5 Go 141h RXF_PATTERN_6 Go 142h RXF_PATTERN_7 Go 143h RXF_PATTERN_8 Go 144h RXF_PATTERN_9 Go 145h RXF_PATTERN_10 Go 146h RXF_PATTERN_11 Go 147h RXF_PATTERN_12 Go 148h RXF_PATTERN_13 Go 149h RXF_PATTERN_14 Go 14Ah RXF_PATTERN_15 Go 14Bh RXF_PATTERN_16 Go 14Ch RXF_PATTERN_17 Go 14Dh RXF_PATTERN_18 Go 14Eh RXF_PATTERN_19 Go | 13Dh | RXF_PATTERN_2 | | Go |
| 140h RXF_PATTERN_5 Go 141h RXF_PATTERN_6 Go 142h RXF_PATTERN_7 Go 143h RXF_PATTERN_8 Go 144h RXF_PATTERN_9 Go 145h RXF_PATTERN_10 Go 146h RXF_PATTERN_11 Go 147h RXF_PATTERN_12 Go 148h RXF_PATTERN_13 Go 149h RXF_PATTERN_14 Go 14Ah RXF_PATTERN_15 Go 14Bh RXF_PATTERN_16 Go 14Ch RXF_PATTERN_17 Go 14Dh RXF_PATTERN_18 Go 14Eh RXF_PATTERN_19 Go | 13Eh | RXF_PATTERN_3 | | Go |
| 141h RXF_PATTERN_6 Go 142h RXF_PATTERN_7 Go 143h RXF_PATTERN_8 Go 144h RXF_PATTERN_9 Go 145h RXF_PATTERN_10 Go 146h RXF_PATTERN_11 Go 147h RXF_PATTERN_12 Go 148h RXF_PATTERN_13 Go 149h RXF_PATTERN_14 Go 14Ah RXF_PATTERN_15 Go 14Bh RXF_PATTERN_16 Go 14Ch RXF_PATTERN_17 Go 14Dh RXF_PATTERN_18 Go 14Eh RXF_PATTERN_19 Go | 13Fh | RXF_PATTERN_4 | | Go |
| 142h RXF_PATTERN_7 Go 143h RXF_PATTERN_8 Go 144h RXF_PATTERN_9 Go 145h RXF_PATTERN_10 Go 146h RXF_PATTERN_11 Go 147h RXF_PATTERN_12 Go 148h RXF_PATTERN_13 Go 149h RXF_PATTERN_14 Go 14Ah RXF_PATTERN_15 Go 14Bh RXF_PATTERN_16 Go 14Ch RXF_PATTERN_17 Go 14Dh RXF_PATTERN_18 Go 14Eh RXF_PATTERN_19 Go | 140h | RXF_PATTERN_5 | | Go |
| 143h RXF_PATTERN_8 Go 144h RXF_PATTERN_9 Go 145h RXF_PATTERN_10 Go 146h RXF_PATTERN_11 Go 147h RXF_PATTERN_12 Go 148h RXF_PATTERN_13 Go 149h RXF_PATTERN_14 Go 14Ah RXF_PATTERN_15 Go 14Bh RXF_PATTERN_16 Go 14Ch RXF_PATTERN_17 Go 14Dh RXF_PATTERN_18 Go 14Eh RXF_PATTERN_19 Go | 141h | RXF_PATTERN_6 | | Go |
| 144h RXF_PATTERN_9 Go 145h RXF_PATTERN_10 Go 146h RXF_PATTERN_11 Go 147h RXF_PATTERN_12 Go 148h RXF_PATTERN_13 Go 149h RXF_PATTERN_14 Go 14Ah RXF_PATTERN_15 Go 14Bh RXF_PATTERN_16 Go 14Ch RXF_PATTERN_17 Go 14Dh RXF_PATTERN_18 Go 14Eh RXF_PATTERN_19 Go | 142h | RXF_PATTERN_7 | | Go |
| 145h RXF_PATTERN_10 Go 146h RXF_PATTERN_11 Go 147h RXF_PATTERN_12 Go 148h RXF_PATTERN_13 Go 149h RXF_PATTERN_14 Go 14Ah RXF_PATTERN_15 Go 14Bh RXF_PATTERN_16 Go 14Ch RXF_PATTERN_17 Go 14Dh RXF_PATTERN_18 Go 14Eh RXF_PATTERN_19 Go | 143h | RXF_PATTERN_8 | | Go |
| 146h RXF_PATTERN_11 Go 147h RXF_PATTERN_12 Go 148h RXF_PATTERN_13 Go 149h RXF_PATTERN_14 Go 14Ah RXF_PATTERN_15 Go 14Bh RXF_PATTERN_16 Go 14Ch RXF_PATTERN_17 Go 14Dh RXF_PATTERN_18 Go 14Eh RXF_PATTERN_19 Go | 144h | RXF_PATTERN_9 | | Go |
| 147h RXF_PATTERN_12 Go 148h RXF_PATTERN_13 Go 149h RXF_PATTERN_14 Go 14Ah RXF_PATTERN_15 Go 14Bh RXF_PATTERN_16 Go 14Ch RXF_PATTERN_17 Go 14Dh RXF_PATTERN_18 Go 14Eh RXF_PATTERN_19 Go | 145h | RXF_PATTERN_10 | | Go |
| 148h RXF_PATTERN_13 Go 149h RXF_PATTERN_14 Go 14Ah RXF_PATTERN_15 Go 14Bh RXF_PATTERN_16 Go 14Ch RXF_PATTERN_17 Go 14Dh RXF_PATTERN_18 Go 14Eh RXF_PATTERN_19 Go | 146h | RXF_PATTERN_11 | | Go |
| 149h RXF_PATTERN_14 Go 14Ah RXF_PATTERN_15 Go 14Bh RXF_PATTERN_16 Go 14Ch RXF_PATTERN_17 Go 14Dh RXF_PATTERN_18 Go 14Eh RXF_PATTERN_19 Go | 147h | RXF_PATTERN_12 | | Go |
| 14Ah RXF_PATTERN_15 Go 14Bh RXF_PATTERN_16 Go 14Ch RXF_PATTERN_17 Go 14Dh RXF_PATTERN_18 Go 14Eh RXF_PATTERN_19 Go | 148h | RXF_PATTERN_13 | | Go |
| 14Bh RXF_PATTERN_16 Go 14Ch RXF_PATTERN_17 Go 14Dh RXF_PATTERN_18 Go 14Eh RXF_PATTERN_19 Go | 149h | RXF_PATTERN_14 | | Go |
| 14Ch RXF_PATTERN_17 Go 14Dh RXF_PATTERN_18 Go 14Eh RXF_PATTERN_19 Go | 14Ah | RXF_PATTERN_15 | | Go |
| 14Dh RXF_PATTERN_18 Go 14Eh RXF_PATTERN_19 Go | 14Bh | RXF_PATTERN_16 | | Go |
| 14Eh RXF_PATTERN_19 Go | 14Ch | RXF_PATTERN_17 | | Go |
| - | 14Dh | RXF_PATTERN_18 | | Go |
| 14Fh RXF_PATTERN_20 Go | 14Eh | RXF_PATTERN_19 | | Go |
| | 14Fh | RXF_PATTERN_20 | | Go |



Table 7-20. DP83869 Registers (continued)

| Offset | Acronym | -20. DP83869 Registers (continued) Register Name | Section |
|--------|-------------------------|--|---------|
| 150h | RXF_PATTERN_21 | | Go |
| 151h | RXF_PATTERN_22 | | Go |
| 152h | RXF_PATTERN_23 | | Go |
| 153h | RXF PATTERN 24 | | Go |
| 154h | RXF_PATTERN_25 | | Go |
| 155h | RXF_PATTERN_26 | | Go |
| 156h | RXF_PATTERN_27 | | Go |
| 157h | RXF_PATTERN_28 | | Go |
| 158h | RXF_PATTERN_29 | | Go |
| 159h | RXF_PATTERN_30 | | Go |
| 15Ah | RXF_PATTERN_31 | | Go |
| 15Bh | RXF_PATTERN_32 | | Go |
| 15Ch | RXF_PATTERN_BYTE_MASK_1 | | Go |
| 15Dh | RXF_PATTERN_BYTE_MASK_2 | | Go |
| 15Eh | RXF_PATTERN_BYTE_MASK_3 | | Go |
| 15Fh | RXF_PATTERN_BYTE_MASK_4 | | Go |
| 16Fh | 10M SGMII CFG | | Go |
| 170h | IO_MUX_CFG | | Go |
| 180h | TDR_GEN_CFG1 | | Go |
| 181h | TDR_GEN_CFG2 | | Go |
| 182h | TDR_SEG_DURATION1 | | Go |
| 183h | TDR_SEG_DURATION2 | | Go |
| 184h | TDR_GEN_CFG3 | | Go |
| 185h | TDR_GEN_CFG4 | | Go |
| 190h | TDR_PEAKS_LOC_A_0_1 | | Go |
| 191h | TDR_PEAKS_LOC_A_2_3 | | Go |
| 192h | TDR_PEAKS_LOC_A_4_B_0 | | Go |
| 193h | TDR_PEAKS_LOC_B_1_2 | | Go |
| 194h | TDR_PEAKS_LOC_B_3_4 | | Go |
| 195h | TDR_PEAKS_LOC_C_0_1 | | Go |
| 196h | TDR_PEAKS_LOC_C_2_3 | | Go |
| 197h | TDR_PEAKS_LOC_C_4_D_0 | | Go |
| 198h | TDR_PEAKS_LOC_D_1_2 | | Go |
| 199h | TDR_PEAKS_LOC_D_3_4 | | Go |
| 1A4h | TDR_GEN_STATUS | | Go |
| 1A5h | TDR_PEAKS_SIGN_A_B | | Go |
| 1A6h | TDR_PEAKS_SIGN_C_D | | Go |
| 1A8h | DBG_PRBS_PKT_CNT_1 | | Go |
| 1A9h | DBG_PRBS_PKT_CNT_2 | | Go |
| 1DFh | OP_MODE_DECODE | | Go |
| 1E0h | GPIO_MUX_CTRL | | Go |
| 1ECh | MC_LINK_LOSS | | Go |
| C00h | FX_CTRL | Fiber Control Register | Go |
| C01h | FX_STS | Fiber Status Register | Go |
| | FX_PHYID1 | Fiber PHYID Register 1 | Go |

Table 7-20. DP83869 Registers (continued)

| Offset | Acronym | Register Name | Section |
|--------|-----------------|--|---------|
| C03h | FX_PHYID2 | Fiber PHYID Register 2 | Go |
| C04h | FX_ANADV | Fiber Autonegotiation Advertisement Register | Go |
| C05h | FX_LPABL | Fiber Link Partner Ability Register | Go |
| C06h | FX_ANEXP | Fiber Autonegotiation Expansion Register | Go |
| C07h | FX_LOCNP | Fiber LOC Next Page Register | Go |
| C08h | FX_LPNP | Fiber Link Partner Next Page Register | Go |
| C10h | CFG_FX_CTRL0 | Fiber Signal Detect | Go |
| C18h | FX_INT_EN | Fiber Interrupt Enable Register | Go |
| C19h | FX_INT_STS | Fiber Interrupt Status Register | Go |
| C1Ah | BIST_CONTROL_FX | Fiber Reverse Loopback | Go |
| C30h | CFG_100FX_CTRL5 | Signal Detect Polarity Configuration | Go |

Complex bit access types are encoded to fit into small table cells. Table 7-21 shows the codes that are used for access types in this section.

Table 7-21. DP83869 Access Type Codes

| Table 7-21. DP63669 Access Type Codes | | | | | | |
|---------------------------------------|------------------------|--|--|--|--|--|
| Access Type | Code | Description | | | | |
| Read Type | | | | | | |
| R | R | Read | | | | |
| RC | R C | Read to Clear | | | | |
| RH | R H | Read Set or cleared by hardware | | | | |
| Write Type | | | | | | |
| W | w | Write | | | | |
| W1C | W 1C | Write 1 to clear | | | | |
| WoP | w | Write | | | | |
| WtoPH | W | Write | | | | |
| Reset or Default | Reset or Default Value | | | | | |
| -n | | Value after reset or the default value | | | | |

7.6.1.1 BMCR Register (Offset = 0h) [Reset = 1140h]

BMCR is shown in Table 7-22.

Return to the Summary Table.

IEEE defined register to control PHY functionality.

Table 7-22. BMCR Register Field Descriptions

| | 14.5.0 · 22. 2 or regions i loid 2000. p. 10 | | | | | | |
|-----|--|------|-------|---|--|--|--|
| Bit | Field | Туре | Reset | Description | | | |
| 15 | RESET | R/W | 0h | This bit controls the MII reset function. This bit is self cleared after reset is completed. 0h = Normal Operation 1h = Reset. | | | |
| 14 | MII_LOOPBACK | R/W | 0h | This bit controls the MII Loopback. When enabled, this sends data back to the MAC 0h = Disable 1h = Enable | | | |



Table 7-22. BMCR Register Field Descriptions (continued)

| Bit | Field | | Reset | Pagarintian |
|-----|---------------|---------|--------|---|
| Віт | 1 | Туре | 110000 | Description |
| 13 | SPEED_SEL_LSB | R/W | Oh | Speed selection bits LSB[13] and MSB[6] are used to control the data rate of the ethernet link when auto-negotiation is disabled. 0h = 10Mbps 1h = 100Mbps 2h = 1000Mbps 3h = Reserved |
| 12 | AUTONEG_EN | R/W | 1h | Controls autonegotiation feature 0h = Autonegotiation off 1h = Autonegotiation on |
| 11 | PWD_DWN | R | 0h | Controls IEEE power down feature 0h = Normal Mode 1h = IEEE power down mode |
| 10 | ISOLATE | R/W | 0h | Isolate MAC interface pins. 0h = Normal mode 1h = MAC Isolate mode enabled |
| 9 | RSTRT_AUTONEG | R/WtoPH | 0h | Restart auto-negotiation 0h = Normal mode 1h = Restart autonegotiation |
| 8 | DUPLEX_EN | R/W | 1h | Controls Half and Full duplex mode of the ethernet link 0h = Half Duplex mode 1h = Full Duplex mode |
| 7 | COL_TST | R/W | 0h | Controls Collision Signal Test 0h = Disable Collision Signal Test 1h = Enable Collision Signal Test |
| 6 | SPEED_SEL_MSB | R | 1h | Controls data rate of ethernet link when autonegotiation is disabled. See bit 13 description for more information. |
| 5-0 | RESERVED | R | 0h | Reserved |

7.6.1.2 BMSR Register (Offset = 1h) [Reset = 7949h]

BMSR is shown in Table 7-23.

Return to the Summary Table.

IEEE defined register to show status of PHY

Table 7-23. BMSR Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-----|-----------|------|-------|---|
| 15 | RESERVED | R | 0h | Reserved |
| 14 | 100M_FDUP | R | 1h | 100Base-TX full duplex 0h = PHY not able to perform full duplex 100Base-X 1h = PHY able to perform full duplex 100Base-X |
| 13 | 100M_HDUP | R | 1h | 100Base-TX halfduplex 0h = PHY not able to perform half duplex 100Base-X 1h = PHY able to perform half duplex 100Base-X |
| 12 | 10M_FDUP | R | 1h | 10Base-Te full duplex 0h = PHY not able to operate at 10Mbps in full duplex 1h = PHY able to operate at 10Mbps in full duplex |
| 11 | 10M_HDUP | R | 1h | 10Base-Te half duplex 0h = PHY not able to operate at 10Mbps in half duplex 1h = PHY able to operate at 10Mbps in half duplex |
| 10 | RESERVED | R | 0h | Reserved |
| 9 | RESERVED | R | 0h | Reserved |
| 8 | EXT_STS | R | 1h | Extended status for 1000Base T abilities in register 15 1h = Extended status information in register 0x0F |
| 7 | RESERVED | R | 0h | Reserved |

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Table 7-23. BMSR Register Field Descriptions (continued)

| | | | | r Field Descriptions (continued) |
|-----|-----------------|------|-------|---|
| Bit | Field | Type | Reset | Description |
| 6 | MF_PREAMBLE_SUP | R | 1h | Ability to accept management frames with preamble suppressed. Oh = PHY does not accept management frames with preamble suppressed 1h = PHY accepts management frames with preamble suppressed |
| 5 | AUTONEG_COMP | R | Oh | Status of Autonegotiation 0h = Auto Negotiation process not completed 1h = Auto Negotiation process completed |
| 4 | REMOTE_FAULT | RC | Oh | Remote fault detection 0h = No remote fault condition detected 1h = Remote fault condition detected |
| 3 | AUTONEG_ABL | R | 1h | Autonegotiation ability 0h = PHY is not able to perform Auto-Negotiation 1h = PHY is able to perform Auto-Negotiation |
| 2 | LINK_STS1 | R | 0h | Link Status This is latch low and needs to be read twice for valid link up 0h = Link down 1h = Link up |
| 1 | JABBER_DTCT | RC | Oh | Jabber detected 0h = No jabber detected 1h = Jabber detected |
| 0 | EXT_CAPBLTY | R | 1h | Extended register capabilities 0h = Basic register set capabilities 1h = Extended register set capabilities |

7.6.1.3 PHYIDR1 Register (Offset = 2h) [Reset = 2000h]

PHYIDR1 is shown in Table 7-24.

Return to the Summary Table.

The PHY Identifier Registers Number 1 and Number 2 together form a unique identifier for the DP83869. The Identifier consists of a concatenation of the Organizationally Unique Identifier (OUI), the vendor's model number and the model revision number. A PHY can return a value of zero in each of the 32 bits of the PHY Identifier if desired. The PHY Identifier is intended to support network management. Texas Instruments' IEEE assigned OUI is 080028h.

Table 7-24. PHYIDR1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------|------|-------|---|
| 15-0 | OUI_MSB | R | | OUI Most Significant Bits: Bits 3 to 18 of the OUI (080028h,) are stored in bits 15 to 0 of this register respectively. Bit numbering for OUI goes from 1 (MSB) to 24(LSB). The most significant two bits of the OUI are ignored (the IEEE standard refers to these as bits 1 and 2). |

7.6.1.4 PHYIDR2 Register (Offset = 3h) [Reset = A0F1h]

PHYIDR2 is shown in Table 7-25.

Return to the Summary Table.

Table 7-25. PHYIDR2 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|-----------|------|-------|---|
| 15-10 | OUI_LSB | R | 28h | OUI Least Significant Bits: Bits 19 to 24 of the OUI (080028h) are mapped from bits 15 to 10 of this register respectively. |
| 9-4 | MODEL_NUM | R | | Model number: The six bits of vendor model number are mapped from bits 9 to 4 (most significant bit to bit 9). |



Table 7-25. PHYIDR2 Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Description |
|-----|--------------|------|-------|---|
| 3-0 | REVISION_NUM | R | | Revision number: Four bits of the vendor model revision number are mapped from bits 3 to 0 (most significant bit to bit 3). This field is to be incremented for all major device changes. |

7.6.1.5 ANAR Register (Offset = 4h) [Reset = 0001h]

ANAR is shown in Table 7-26.

Return to the Summary Table.

This register contains the advertised abilities of this device as the advertised abilities are transmitted to the PHY's link partner during Auto-Negotiation. Any writes to this register prior to completion of Auto-Negotiation (as indicated in the Basic Mode Status Register (address 01h) Auto-Negotiation Complete bit, BMSR[5]) must be followed by a renegotiation. This makes sure that the new values are properly used in the Auto-Negotiation.

Table 7-26 ANAR Register Field Descriptions

| | Table 7-26. ANAK Register Field Descriptions | | | | | | |
|-----|--|------|-------|---|--|--|--|
| Bit | Field | Туре | Reset | Description | | | |
| 15 | NEXT_PAGE_1_ADV | R/W | Oh | Next Page Advertisement 0h = Do not advertise desire to send additional SW next pages 1h = Advertise desire to send additional SW next pages | | | |
| 14 | RESERVED | R | 0h | Reserved | | | |
| 13 | REMOTE_FAULT_ADV | R/W | 0h | Remote Fault Advertisement 0h = Do not advertise remote fault event detection 1h = Advertise remote fault event detection | | | |
| 12 | ANAR_BIT12 | R/W | 0h | | | | |
| 11 | ASYMMETRIC_PAUSE_A DV | R/W | 0h | 1b = Advertise asymmetric pause ability 0b = Do not advertise asymmetric pause ability | | | |
| 10 | PAUSE_ADV | R/W | 0h | 0h = Do not advertise pause ability 1h = Advertise pause ability | | | |
| 9 | G_100BT_4_ADV | R/W | 0h | 100BT-4 is not supported | | | |
| 8 | G_100BTX_FD_ADV | R/W | Oh | 100Base-TX Full Duplex. Default depends on strap, non strap default '1'. 0h = Do not advertise 100Base-TX Full Duplex ability 1h = Advertise 100Base-TX Full Duplex ability | | | |
| 7 | G_100BTX_HD_ADV | R/W | Oh | 100Base-TX Half Duplex. Default depends on strap, non strap default '1'. 0h = Do not advertise 100Base-TX Half Duplex ability 1h = Advertise 100Base-TX Half Duplex ability | | | |
| 6 | G_10BT_FD_ADV | R/W | 0h | Default depends on strap, non strap default '1' 0h = Do not advertise 10Base-T Full Duplex ability 1h = Advertise 10Base-T Full Duplex ability | | | |
| 5 | G_10BT_HD_ADV | R/W | 0h | Default depends on strap, non strap default '1' 0h = Do not advertise 10Base-T Half Duplex ability 1h = Advertise 10Base-T Half Duplex ability | | | |
| 4-0 | SELECTOR_FIELD_ADV | R/W | 1h | Technology selector field (802.3 == 00001) | | | |

7.6.1.6 ALNPAR Register (Offset = 5h) [Reset = 0000h]

ALNPAR is shown in Table 7-27.

Return to the Summary Table.

This register contains the advertised abilities of the Link Partner as received during Auto-Negotiation. The content changes after the successful Auto-Negotiation if Next pages are supported.

Table 7-27. ALNPAR Register Field Descriptions

| | Table 7-27. ALNPAR Register Field Descriptions | | | | | | | |
|-----|--|------|-------|---|--|--|--|--|
| Bit | Field | Туре | Reset | Description | | | | |
| 15 | NEXT_PAGE_1_LP | R | 0h | 0h = Link Partner does not advertise desire to send additional SW next pages 1h = Link Partner advertises desire to send additional SW next pages | | | | |
| 14 | ACKNOWLEDGE_1_LP | R | 0h | Oh = Link Partner does not acknowledge reception of link partner's link code word 1h = Link Partner acknowledges reception of link partner's link code word | | | | |
| 13 | REMOTE_FAULT_LP | R | 0h | 0h = Link Partner does not advertise remote fault event detection 1h = Link Partner advertises remote fault event detection | | | | |
| 12 | RESERVED | R | 0h | Reserved | | | | |
| 11 | ASYMMETRIC_PAUSE_L P | R | 0h | 0h = Link Partner does not advertise asymmetric pause ability 1h = Link Partner advertises asymmetric pause ability | | | | |
| 10 | PAUSE_LP | R | 0h | 0h = Link Partner does not advertise pause ability 1h = Link Partner advertises pause ability | | | | |
| 9 | G_100BT4_LP | R | 0h | 0h = Link Partner does not advertise 100Base-T4 ability 1h = Link Partner advertises 100Base-T4 ability | | | | |
| 8 | G_100BTX_FD_LP | R | 0h | 0h = Link Partner does not advertise 100Base-TX Full Duplex ability 1h = Link Partner advertises 100Base-TX Full Duplex ability | | | | |
| 7 | G_100BTX_HD_LP | R | 0h | 0h = Link Partner does not advertise 100Base-TX Half Duplex ability 1h = Link Partner advertises 100Base-TX Half Duplex ability | | | | |
| 6 | G_10BT_FD_LP | R | 0h | 0h = Link Partner does not advertise 10Base-T Full Duplex ability 1h = Link Partner advertises 10Base-T Full Duplex ability | | | | |
| 5 | G_10BT_HD_LP | R | 0h | 0h = Link Partner does not advertise 10Base-T Half Duplex ability 1h = Link Partner advertises 10Base-T Half Duplex ability | | | | |
| 4-0 | SELECTOR_FIELD_LP | R | 0h | Technology selector field | | | | |

7.6.1.7 ANER Register (Offset = 6h) [Reset = 0064h]

ANER is shown in Table 7-28.

Return to the Summary Table.

This register contains additional Local Device and Link Partner status information.

Table 7-28. ANER Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------------|------|-------|--|
| 15-7 | RESERVED | R | 0h | Reserved |
| 6 | RX_NEXT_PAGE_LOC_A BLE | R | 1h | 0h = Received Next Page storage location is not specified by bit 6.5 1h = Received Next Page storage location is specified by bit 6.5 |
| 5 | RX_NEXT_PAGE_STOR_ LOC | R | 1h | 0h = Link Partner Next Pages are stored in register 5 1h = Link Partner Next Pages are stored in register 8 |
| 4 | PRLL_TDCT_FAULE | RC | 0h | THIS STATUS IS LH (Latched-High) 0h = A fault has not been detected during the parallel detection process 1h = A fault has been detected during the parallel detection process |
| 3 | LP_NP_ABLE | R | 0h | 0h = Link partner is not able to exchange next pages 1h = Link partner is able to exchange next pages |
| 2 | LOCAL_NP_ABLE | R | 1h | 0h = Local device is not able to exchange next pages 1h = Local device is able to exchange next pages |
| 1 | PAGE_RECEIVED_1 | RC | 0h | THIS STATUS IS LH (Latched-High) 0h = A new page has not been received 1h = A new page has been received |



Table 7-28. ANER Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Description |
|-----|-----------------|------|-------|---|
| 0 | LP_AUTONEG_ABLE | R | 0h | 0h = Link partner is not Auto-Negotiation able 1h = Link partner is Auto-Negotiation able |

7.6.1.8 ANNPTR Register (Offset = 7h) [Reset = 2001h]

ANNPTR is shown in Table 7-29.

Return to the Summary Table.

This register contains the next page information sent by this device to the PHY's Link Partner during Auto-Negotiation.

Table 7-29. ANNPTR Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------------------|------|-------|---|
| 15 | NEXT_PAGE_2_ADV | R/W | 0h | 0h = Do not advertise desire to send additional next pages 1h = Advertise desire to send additional next pages |
| 14 | RESERVED | R | 0h | Reserved |
| 13 | MESSAGE_PAGE | R/W | 1h | 0h = Current page is an unformatted page 1h = Current page is a message page |
| 12 | ACKNOWLEDGE2 | R/W | 0h | 0h = Do not set the ACK2 bit 1h = Set the ACK2 bit |
| 11 | TOGGLE | R | 0h | Toggles every page. Initial value is !4.11 |
| 10-0 | MESSAGE_UNFORMATT ED | R/W | 1h | Contents of the message/unformatted page |

7.6.1.9 ANLNPTR Register (Offset = 8h) [Reset = 2001h]

ANLNPTR is shown in Table 7-30.

Return to the Summary Table.

This register contains the next page information sent by the Link Partner during Auto-Negotiation.

Table 7-30. ANLNPTR Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------------------------|------|-------|---|
| 15 | NEXT_PAGE_2_LP | R | Oh | Oh = Link partner does not advertise desire to send additional next pages 1h = Link partner advertises desire to send additional next pages |
| 14 | ACKNOWLEDGE_2_LP | R | 0h | 0h = Link partner does not acknowledge reception of link code work 1h = Link partner acknowledges reception of link code word |
| 13 | MESSAGE_PAGE_LP | R | 1h | 0h = Received page is an unformatted page 1h = Received page is a message page |
| 12 | ACKNOWLEDGE2_LP | R | 0h | 0h = Link partner does not set the ACK2 bit 1h = Link partner sets the ACK2 bit |
| 11 | TOGGLE_LP | R | 0h | Toggles every page. Initial value is !5.11 |
| 10-0 | MESSAGE_UNFORMATT ED_LP | R | 1h | Contents of the message/unformatted page |

7.6.1.10 GEN_CFG1 Register (Offset = 9h) [Reset = 0300h]

GEN_CFG1 is shown in Table 7-31.

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Table 7-31. GEN_CFG1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|---------------------------------|------|-------|--|
| 15-13 | TEST_MODE | R/W | Oh | 0h = Normal Mode 1h = Test Mode 1 - Transmit Waveform Test 2h = Test Mode 2 - Transmit Jitter Test (Leader Mode) 3h = Test Mode 3 - Transmit Jitter Test (Follower Mode) 4h = Test Mode 4 - Transmit Distortion Test 5h = Test Mode 5 - Scrambled MLT3 Idles 6h = Test Mode 6 - Repetitive 0001 sequence 7h = Test Mode 7 - Repetitive {Pulse, 63 zeros} |
| 12 | LEADER_FOLLOWER_M AN_CFG_EN | R/W | 0h | 0h = Do not enable manual Leader/Follower configuration 1h = Enable manual Leader/Follower configuration |
| 11 | LEADER_FOLLOWER_M AN_CFG_VAL | R/W | 0h | 0h = Manual configure as Follower 1h = Manual configure as Leader |
| 10 | PORT_TYPE | R/W | 0h | 0h = Single-port device 1h = Multi-port device |
| 9 | G_1000BT_FD_ADV | R/W | 1h | Default depends on strap 0h = Do not advertise 1000Base-T Full Duplex ability 1h = Advertise 1000Base-T Full Duplex ability |
| 8 | G_1000BT_HD_ADV | R/W | 1h | Default depends on strap 0h = Do not advertise 1000Base-T Half Duplex ability 1h = Advertise 1000Base-T Half Duplex ability |
| 7 | TDR_AUTO_RUN | R/W | 0h | TDR Auto Run at link down: 0h = Disable automatic execution of TDR 1h = Enable execution of TDR procedure after link down event |
| 6-0 | RESERVED | R | 0h | Reserved |

7.6.1.11 GEN_STATUS1 Register (Offset = Ah) [Reset = 0000h]

GEN_STATUS1 is shown in Table 7-32.

Return to the Summary Table.

Table 7-32. GEN_STATUS1 Register Field Descriptions

| | Table 7-02. GEN_GTATOOT Register Field Descriptions | | | | | | |
|-----|---|------|-------|---|--|--|--|
| Bit | Field | Туре | Reset | Description | | | |
| 15 | MS_CONFIG_FAULT | RC | Oh | Oh = No Leader/Follower configuration fault detected THIS STATUS IS LH (Latched-High) 1h = Leader/Follower configuration fault detected | | | |
| 14 | MS_CONFIG_RES | R | 0h | 0h = Local PHY configuration resolved to Follower 1h = Local PHY configuration resolved to Leader | | | |
| 13 | LOC_RCVR_STATUS_1 | R | 0h | 0h = Local receiver is not OK 1h = Local receiver is OK | | | |
| 12 | REM_RCVR_STATUS | R | 0h | 0h = Remote receiver is not OK 1h = Remote receiver is OK | | | |
| 11 | LP_1000BT_FD_ABILITY | R | 0h | 0h = Link partner does not support 1000Base-T Full Duplex ability 1h = Link partner supports 1000Base-T Full Duplex ability | | | |
| 10 | LP_1000BT_HD_ABILITY | R | 0h | 0h = Link partner does not support 1000Base-T Half Duplex ability 1h = Link partner supports 1000Base-T Half Duplex ability | | | |
| 9-8 | RESERVED | R | 0h | Reserved | | | |
| 7-0 | IDLE_ERR_COUNT | R | 0h | 1000Base-T Idle Error Counter | | | |

7.6.1.12 REGCR Register (Offset = Dh) [Reset = 0000h]

REGCR is shown in Table 7-33.

Return to the Summary Table.



This register is the MDIO Manageable MMD access control. In general, register REGCR (4:0) is the device address DEVAD that directs any accesses of the ADDAR (0x000E) register to the appropriate MMD. REGCR also contains selection bits for auto increment of the data register. This register contains the device address to be written to access the extended registers. Write 0x1F into bits 4:0 of this register. REGCR also contains selection bits (15:14) for the address auto-increment mode of ADDAR.

Table 7-33. REGCR Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|------------|------|-------|---|
| 15-14 | G_FUNCTION | R/W | 0h | 0h = Address 1h = Data, no post increment 2h = Data, post increment on read and write 3h = Data, post increment on write only |
| 13-5 | RESERVED | R | 0h | Reserved |
| 4-0 | DEVAD | R/W | 0h | Device Address |

7.6.1.13 ADDAR Register (Offset = Eh) [Reset = 0000h]

ADDAR is shown in Table 7-34.

Return to the Summary Table.

This register is the address/data MMD register. ADDAR is used in conjunction with REGCR register (0x000D) to provide the access by indirect read/write mechanism to the extended register set.

Table 7-34. ADDAR Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-----------|------|-------|--|
| 15-0 | ADDR_DATA | R/W | 0h | If register 13.15:14 = 00, holds the MMD DEVAD's address register, otherwise holds the MMD DEVAD's data register |

7.6.1.14 1KSCR Register (Offset = Fh) [Reset = F000h]

1KSCR is shown in Table 7-35.

Return to the Summary Table.

Table 7-35. 1KSCR Register Field Descriptions

| | Table 1 to 11to at 11to at 11to a 2000 il parent | | | | | |
|------|--|------|-------|--|--|--|
| Bit | Field | Туре | Reset | Description | | |
| 15 | G_1000BX_FD | R | 1h | 0h = PHY does not support 1000Base-X Full Duplex capability 1h = PHY supports 1000Base-X Full Duplex capability | | |
| 14 | G_1000BX_HD | R | 1h | 0h = PHY does not support 1000Base-X Half Duplex capability 1h = PHY supports 1000Base-X Half Duplex capability | | |
| 13 | G_1000BT_FD | R | 1h | 0h = PHY does not support 1000Base-T Full Duplex capability 1h = PHY supports 1000Base-T Full Duplex capability | | |
| 12 | G_1000BT_HD | R | 1h | 0h = PHY does not support 1000Base-T Half Duplex capability 1h = PHY supports 1000Base-T Half Duplex capability | | |
| 11-0 | RESERVED | R | 0h | Reserved | | |

7.6.1.15 PHY_CONTROL Register (Offset = 10h) [Reset = 5048h]

PHY_CONTROL is shown in Table 7-36.

Return to the Summary Table.

Table 7-36. PHY_CONTROL Register Field Descriptions

| | Table | 7-36. PHY_ | CONTROL | Register Field Descriptions |
|-------|------------------------|------------|---------|---|
| Bit | Field | Туре | Reset | Description |
| 15-14 | TX_FIFO_DEPTH | R/W | 1h | FIFO is enabled only in the following modes: 1000BaseT + GMII, 10BaseT/100BaseTX/1000BaseT + SGMII 0h = 3 bytes/nibbles (1000Mbps/Other Speeds) 1h = 4 bytes/nibbles (1000Mbps/Other Speeds) 2h = 6 bytes/nibbles (1000Mbps/Other Speeds) 3h = 8 bytes/nibbles (1000Mbps/Other Speeds) |
| 13-12 | RX_FIFO_DEPTH | R/W | 1h | FIFO is enabled only when SGMII is used 0h = 3 bytes/nibbles (1000Mbps/Other Speeds) 1h = 4 bytes/nibbles (1000Mbps/Other Speeds) 2h = 6 bytes/nibbles (1000Mbps/Other Speeds) 3h = 8 bytes/nibbles (1000Mbps/Other Speeds) |
| 11 | RESERVED | R/W | 0h | Reserved |
| 10 | FORCE_LINK_GOOD | R/W | 0h | 0h = Do Normal operation 1h = Force Link OK if speed is 1G |
| 9-8 | POWER_SAVE_MODE | R/W | Oh | 0h = Normal mode 1h = Reserved 2h = Active Sleep mode 3h = Passive Sleep mode |
| 7 | RESERVED | R/W | 0h | Reserved |
| 6-5 | MDI_CROSSOVER_MOD E | R/W | 2h | Default depends on strap 0h = Manual MDI configuration 1h = Manual MDI-X configuration Ah = Enable automatic crossover Bh = Enable automatic crossover |
| 4 | DISABLE_CLK_125 | R/W | 0h | 0h = Enable CLK125 1h = Disable CLK125 |
| 3 | RESERVED | R/W | 0h | Reserved |
| 2 | RESERVED | R/W | 0h | Reserved |
| 1 | LINE_DRIVER_INV_EN | R/W | 0h | This bit is not applicable in Mirror mode 0h = Do not Invert LD transmission 1h = Invert LD transmission |
| 0 | DISABLE_JABBER | R/W | 0h | 0h = Enable Jabber function 1h = Disable Jabber function |

7.6.1.16 PHY_STATUS Register (Offset = 11h) [Reset = 0000h]

PHY_STATUS is shown in Table 7-37.

Return to the Summary Table.

Table 7-37. PHY_STATUS Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|---------------------------|------|-------|---|
| 15-14 | SPEED_SEL | R | 0h | 0h = 10Mbps 1h = 100Mbps 2h = 1000Mbps 3h = Reserved |
| 13 | DUPLEX_MODE_ENV | R | 0h | 0h = Half duplex 1h = Full duplex |
| 12 | PAGE_RECEIVED_2 | RC | 0h | THIS BIT IS LH (Latched-High), meaning that if this bit detects "Page received," this bit holds the value '1' until the register is read. The second read is '0' if there have been no further "Page received." 0h = Page not received 1h = Page received |
| 11 | SPEED_DUPLEX_RESOL VED | R | 0h | 0h = Auto-Negotiation enabled and not completed 1h = Auto-Negotiation completed or disabled |



Table 7-37. PHY_STATUS Register Field Descriptions (continued)

| | Table 7-37.1111_01A100 Register Field Descriptions (continued) | | | | | | |
|-----|--|------|-------|---|--|--|--|
| Bit | Field | Type | Reset | Description | | | |
| 10 | LINK_STATUS_2 | R | 0h | 0h = Link is down 1h = Link is up | | | |
| 9 | MDI_X_MODE_CD_1 | R | 0h | 0h = MDI 1h = MDI-X | | | |
| 8 | MDI_X_MODE_AB_1 | R | 0h | 0h = MDI 1h = MDI-X | | | |
| 7 | SPEED_OPT_STATUS | R | Oh | 0h = Auto-Negotiation is currently being performed without Speed Optimization 1h = Auto-Negotiation is currently being performed with Speed Optimization masking 1000BaseT abilities (Valid only during Auto-Negotiation) | | | |
| 6 | SLEEP_MODE | R | 0h | 0h = Active 1h = Sleep | | | |
| 5-2 | WIRE_CROSS | R | 0h | Indicates channels [D,C,B,A] polarity in 1000BT link 0h = Channel polarity is normal 1h = Channel polarity is reversed | | | |
| 1 | DATA_POLARITY | R | 0h | 0h = 10BT is in reversed polarity 1h = 10BT is in normal polarity | | | |
| 0 | JABBER_DTCT_2 | R | 0h | 0h = No Jabber 1h = Jabber | | | |

7.6.1.17 INTERRUPT_MASK Register (Offset = 12h) [Reset = 0000h]

INTERRUPT_MASK is shown in Table 7-38.

Return to the Summary Table.

This register implements the Interrupt PHY Specific Control register. The individual interrupt events must be enabled by setting bits in the MII Interrupt Control Register (MICR). If the corresponding enable bit in the register is set, an interrupt is generated if the event occurs.

Table 7-38. INTERRUPT_MASK Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-----|-------------------------------|------|-------|---|
| 15 | AUTONEG_ERR_INT_EN | R/W | 0h | 0h = Disable interrupt 1h = Enable interrupt |
| 14 | SPEED_CHNG_INT_EN | R/W | 0h | 0h = Disable interrupt 1h = Enable interrupt |
| 13 | DUPLEX_MODE_CHNG_I NT_EN | R/W | 0h | 0h = Disable interrupt 1h = Enable interrupt |
| 12 | PAGE_RECEIVED_INT_E N | R/W | 0h | 0h = Disable interrupt 1h = Enable interrupt |
| 11 | AUTONEG_COMP_INT_E N | R/W | 0h | 0h = Disable interrupt 1h = Enable interrupt |
| 10 | LINK_STATUS_CHNG_IN T_EN | R/W | 0h | 0h = Disable interrupt 1h = Enable interrupt |
| 9 | EEE_ERR_INT_EN | R/W | 0h | 0h = Disable interrupt 1h = Enable interrupt |
| 8 | FALSE_CARRIER_INT_E N | R/W | 0h | 0h = Disable interrupt 1h = Enable interrupt |
| 7 | ADC_FIFO_OVF_UNF_IN T_EN | R/W | 0h | 0h = Disable interrupt 1h = Enable interrupt |
| 6 | MDI_CROSSOVER_CHN G_INT_EN | R/W | 0h | 0h = Disable interrupt 1h = Enable interrupt |
| 5 | SPEED_OPT_EVENT_IN T_EN | R/W | 0h | 0h = Disable interrupt 1h = Enable interrupt |

Table 7-38. INTERRUPT_MASK Register Field Descriptions (continued)

| | rabic 7 oc. interest in More register 1 icia bescriptions (continued) | | | | | | |
|-----|---|------|-------|---|--|--|--|
| Bit | Field | Туре | Reset | Description | | | |
| 4 | SLEEP_MODE_CHNG_IN T_EN | R/W | 0h | 0h = Disable interrupt 1h = Enable interrupt | | | |
| 3 | WOL_INT_EN | R/W | 0h | 0h = Disable interrupt 1h = Enable interrupt | | | |
| 2 | XGMII_ERR_INT_EN | R/W | 0h | 0h = Disable interrupt 1h = Enable interrupt | | | |
| 1 | POLARITY_CHNG_INT_E N | R/W | 0h | 0h = Disable interrupt 1h = Enable interrupt | | | |
| 0 | JABBER_INT_EN | R/W | 0h | 0h = Disable interrupt 1h = Enable interrupt | | | |

7.6.1.18 INTERRUPT_STATUS Register (Offset = 13h) [Reset = 0000h]

INTERRUPT_STATUS is shown in Table 7-39.

Return to the Summary Table.

This register contains event status for the interrupt function. If an event has occurred since the last read of this register, the corresponding status bit is to be set. The status indications in this register is to be set even if the interrupt is not enabled.

Table 7-39. INTERRUPT_STATUS Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-----|------------------------|------|-------|--|
| 15 | AUTONEG_ERR | RC | 0h | 0h = Auto-Negotiation error has not occurred THIS BIT IS LH (Latched-High) 1h = Auto-Negotiation error has occurred |
| 14 | SPEED_CHNG | RC | 0h | 0h = Link speed has not changed THIS BIT IS LH (Latched-High) 1h = Link speed has changed |
| 13 | DUPLEX_MODE_CHNG | RC | 0h | 0h = Duplex mode has not changed THIS BIT IS LH (Latched-High) 1h = Duplex mode has changed |
| 12 | PAGE_RECEIVED | RC | 0h | 0h = Page has not been received THIS BIT IS LH (Latched-High) 1h = Page has been received |
| 11 | AUTONEG_COMP | RC | 0h | 0h = Auto-Negotiation has not completed THIS BIT IS LH (Latched- High) 1h = Auto-Negotiation has completed |
| 10 | LINK_STATUS_CHNG | RC | 0h | 0h = Link status has not changed THIS BIT IS LH (Latched-High) 1h = Link status has changed |
| 9 | EEE_ERR_STATUS | R | 0h | 1h = EEE error has been detected |
| 8 | FALSE_CARRIER | RC | 0h | 0h = Disable interrupt THIS BIT IS LH (Latched-High) 1h = Enable interrupt |
| 7 | ADC_FIFO_OVF_UNF | RC | 0h | 1h = Overflow / underflow has been detected in one of ADC's FIFOs THIS BIT IS LH (Latched-High) |
| 6 | MDI_CROSSOVER_CHN G | RC | 0h | 0h = MDI crossover has not changed THIS BIT IS LH (Latched-High) 1h = MDI crossover has changed |
| 5 | SPEED_OPT_EVENT | RC | 0h | 0h = MDI crossover has not changed THIS BIT IS LH (Latched-High) 1h = MDI crossover has changed |
| 4 | SLEEP_MODE_CHNG | RC | 0h | 0h = Sleep mode has not changed THIS BIT IS LH (Latched-High) 1h = Sleep mode has changed |
| 3 | WOL_STATUS | R | 0h | 1h = WoL (or pattern) packet has been received |
| 2 | XGMII_ERR_STATUS | R | 0h | 0h = Overflow / underflow has not been detected 1h = Overflow / underflow has been detected in one of GMII / RGMII / SGMII buffers |
| 1 | POLARITY_CHNG | R | 0h | 0h = Data polarity has not changed THIS BIT IS LH (Latchde-High) 1h = Data polarity has changed |



Table 7-39. INTERRUPT_STATUS Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Description |
|-----|--------|------|-------|---|
| 0 | JABBER | RC | | 0h = Jabber not detected THIS BIT IS LH (Latched-High) 1h = Jabber detected |

7.6.1.19 GEN_CFG2 Register (Offset = 14h) [Reset = 29C7h]

GEN_CFG2 is shown in Table 7-40.

Return to the Summary Table.

Table 7-40. GEN CFG2 Register Field Descriptions

| Bit | Field | Type | Reset | Description |
|-------|-----------------------------|---------|-------|---|
| 15 | PD DETECT EN | R/WtoPH | 0h | 0h = Disable PD detection |
| 15 | PD_DETECT_EN | R/WIOPH | OH | 1h = Enable PD (Powered Device) detection |
| 14 | SGMII_TX_ERR_DIS | R/W | 0h | 0h = Enable SGMII TX Error indication 1h = Disable SGMII TX Error indication |
| 13 | INTERRUPT_POLARITY | R/W | 1h | 0h = Interrupt pin is active high 1h = Interrupt pin is active low |
| 12 | SGMII_SOFT_RESET | R/WtoPH | 0h | Setting this bit generates a soft reset pulse of SGMII. This register is WSC (write-self-clear). |
| 11-10 | SPEED_OPT_ATTEMPT_ CNT | R/W | 2h | Selects the number of 1G link establishment attempt failures prior to performing Speed Optimization: 0h = 1 attempt 1h = 2 attempts 2h = 4 attempts 3h = 8 attempts |
| 9 | SPEED_OPT_EN | R/W | 0h | 0h = Disable Speed Optimization 1h = Enable Speed Optimization |
| 8 | SPEED_OPT_ENHANCE D_EN | R/W | 1h | In enhanced mode, speed is optimized if energy is not detected in channels C and D 0h = Disable Speed Optimization enhanced mode 1h = Enable Speed Optimization enhanced mode |
| 7 | SGMII_AUTONEG_EN | R/W | 1h | 0h = Disable SGMII Auto-Negotiation 1h = Enable SGMII Auto-Negotaition |
| 6 | SPEED_OPT_10M_EN | R/W | 1h | 0h = Disable speed optimization to 10M 1h = Enable speed optimization to 10M (If link establishments of 1G and 100M fail) |
| 5-4 | MII_CLK_CFG | R/W | 0h | Selects frequency of GMII_TX_CLK in 1G mode: 0h = 2.5Mhz 1h = 25Mhz 2h = Disabled 3h = Disabled |
| 3 | COL_FD_EN | R/W | 0h | 0h = Disable COL indication in full duplex mode 1h = Enable COL indication in full duplex mode |
| 2 | LEGACY_CODING_TXM ODE_EN | R/W | 1h | 0h = Disable automatic selection of Legacy scrambler mode in 1G, Leader mode 1h = Enable automatic selection of Legacy scrambler mode in 1G, Leader mode |
| 1 | LEADER_SEMI_CROSS_ EN | R/W | 1h | 0h = Disable semi-cross mode in 1G Leader mode 1h = Enable semi-cross mode in 1G Leader mode |
| 0 | FOLLOWER_SEMI_CRO SS_EN | R/W | 1h | 0h = Disable semi-cross mode in 1G Follower mode 1h = Enable semi-cross mode in 1G Follower mode |

7.6.1.20 RX_ERR_CNT Register (Offset = 15h) [Reset = 0000h]

RX_ERR_CNT is shown in Table 7-41.

Return to the Summary Table.

Table 7-41. RX_ERR_CNT Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------------|-------|-------|-----------------------|
| 15-0 | RX_ERROR_COUNT | R/W1C | 0h | Receive Error Counter |

7.6.1.21 BIST_CONTROL Register (Offset = 16h) [Reset = 0000h]

BIST CONTROL is shown in Table 7-42.

Return to the Summary Table.

This register is used for Build-In Self Test (BIST) configuration. The BIST functionality provides Pseudo Random Bit Stream (PRBS) mechanism including packet generation generator and checker. Selection of the exact loopback point in the signal chain is also done in this register.

Table 7-42. BIST_CONTROL Register Field Descriptions

| Table 7-42. BIST_CONTROL Register Field Descriptions | | | | | | | |
|--|---------------------------|------|-------|---|--|--|--|
| Bit | Field | Туре | Reset | Description | | | |
| 15-12 | PACKET_GEN_EN_3:0 | R/W | 0h | These bits along controls PRBS generator.Other values are not applicable. 0h = Disable PRBS Fh = Enable Continuous PRBS | | | |
| 11-10 | RESERVED | R | 0h | Reserved | | | |
| 9 | RESERVED | R/W | 0h | Reserved | | | |
| 8 | RESERVED | R/W | 0h | Reserved | | | |
| 7 | REV_LOOP_RX_DATA_C TRL | R/W | 0h | Reverse Loopback Receive Data Control: This bit can only be set in Reverse Loopback mode 0h = Suppress RX packets to MAC in reverse loop 1h = Send RX packets to MAC in reverse loop | | | |
| 6 | MII_LOOP_TX_DATA_CT | R/W | 0h | MII Loopback Transmit Data Control: This bit can only be set in MII Loopback mode 0h = Suppress data to MDI in MII loop 1h = Transmit data to MDI in MII loop | | | |
| 5-2 | LOOP_TX_DATA_MIX | R/W | 0h | Loopback Mode Select: PCS loopback must be disabled (Bits[1:0] = 00) 0h = No Loopback 1h = Digital Loopback 2h = Analog Loopback 4h = External Loopback 8h = Reverse Loopback | | | |
| 1-0 | LOOPBACK_MODE | R/W | 0h | PCS loopback select – When configured in 1000Base-T, X1b: Loop before 1000Base-T signal processing when configured in 100Base-TX, 0h = See bits [5:2] 01b = Loop before scrambler 10b = Loop after scrambler, before MLT3 encoder 11b = Loop after MLT3 encoder (full TX/RX path) | | | |

7.6.1.22 GEN_STATUS2 Register (Offset = 17h) [Reset = 0040h]

GEN_STATUS2 is shown in Table 7-43.

Return to the Summary Table.

Table 7-43. GEN STATUS2 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-----|---------|------|-------|--|
| 15 | PD_PASS | RC | _ · | 0h = PD has not been detected 1h = PD (Powered Device) has been successfully detected |

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Table 7-43. GEN_STATUS2 Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Description |
|-----|--------------------------|------|-------|---|
| 14 | PD_PULSE_DET_ZERO | RC | 0h | 0h = PD detection mechanism has received signal 1h = PD detection mechanism has received no signal |
| 13 | PD_FAIL_WD | RC | 0h | 0h = PD detection mechanism watchdog has not expired 1h = PD detection mechanism watchdog has expired |
| 12 | PD_FAIL_NON_PD | RC | Oh | 0h = PD detection mechanism has not detected a non-powered device 1h = PD detection mechanism has detected a non-powered device |
| 11 | PRBS_LOCK | R | 0h | 0h = PRBS checker is not locked 1h = PRBS checker is locked sync) on received byte stream |
| 10 | PRBS_SYNC_LOSS | R | 0h | 0h = PRBS checker has not lost sync LH - clear on read register 1h = PRBS checker has lost sync |
| 9 | PKT_GEN_BUSY | R | 0h | 0h = Packet generator is not in process 1h = Packet generator is in process |
| 8 | SCR_MODE_LEADER_1 G | R | 0h | 0h = 1G PCS (leader) is in normal encoding mode 1h = 1G PCS (leader) is in legacy encoding mode |
| 7 | SCR_MODE_FOLLOWER _1G | R | 0h | 0h = 1G PCS (follower) is in normal encoding mode 1h = 1G PCS (follower) is in legacy encoding mode |
| 6 | CORE_PWR_MODE | R | 1h | 0h = Core is powered down or in sleep mode 1h = Core is in normal power mode |
| 5-0 | RESERVED | R | 0h | Reserved |

7.6.1.23 LEDS_CFG1 Register (Offset = 18h) [Reset = 6XXXh]

LEDS_CFG1 is shown in Table 7-44.

Return to the Summary Table.

Table 7-44. LEDS_CFG1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|--------------|------|-------|---|
| 15-12 | LED_GPIO_SEL | R/W | 6h | Source of GPIO LED, same as bits 3:0 |
| 11-8 | LED_2_SEL | R/W | Xh | See Strap Configuration section for defaults. Source of LED_2 (LED 2) , same as bits 3:0 |
| 7-4 | LED_1_SEL | R/W | Xh | See Strap Configuration section for defaults. Source of LED_1 (LED 1) |
| 3-0 | LED_0_SEL | R/W | Xh | See Strap Configuration section for defaults. Source of LED_0 (LED 0) 0h = link OK 1h = RX/TX activity 2h = TX activity 3h = RX activity 4h = collision detected 5h = 1000BT/1000BASE-X link is up 6h = 100 BTX/100BASE-FX link is up 7h = 10BT link is up 8h = 10/100BT link is up 9h = 100/1000BT link is up Ah = full duplex Bh = link status for copper only + blink on TX/RX activity Ch = NA Dh = RX_ER or TX_ER Eh = RX_ER |

7.6.1.24 LEDS_CFG2 Register (Offset = 19h) [Reset = 4444h]

LEDS_CFG2 is shown in Table 7-45.

Return to the Summary Table.

Table 7-45. LEDS_CFG2 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-----|-------------------|------|-------|--|
| 15 | RESERVED | R | 0h | Reserved |
| 14 | LED_GPIO_POLARITY | R/W | 1h | GPIO LED polarity: Default depends on strap, non strap default Active High 0h = Active low 1h = Active high |
| 13 | LED_GPIO_DRV_VAL | R/W | 0h | If bit 12 is set, this is the value of GPIO LED |
| 12 | LED_GPIO_DRV_EN | R/W | 0h | Force value to LED_GPIO as per bit 13 0h = LED_GPIO is in normal operation mode 1h = Force the value of LED_GPIO |
| 11 | RESERVED | R | 0h | Reserved |
| 10 | LED_2_POLARITY | R/W | 1h | LED_2 polarity. Default depends on strap, non strap default Active High 0h = Active low 1h = Active high |
| 9 | LED_2_DRV_VAL | R/W | 0h | If bit 8 is set, this is the value of LED_2 |
| 8 | LED_2_DRV_EN | R/W | 0h | Force value to LED_GPIO as per bit 9 0h = LED_2 is in normal operation mode 1h = Drive the value of LED_2 |
| 7 | RESERVED | R | 0h | Reserved |
| 6 | LED_1_POLARITY | R/W | 1h | LED_1 polarity: Default depends on strap, non strap default Active High 0h = Active low 1h = Active high |
| 5 | LED_1_DRV_VAL | R/W | 0h | If bit 4 is set, this is the value of LED_1 |
| 4 | LED_1_DRV_EN | R/W | 0h | Force value to LED_GPIO as per bit 5 0h = LED_1 is in normal operation mode 1h = Drive the value of LED_1 |
| 3 | RESERVED | R | 0h | Reserved |
| 2 | LED_0_POLARITY | R/W | 1h | LED_0 polarity: Default depends on strap, non strap default Active High 0h = Active low 1h = Active high |
| 1 | LED_0_DRV_VAL | R/W | 0h | If bit 1 is set, this is the value of LED_0 |
| 0 | LED_0_DRV_EN | R/W | 0h | Force value to LED_GPIO as per bit 1 0h = LED_0 is in normal operation mode 1h = Drive the value of LED_0 |

7.6.1.25 LEDS_CFG3 Register (Offset = 1Ah) [Reset = 0002h]

LEDS_CFG3 is shown in Table 7-46.

Return to the Summary Table.

Table 7-46. LEDS_CFG3 Register Field Descriptions

| Table 1 40. EEDO_OF CO Register 1 fold Decemptions | | | | | | |
|--|----------------------------|------|-------|--|--|--|
| Bit | Field | Туре | Reset | Description | | |
| 15-3 | RESERVED | R | 0h | Reserved | | |
| 2 | LEDS_BYPASS_STRETC HING | R/W | 0h | 0b = Noraml Operation 1b = Bypass LEDs stretching | | |
| 1-0 | LEDS_BLINK_RATE | R/W | 2h | 00b = 20Hz (50mSec) 01b = 10Hz (100mSec) 10b = 5Hz (200mSec) 11b = 2Hz (500mSec) | | |

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7.6.1.26 GEN_CFG4 Register (Offset = 1Eh) [Reset = 0012h]

GEN_CFG4 is shown in Table 7-47.

Return to the Summary Table.

Table 7-47. GEN_CFG4 Register Field Descriptions

| Bit | Field | Description | | |
|-------|----------------------------|-------------|-------|--|
| Bit | 1 1010 | Туре | Reset | · |
| 15 | RESERVED | R/W | 0h | Reserved |
| 14 | CFG_FAST_ANEG_EN | R/W | 0h | Enable Fast ANEG mode |
| 13-12 | CFG_FAST_ANEG_SEL_ VAL | R/W | 0h | When Fast ANEG mode enabled, this value selects short timer duration 0x0 is the shortest timers config and 0x2 the longest |
| 11 | CFG_ANEG_ADV_FD_E N | R/W | Oh | this but enables to declare FD also in parallel detect link, the IEEE defien on parallel detect to always declare HD, this bit allows also to declare FD in this scenario |
| 10 | RESTART_STATUS_BITS _EN | R/W | Oh | reset enable 0h = do not clear the status bit 1h = clear all the phy status bits (part of register 0x11) |
| 9 | CFG_ROBUST_AMDIX_E | R/W | 0h | Enable Robust Auto MDI/MDIX resolution |
| 8 | CFG_FAST_AMDIX_EN | R/W | 0h | Enabe Fast Auto MDI-X mode |
| 7 | INT_OE | R/W | Oh | Interrupt Output Enable: 0h = INTN/PWDNN Pad in an Power Down Input 1h = INTN/PWDNN Pad is an Interrupt Output |
| 6 | FORCE_INTERRUPT | R/W | 0h | 0h = Normal interrupt mode 1h = Assert interrupt pin |
| 5 | RESERVED | R/W | 0h | Reserved |
| 4 | RESERVED | R/W | 0h | Reserved |
| 3 | FORCE_1G_AUTONEG_ EN | R/W | Oh | 0h = Do not invoke Auto-Negotiation when manual speed in register 0x0000 is 1G 1h = Invoke Auto-Negotiation with only 1G advertised when manual speed in register 0x0000 is 1G |
| 2 | TDR_FAIL | R | 0h | |
| 1 | TDR_DONE | R | 1h | |
| 0 | TDR_START | R/WtoPH | 0h | 0h = TDR Completed 1h = Start TDR |

7.6.1.27 GEN_CTRL Register (Offset = 1Fh) [Reset = 0000h]

GEN_CTRL is shown in Table 7-48.

Return to the Summary Table.

Table 7-48. GEN_CTRL Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|------------|---------|-------|---|
| 15 | SW_RESET | R/WtoPH | 0h | Software Reset - This resets the PHY and return registers to the PHY's default values. Registers controlled via strap pins return back to the PHY's last strapped values. 0h = Normal mode 1h = Reset PHY |
| 14 | SW_RESTART | R/WtoPH | 0h | Soft Restart Restarts the PHY without affecting registers. 0h = Normal Operation 1h = Software Reset |
| 13 | RESERVED | R/W | 0h | Reserved |
| 12-7 | RESERVED | R/W | 0h | Reserved |

Table 7-48. GEN_CTRL Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Description |
|-----|----------|------|-------|-------------|
| 6-0 | RESERVED | R/W | 0h | Reserved |

7.6.1.28 ANALOG_TEST_CTRL Register (Offset = 25h) [Reset = 0480h]

ANALOG_TEST_CTRL is shown in Table 7-49.

Return to the Summary Table.

Table 7-49. ANALOG_TEST_CTRL Register Field Descriptions

| | | . ANALUG | _1E31_C1 | RL Register Field Descriptions |
|-------|-------------------------|----------|----------|--|
| Bit | Field | Туре | Reset | Description |
| 15-12 | RESERVED | R | 0h | Reserved |
| 11-10 | TM7_PULSE_SEL | R/W | 1h | Selects pulse amplitude and polarity for Test Mode 7 (See register 0x9): 0h = +2 1h = -2 2h = +1 3h = -1 |
| 9 | EXTND_TM7_100BT_MS B | R/W | Oh | MSB of configurable length for 100BT extended TM7 For 100BT Test Mode: repetitive sequence of "1" with configurable number of "0". Bits { 9,[3:0] } define the number of "0" to follow the "1", from 1 to 31. 0,0001 - 1,1111 : single "0" to 31 zeros. 0,0000 - clear the shiftreg. |
| 8 | EXTND_TM7_100BT_EN | R/W | 0h | Enable extended TM7 for 100M. NOTE1: bit 4 must be "0" for 100BT TestMode. NOTE2: 100BT testmode must be Clear before appling new Value. e.g, one need to write 0x0 before configuring new value. NOTE3: use FORCE100 for 100BT testing, via Reg0x0. |
| 7-5 | STIM_CH_SEL | R/W | 4h | Selects the channel or channels that outputs the test mode: If bit 7 is set, test mode is driven to all channels. If bit 7 is cleared, test mode is driven according to bits 6:5 - 00b = Channel A 01b = Channel B 10b = Channel C 11b = Channel D |
| 4-0 | ANALOG_TEST | R/W | Oh | Bit [4] enables 10BaseT test modes Bits [3:0] select the 10BaseT test pattern, as follows:. To operate extended TM7 for 100BT, bits 3:0 shall be configured as well - more details in bit 9 0000b = Single NLP 0001b = Single Pulse 1 0010b = Single Pulse 0 0011b = Repetitive 1 0100b = Repetitive 0 0101b = Preamble (repetitive "10") 0110b = Single 1 followed by TP_IDLE 0111b = Single 0 followed by TP_IDLE 1000b = Repetitive "1001" sequence 1001b = Random 10Base-T data 1010b = TP_IDLE_00 1011b = TP_IDLE_01 1100b = TP_IDLE_10 1101b = TP_IDLE_11 0110b = TP_IDLE_11 |

7.6.1.29 GEN_CFG_ENH_AMIX Register (Offset = 2Ch) [Reset = 141Fh]

GEN_CFG_ENH_AMIX is shown in Table 7-50.

Return to the Summary Table.

Table 7-50. GEN_CFG_ENH_AMIX Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|-------------------|------|-------|---|
| 15-14 | RESERVED | R | 0h | Reserved |
| 13-9 | CFG_FLD_WINDW_CNT | R/W | Ah | Counter to define the window in which we look for fast link down criteria, default 10usec |



Table 7-50. GEN_CFG_ENH_AMIX Register Field Descriptions (continued)

| | 3 | | | | | | |
|-----|--------------------------|------|-------|---|--|--|--|
| Bit | Field | Туре | Reset | Description | | | |
| 8-4 | CFG_FAST_AMDIX_VAL | R/W | 1h | Timer of the MDI/MDI-X switch cuonterin force 100m fast amdix mode, very fast as the PHY need only to allow far end to detect energy 4ms in default | | | |
| 3-0 | CFG_ROBUST_AMDIX_V AL | R/W | Fh | The value of the timer that switch MDI/X in robust mode, this is a long timer to allow far end to still do parallel detect witht he IEEE ANEG timers Default 0.5s | | | |

7.6.1.30 GEN_CFG_FLD Register (Offset = 2Dh) [Reset = 0000h]

GEN_CFG_FLD is shown in Table 7-51.

Return to the Summary Table.

Table 7-51. GEN CFG FLD Register Field Descriptions

| | 140.0 | · • · · · • - · · - | · · · · - · - · · · · · | register ricia Descriptions |
|------|-------------------------------|---------------------|-------------------------|--|
| Bit | Field | Туре | Reset | Description |
| 15 | CFG_FORCE_DROP_LIN K_EN | R/W | 0h | Drop link (stop transmitting) when no signal is received |
| 14 | FLD_BYPASS_MAX_WAI T_TIMER | R/W | 0h | If set, MAX_WAIT_TIMER is skipped (and therefore link is dropped faster) |
| 13 | SLICER_OUT_STUCK | R | 0h | indicate slicer)out_stuck status |
| 12-8 | FLD_STATUS | R | 0h | Fast link down status LH - clear on read register |
| 7-5 | RESERVED | R | 0h | Reserved |
| 4-0 | CFG_FAST_LINK_DOWN _MODES | R/W | 0h | 5 bits for different fast link down option (can all work simultaniously): bit [0] - energy lost bit [1] - mse bit [2] - mlt3 errors bit [3] - rx_err bit [4] - descrambler sync loss |

7.6.1.31 GEN_CFG_FLD_THR Register (Offset = 2Eh) [Reset = 0221h]

GEN_CFG_FLD_THR is shown in Table 7-52.

Return to the Summary Table.

Table 7-52. GEN_CFG_FLD_THR Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|-------------------------|------|-------|---|
| 15-11 | RESERVED | R | 0h | Reserved |
| 10-8 | ENERGY_WINDOW_LEN_FLD | R/W | 2h | Window length in FLD energy lost mode for energy detection accumulator |
| 7 | RESERVED | R | 0h | Reserved |
| 6-4 | ENERGY_ON_FLD_THR | R/W | 2h | energy lost threshold for FLD energy lost mode. energy_detected indication is asserted when energy detector accumulator exceeds this threshold. |
| 3 | RESERVED | R | 0h | Reserved |
| 2-0 | ENERGY_LOST_FLD_TH R | R/W | 1h | energy lost threshold for FLD energy lost mode energy_lost indication is asserted if energy detector accumulator falls below this threshold. |

7.6.1.32 GEN_CFG3 Register (Offset = 31h) [Reset = 10B0h]

GEN_CFG3 is shown in Table 7-53.



Return to the Summary Table.

Table 7-53. GEN_CFG3 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-------------------------|------|-------|--|
| 15 | RESERVED | R | 0h | Reserved |
| 14 | RESERVED | R/W | 0h | Reserved |
| 13 | RESERVED | R/W | 0h | Reserved |
| 12 | RESERVED | R/W | 0h | Reserved |
| 11-9 | RESERVED | R | 0h | Reserved |
| 8 | RESERVED | R/W | 0h | Reserved |
| 7 | RESERVED | R/W | 0h | Reserved |
| 6-5 | SGMII_AUTONEG_TIME R | R/W | 1h | Selects duration of SGMII Auto-Negotiation timer: 0h = 1.6ms 1h = 2µs 2h = 800µs 3h = 11ms |
| 4 | RESERVED | R/W | 0h | Reserved |
| 3 | RESERVED | R/W | 0h | Reserved |
| 2 | RESERVED | R/W | 0h | Reserved |
| 1 | RESERVED | R | 0h | Reserved |
| 0 | PORT_MIRRORING_MO DE | R/W | 0h | Port mirroring mode: 0h = Disabled |

7.6.1.33 RGMII_CTRL Register (Offset = 32h) [Reset = 00D0h]

RGMII_CTRL is shown in Table 7-54.

Return to the Summary Table.

Table 7-54. RGMII_CTRL Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-----|----------------------------|------|-------|--|
| 15 | RESERVED | R | 0h | Reserved |
| 14 | RESERVED | R | 0h | Reserved |
| 13 | RESERVED | R | 0h | Reserved |
| 12 | RESERVED | R | 0h | Reserved |
| 11 | RESERVED | R/W | 0h | Reserved |
| 10 | RESERVED | R | 0h | Reserved |
| 9 | RESERVED | R/W | 0h | Reserved |
| 8 | RESERVED | R/W | 0h | Reserved |
| 7 | RESERVED | R/W | 0h | Reserved |
| 6-5 | RGMII_RX_HALF_FULL_ THR | R/W | 2h | RGMII RX sync FIFO Half-full Threshold Bits 1:0 of the 3-bit threshold field. Bit2 can be found in Reg 0x33[1]. The default setting 2 starts a FIFO read when the difference between the write and read pointer is 4. The TX/RX FIFOs have a depth of 8. Increasing the threshold from 2 to 3 increases the latency by 1 read cycle; while decreasing the threshold from 2 to 1 decreases latency by 1 read cycle. If the difference between ppm of the read and write clocks is significant, a half-full threshold can cause either FIFO underflow or overflow. |
| 4-3 | RGMII_TX_HALF_FULL_ THR | R/W | 2h | RGMII TX sync FIFO Half-full Thresholds Bits 1:0 of the 3-bit threshold field. Bit2 can be found in Reg 0x33[0] See RGMII_RX_HALF_FULL_THR for more details. |
| 2 | SUPPRESS_TX_ERR_EN | R/W | 0h | |



Table 7-54. RGMII_CTRL Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Description |
|-----|--------------------|------|-------|--|
| 1 | RGMII_TX_CLK_DELAY | R/W | | RGMII Transmit Clock Delay 0h = RGMII transmit clock is shifted with respect to transmit data. 1h = RGMII transmit clock is aligned with respect to transmit data. |
| 0 | RGMII_RX_CLK_DELAY | R/W | Oh | RGMII Receive Clock Delay 0h = RGMII receive clock is shifted with respect to receive data. 1h = RGMII transmit clock is aligned with respect to receive data. |

7.6.1.34 RGMII_CTRL2 Register (Offset = 33h) [Reset = 0000h]

RGMII_CTRL2 is shown in Table 7-55.

Return to the Summary Table.

Table 7-55. RGMII_CTRL2 Register Field Descriptions

| | | | togister i leia besoriptions | |
|------|--------------------------------|------|------------------------------|---|
| Bit | Field | Туре | Reset | Description |
| 15-5 | RESERVED | R | 0h | Reserved |
| 4 | RGMII_AF_BYPASS_EN | R/W | 0h | RGMII Async FIFO Bypass Enable: 0h = Normal operation. 1h = Enable RGMII Async FIFO Bypass. |
| 3 | RGMII_AF_BYPASS_DLY _EN | R/W | 0h | RGMII Async FIFO Bypass Delay Enable: 0h = Normal operation 1h = Delay RX_CLK when operating in 10/100 with RGMII. |
| 2 | LOW_LATENCY_10_100_ EN | R/W | 0h | Low Latency 10/100 Enable: 0h = Normal operation. 1h = Enable low latency in 10/100 operation. |
| 1 | RGMII_RX_HALF_FULL_ THR_MSB | R/W | 0h | RGMII RX sync FIFO Half-full Threshold Bit2 of the 3-bit threshold field. Bits 1:0 can be found in Reg 0x32[6:5], respectively. |
| 0 | RGMII_TX_HALF_FULL_ THR_MSB | R/W | 0h | RGMII TX sync FIFO Half-full Threshold Bit2 of the 3-bit threshold field. Bits 1:0 can be found in Reg 0x32[4:3], respectively. |

7.6.1.35 SGMII_AUTO_NEG_STATUS Register (Offset = 37h) [Reset = 0000h]

SGMII_AUTO_NEG_STATUS is shown in Table 7-56.

Return to the Summary Table.

Table 7-56. SGMII_AUTO_NEG_STATUS Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------------------------|------|-------|--|
| 15-2 | RESERVED | R | 0h | Reserved |
| 1 | SGMII_PAGE_RX | R | 0h | 1b = indicate that a new auto-neg page is received |
| 0 | SGMII_AUTONEG_COMP LETE | R | | 0h = Auto-Negotiation process not completed 1h = Auto-Negotiation process completed |

7.6.1.36 PRBS_TX_CHK_CTRL Register (Offset = 39h) [Reset = 0000h]

PRBS_TX_CHK_CTRL is shown in Table 7-57.

Return to the Summary Table.

Table 7-57. PRBS_TX_CHK_CTRL Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-----|----------|------|-------|-------------|
| 15 | RESERVED | R | 0h | Reserved |

Table 7-57. PRBS_TX_CHK_CTRL Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Description |
|------|------------------------------|------|-------|--|
| 14-7 | PRBS_TX_CHK_ERR_CN T | R | 0h | Holds number of errored bytes that received by the PRBS TX checker. When TX PRBS Count Mode (see bit [1]) set to 0, count stops on 0xFF. Notes: Writing bit 7 generates a lock signal for the PRBS TX counters. Writing bit 8 generates a lock and clear signal for the PRBS TX counters |
| 6 | RESERVED | R | 0h | Reserved |
| 5 | PRBS_TX_CHK_SYNC_L OSS | R | 0h | 0h = PRBS TX checker has not lost sync This bit is LH 1h = PRBS TX checker has lost sync |
| 4 | PRBS_TX_CHK_LOCK_S TS | R | 0h | 0h = PRBS TX checker is not locked 1h = PRBS TX checker is locked on received byte stream |
| 3 | RESERVED | R | 0h | Reserved |
| 2 | PRBS_TX_CHK_BYTE_C NT_OVF | R | 0h | If set, bytes counter reached overflow |
| 1 | PRBS_TX_CHK_CNT_M ODE | R/W | 0h | PRBS Checker Mode 0h = Single Mode. 1h = Continuous mode |
| 0 | PRBS_TX_CHK_EN | R/W | 0h | If set, PRBS TX checker is enabled (PRBS TX checker is used in external reverse loop) |

7.6.1.37 PRBS_TX_CHK_BYTE_CNT Register (Offset = 3Ah) [Reset = 0000h]

PRBS_TX_CHK_BYTE_CNT is shown in Table 7-58.

Return to the Summary Table.

Table 7-58. PRBS_TX_CHK_BYTE_CNT Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|--------------------------|------|-------|---|
| 15-0 | PRBS_TX_CHK_BYTE_C NT | R | | Holds number of total bytes that received by the PRBS TX checker. Value in this register is locked when write is done to register PRBS_TX_CHK_CTRL bit[7]or bit[8]. When PRBS Count Mode set to zero, count stops on 0xFFFF (see register 0x0016) |

7.6.1.38 G_100BT_REG0 Register (Offset = 43h) [Reset = 07A0h]

G_100BT_REG0 is shown in Table 7-59.

Table 7-59. G_100BT_REG0 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|----------|------|-------|-------------|
| 15-12 | RESERVED | R | 0h | Reserved |
| 11 | RESERVED | R/W | 0h | Reserved |
| 10-7 | RESERVED | R/W | 0h | Reserved |
| 6 | RESERVED | R/W | 0h | Reserved |
| 5 | RESERVED | R/W | 0h | Reserved |
| 4 | RESERVED | R/W | 0h | Reserved |
| 3 | RESERVED | R/W | 0h | Reserved |
| 2 | RESERVED | R/W | 0h | Reserved |
| 1 | RESERVED | R/W | 0h | Reserved |



Table 7-59. G_100BT_REG0 Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Description |
|-----|------------|------|-------|---|
| 0 | FAST_RX_DV | R/W | | Enable Fast RX_DV for low latency in 100Mbps mode. 0h = Fast rx dv disable 1h = Fast rx dv enable |

7.6.1.39 SERDES_SYNC_STS Register (Offset = 4Fh) [Reset = 0000h]

SERDES_SYNC_STS is shown in Table 7-60.

Return to the Summary Table.

Table 7-60. SERDES_SYNC_STS Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|-------------|------|-------|---|
| 15-12 | RESERVED | R/W | 0h | Reserved |
| 11 | RESERVED | R/W | 0h | Reserved |
| 10 | RESERVED | R | 0h | Reserved |
| 9 | RESERVED | R | 0h | Reserved |
| 8 | SYNC_STATUS | R | 0h | Synchronization Status 0h = No Sync 1h = Sync Established |
| 7-4 | RESERVED | R | 0h | Reserved |
| 3-0 | RESERVED | R | 0h | Reserved |

7.6.1.40 G_1000BT_PMA_STATUS Register (Offset = 55h) [Reset = 0000h]

G_1000BT_PMA_STATUS is shown in Table 7-61.

Return to the Summary Table.

Table 7-61. G_1000BT_PMA_STATUS Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------------------------|------|-------|--|
| 15-8 | RESERVED | R | 0h | Reserved |
| 7-4 | PMA_LEADER_FIFO_CT RL | R | 0h | 1000-Mb SFD Variation in Leader Mode |
| 3-0 | PMA_FOLLOWER_FIFO_ CTRL | R | 0h | 1000-Mb SFD Variation in Follower Mode |

7.6.1.41 STRAP_STS Register (Offset = 6Eh) [Reset = 0000h]

STRAP_STS is shown in Table 7-62.

Return to the Summary Table.

Table 7-62. STRAP_STS Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|-------------------------------|------|-------|---|
| 15-14 | RESERVED | R | 0h | Reserved |
| 13 | STRAP_LINK_LOSS_PAS S_THRU | R | 0h | Link Loss Pass Through Enable Strap 0h = Enable 1h = Disable |
| 12 | STRAP_MIRROR_EN | R | 0h | Mirror Mode Enable StraP. Refer to strap configuration section as this strap also decides MAC interface in Bridge Mode applications. 0h = Disable 1h = Enable |

Table 7-62. STRAP_STS Register Field Descriptions (continued)

| | Table 7-02. OTICAL _516 Register Field Descriptions (continued) | | | | | | |
|------|---|------|-------|---|--|--|--|
| Bit | Field | Туре | Reset | Description | | | |
| 11-9 | STRAP_OPMODE | R | Oh | OPMODE Strap 0h = RGMII To Copper 1h = RGMII to 1000Base-X 2h = RGMII to 100Base-FX 3h = RGMII-SGMII Bridge 4h = 1000Base-T to 1000Base-X 5h = 100Base-T to 100Base-FX 6h = SGMII to Copper 7h = JTAG for Boundary Scan | | | |
| 8-4 | STRAP_PHY_ADD | R | 0h | PHY Address Strap | | | |
| 3-2 | STRAP_ANEGSEL | R | 0h | Auto Negotiation Mode Select Strap. Refer to Strap Configuration Section | | | |
| 1 | STRAP_ANEG_EN | R | 0h | Auto Negotiation Enable Strap 0h = Enable 1h = Disable | | | |
| 0 | RESERVED | R | 0h | Reserved | | | |

7.6.1.42 DBG_PRBS_BYTE_CNT Register (Offset = 71h) [Reset = 0000h]

DBG_PRBS_BYTE_CNT is shown in Table 7-63.

Return to the Summary Table.

Table 7-63. DBG_PRBS_BYTE_CNT Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------|------|-------|--|
| 15-0 | PRBS_BYTE_CNT | R | 0h | Holds number of total bytes that received by the PRBS checker. Value in this register is locked when write is done to register DBG_PRBS_ERR_CNT bit[0] or bit[1]. When PRBS Count Mode set to zero, count stops on 0xFFFF (see register 0x0016) |

7.6.1.43 DBG_PRBS_ERR_CNT Register (Offset = 72h) [Reset = 0000h]

DBG_PRBS_ERR_CNT is shown in Table 7-64.

Return to the Summary Table.

Table 7-64. DBG PRBS ERR CNT Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|-------------------|------|-------|---|
| 15-11 | RESERVED | R | 0h | Reserved |
| 10 | PRBS_PKT_CNT_OVF | R | Oh | If set, packet counter reached overflow Overflow is cleared when PRBS counters are cleared - done by setting bit 1 of this register |
| 9 | PRBS_BYTE_CNT_OVF | R | Oh | If set, bytes counter reached overflow Overflow is cleared when PRBS counters are cleared - done by setting bit 1 of this register |
| 8 | RESERVED | R | 0h | Reserved |
| 7-0 | PRBS_ERR_CNT | R | 0h | Holds number of errored bytes that received by the PRBS checker. Value in this register is locked when write is done to bit[0] or bit[1] (see bellow). When PRBS Count Mode set to zero, count stops on 0xFF (see register 0x0016) Notes: Writing bit 0 generates a lock signal for the PRBS counters. Writing bit 1 generates a lock and clear signal for the PRBS counters |



7.6.1.44 DBG_PKT_LEN_PRBS Register (Offset = 7Bh) [Reset = 05DCh]

DBG_PKT_LEN_PRBS is shown in Table 7-65.

Return to the Summary Table.

Table 7-65. DBG_PKT_LEN_PRBS Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|--------------|------|-------|---|
| 15-0 | PKT_LEN_PRBS | R/W | 5DCh | Length (in bytes) of PRBS packets, this effect the PRBS packets and not |

7.6.1.45 DBG_IPG_LEN Register (Offset = 7Ch) [Reset = 007Dh]

DBG_IPG_LEN is shown in Table 7-66.

Return to the Summary Table.

Table 7-66. DBG_IPG_LEN Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------|------|-------|--|
| 15-8 | RESERVED | R | 0h | Reserved |
| 7-0 | IPG_LEN | R/W | | Inter-packet gap (in 4 bytes) between PRBS packets. IPG increments in steps of 4 bytes |

7.6.1.46 ANA_RGMII_DLL_CTRL Register (Offset = 86h) [Reset = 0077h]

ANA_RGMII_DLL_CTRL is shown in Table 7-67.

Return to the Summary Table.

Table 7-67. ANA_RGMII_DLL_CTRL Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|--------------------------|------|-------|---|
| 15-10 | RESERVED | R | 0h | Reserved |
| 9 | DLL_EN_FORCE_VAL | R/W | 0h | If dll_en_force_en is set, this is the value of DLL_EN |
| 8 | DLL_EN_FORCE_CTRL | R/W | 0h | Force DLL_EN value |
| 7-4 | DLL_TX_DELAY_CTRL_S L | R/W | 7h | Steps of 250ps, affects the CLK_90 output same behavior as bit [3:0] |
| 3-0 | DLL_RX_DELAY_CTRL_ SL | R/W | 7h | Steps of 250ps, affects the CLK_90 output. b[3], b[2], b[1], b[0] if the RGMII shift mode is enabled. |
| | | | | Delay is measured from data to clock. Please note actual delay is also affected by the shift mode in register 32h. 0h = 0.25ns 1h = 0.5ns 2h = 0.75ns 3h = 1.0ns 4h = 1.25ns 5h = 1.5ns 6h = 1.75ns 7h = 2.0ns - default 8h = 2.25ns 9h = 2.5ns Ah = 2.75ns Bh = 3.0ns Ch = 3.25ns Dh = 3.5ns Eh = 3.75ns Fh = 0ns |

7.6.1.47 ANA_LD_TXG_FINE_GAINSEL_AB Register (Offset = A0h) [Reset = 0808h]

ANA_LD_TXG_FINE_GAINSEL_AB is shown in Table 7-68.

Return to the Summary Table.

Table 7-68. ANA_LD_TXG_FINE_GAINSEL_AB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------------|------|-------|---|
| ы | rieiu | Type | Keset | Description |
| 15 | UNFORCE_TEST_MODE _TM4 | R/W | 0h | The TXG gainsel Coarse over writing while the chip is in test mode 4 When unforce_test_mode_tm4 is set to '1' the over writing is disable |
| 14 | UNFORCE_TEST_MODE _TM1 | R/W | 0h | The TXG fine gainsel over writing by a plus 1 value while the chip is in test mode 1 When unforce_test_mode_tm1 is set to '1' the over writing is disable |
| 13 | RESERVED | R | 0h | Reserved |
| 12-8 | TXG_GAINSEL_FINE_B | R/W | 8h | Gain control channal B. For details, see bits [4:0] |
| 7-5 | RESERVED | R | 0h | Reserved |
| 4-0 | TXG_GAINSEL_FINE_A | R/W | 8h | Gain control channal A. Default value is set by trim. Bit 4 is not used in the design - this bit is retained for future extension of range. 0h = -16% change in gain 1h = -14% change in gain 8h = No change in gain 9h = +2% change in gain Fh = +14% change in gain |

7.6.1.48 ANA_LD_TXG_FINE_GAINSEL_CD Register (Offset = A1h) [Reset = 0808h]

ANA_LD_TXG_FINE_GAINSEL_CD is shown in Table 7-69.

Return to the Summary Table.

Table 7-69. ANA_LD_TXG_FINE_GAINSEL_CD Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|--------------------|------|-------|---|
| 15-13 | RESERVED | R | 0h | Reserved |
| 12-8 | TXG_GAINSEL_FINE_D | R/W | 8h | Gain control channal D. For details, see bits [4:0] of ANA_LD_TXG_FINE_GAINSEL_AB |
| 7-5 | RESERVED | R | 0h | Reserved |
| 4-0 | TXG_GAINSEL_FINE_C | R/W | 8h | Gain control channal C. For details, see bits [4:0] of ANA_LD_TXG_FINE_GAINSEL_AB |

7.6.1.49 ANA_LD_FILTER_TUNE_AB Register (Offset = A2h) [Reset = 1010h]

ANA_LD_FILTER_TUNE_AB is shown in Table 7-70.

Table 7-70. ANA_LD_FILTER_TUNE_AB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|---------------------------------|------|-------|--|
| 15-14 | RESERVED | R | 0h | Reserved |
| 13 | LD_FILTER_TUNE_B_FO RCE_CTRL | R/W | 0h | Force register value of ld_filter_tune_b |
| 12-8 | LD_FILTER_TUNE_B | R/W | 10h | LD interpolation LPF affect of channel B when Id_filter_tune_b_force_ctrl is set |
| 7-6 | RESERVED | R | 0h | Reserved |
| 5 | LD_FILTER_TUNE_A_FO RCE_CTRL | R/W | 0h | Force register value of ld_filter_tune_a |



Table 7-70. ANA_LD_FILTER_TUNE_AB Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Description |
|-----|------------------|------|-------|--|
| 4-0 | LD_FILTER_TUNE_A | R/W | · · | LD interpolation LPF affect of channel A when Id_filter_tune_a_force_ctrl is sel |

7.6.1.50 ANA_LD_FILTER_TUNE_CD Register (Offset = A3h) [Reset = 1010h]

ANA_LD_FILTER_TUNE_CD is shown in Table 7-71.

Return to the Summary Table.

Table 7-71. ANA_LD_FILTER_TUNE_CD Register Field Descriptions

| Bit | Field | Туре | Reset | Description | | |
|-------|---------------------------------|------|-------|--|--|--|
| 15-14 | RESERVED | R | 0h | Reserved | | |
| 13 | LD_FILTER_TUNE_D_FO RCE_CTRL | R/W | 0h | Force register value of ld_filter_tune_d | | |
| 12-8 | LD_FILTER_TUNE_D | R/W | 10h | LD interpolation LPF affect of channel D when Id_filter_tune_d_force_ctrl is set | | |
| 7-6 | RESERVED | R | 0h | Reserved | | |
| 5 | LD_FILTER_TUNE_C_FO RCE_CTRL | R/W | 0h | Force register value of ld_filter_tune_c | | |
| 4-0 | LD_FILTER_TUNE_C | R/W | 10h | LD interpolation LPF affect of channel C when Id_filter_tune_c_force_ctrl is sel | | |

7.6.1.51 ANA_PLL_PROG_PI Register (Offset = C6h) [Reset = 0000h]

ANA_PLL_PROG_PI is shown in Table 7-72.

Return to the Summary Table.

Table 7-72. ANA_PLL_PROG_PI Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------|------|-------|-------------|
| 15-0 | RESERVED | R/W | 0h | Reserved |

7.6.1.52 SGMII_TESTMODE Register (Offset = D6h) [Reset = 0000h]

SGMII_TESTMODE is shown in Table 7-73.

Return to the Summary Table.

Table 7-73. SGMII_TESTMODE Register Field Descriptions

| rable 7 70. Comm_1201 mobile 1000 boomptions | | | | | |
|--|---------------------|------|-------|--|--|
| Bit | Field | Туре | Reset | Description | |
| 15 | RESERVED | R/W | 0h | Reserved | |
| 14-13 | SGMII_VOLTAGE_SWING | R/W | 0h | Voltage Swing Pk-Pk Typ (V) 0h = 1.100 (default) 1h = 1.280 2h = 0.920 3h = Do not use | |
| 12-0 | RESERVED | R/W | 0h | Reserved | |

7.6.1.53 DSP_HYBRID_CFG2 Register (Offset = E9h) [Reset = 9F22h]

DSP_HYBRID_CFG2 is shown in Table 7-74.

Table 7-74. DSP_HYBRID_CFG2 Register Field Descriptions

| | Table 1 741 Det _111 Bittb_et GE Régister 1 lois Décemptions | | | | | | | |
|------|--|------|-------|-------------|--|--|--|--|
| Bit | Field | Туре | Reset | Description | | | | |
| 15 | RESERVED | R/W | 0h | Reserved | | | | |
| 14 | RESERVED | R/W | 0h | Reserved | | | | |
| 13 | RESERVED | R/W | 0h | | | | | |
| 12-8 | RESERVED | R/W | 0h | Reserved | | | | |
| 7-5 | RESERVED | R/W | 0h | Reserved | | | | |
| 4-0 | RESERVED | R/W | 0h | Reserved | | | | |

7.6.1.54 LOOPCR Register (Offset = FEh) [Reset = E720h]

LOOPCR is shown in Table 7-75.

Return to the Summary Table.

Table 7-75. LOOPCR Register Field Descriptions

| | i and the second | | | | | | | |
|-------|--|------|-------|---|--|--|--|--|
| Bit | Field | Туре | Reset | Description | | | | |
| 15-13 | FB_AEQ_CNT | R/W | 7h | AEQ max number of fallbacks | | | | |
| 12-8 | AEQ_MAX_STEP | R/W | 7h | the max step in aeq table | | | | |
| 7-5 | AEQ_STEP_SIZE | R/W | 1h | increment step for aeq table | | | | |
| 4-1 | RESERVED | R | 0h | | | | | |
| 0 | AEQ_BEG | R/W | Oh | starting index for aeq table 0h = normal operation 1h = near-end loopback | | | | |

7.6.1.55 RXF_CFG Register (Offset = 134h) [Reset = 1000h]

RXF_CFG is shown in Table 7-76.

Return to the Summary Table.

Table 7-76. RXF_CFG Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|--------------------------|--------|-------|--|
| 15-14 | RESERVED | R/W | 0h | Reserved |
| 13 | RESERVED | R/W | 0h | Reserved |
| 12 | RESERVED | R/W | 0h | Reserved |
| 11 | WOL_OUT_CLEAN | RH/WoP | 0h | If WOL out is in level mode in bit 8, writing to this bit clears WOL out. |
| 10-9 | WOL_OUT_STRETCH | R/W | Oh | If WOL out is in pulse mode in bit 8, this is the pulse length: 0h = 8 clock cycles 1h = 16 clock cycles 2h = 32 clock cycles 3h = 64 clock cycles |
| 8 | WOL_OUT_MODE | R/W | 0h | Mode of the wake up that goes to GPIO pin: 0h = Pulse Mode. 1h = Level Mode |
| 7 | ENHANCED_MAC_SUPP ORT | R/W | 0h | Enables enhanced RX features. This bit can be set when using wakeup abilities, CRC check or RX 1588 indication |
| 6 | RESERVED | R/W | 0h | Reserved |
| 5 | RESERVED | R/W | 0h | Reserved |
| 4 | WAKE_ON_UCAST | R/W | 0h | If set, issue an interrupt upon reception of unicast packets |
| 3 | RESERVED | R/W | 0h | Reserved |
| 2 | WAKE_ON_BCAST | R/W | 0h | If set, issue an interrupt upon reception of broadcast packets |



Table 7-76. RXF_CFG Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Description |
|-----|-----------------|------|-------|---|
| 1 | WAKE_ON_PATTERN | R/W | 0h | If set, issue an interrupt upon reception of a packet with configured pattern |
| 0 | WAKE_ON_MAGIC | R/W | 0h | If set, issue an interrupt upon reception of magic packet |

7.6.1.56 RXF_STATUS Register (Offset = 135h) [Reset = 0000h]

RXF STATUS is shown in Table 7-77.

Return to the Summary Table.

Table 7-77. RXF_STATUS Register Field Descriptions

| | | | | 10g.000. 1 1010. 2 000. p.10110 |
|------|--------------|------|-------|---------------------------------|
| Bit | Field | Туре | Reset | Description |
| 15-8 | RESERVED | R | 0h | Reserved |
| 7 | SFD_ERR | RC | 0h | SFD Error Detected |
| 6 | BAD_CRC | RC | 0h | Bad CRC Packet Received |
| 5 | RESERVED | RC | 0h | Reserved |
| 4 | UCAST_RCVD | RC | 0h | Unicast Packet Received |
| 3 | RESERVED | RC | 0h | Reserved |
| 2 | BCAST_RCVD | RC | 0h | Broadcast Packet Received |
| 1 | PATTERN_RCVD | RC | 0h | Pattern Match Packet Received |
| 0 | MAGIC_RCVD | RC | 0h | Magic Packet Received |
| | | | | |

7.6.1.57 RXF_PMATCH_DATA1 Register (Offset = 136h) [Reset = 0000h]

RXF_PMATCH_DATA1 is shown in Table 7-78.

Return to the Summary Table.

Table 7-78. RXF_PMATCH_DATA1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|------------------|------|-------|---|
| 15-0 | PMATCH_DATA_15_0 | R/W | 0h | Bits 15:0 of Perfect Match Data - used for DA (destination address) match |

7.6.1.58 RXF_PMATCH_DATA2 Register (Offset = 137h) [Reset = 0000h]

RXF_PMATCH_DATA2 is shown in Table 7-79.

Return to the Summary Table.

Table 7-79. RXF_PMATCH_DATA2 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-------------------|------|-------|--|
| 15-0 | PMATCH_DATA_31_16 | R/W | 0h | Bits 31:16 of Perfect Match Data - used for DA (destination address) match |

7.6.1.59 RXF_PMATCH_DATA3 Register (Offset = 138h) [Reset = 0000h]

RXF_PMATCH_DATA3 is shown in Table 7-80.

Table 7-80. RXF PMATCH DATA3 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-------------------|------|-------|--|
| 15-0 | PMATCH_DATA_47_32 | R/W | 0h | Bits 47:32 of Perfect Match Data - used for DA (destination address) match |

7.6.1.60 RXF_SCRON_PASS1 Register (Offset = 139h) [Reset = 0000h]

RXF_SCRON_PASS1 is shown in Table 7-81.

Return to the Summary Table.

Table 7-81. RXF_SCRON_PASS1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-------------------------|------|-------|---|
| 15-0 | SCRON_PASSWORD_15 _0 | R/W | 0h | Bits 15:0 of secure-on password (related to magic packet) |

7.6.1.61 RXF_SCRON_PASS2 Register (Offset = 13Ah) [Reset = 0000h]

RXF_SCRON_PASS2 is shown in Table 7-82.

Return to the Summary Table.

Table 7-82. RXF_SCRON_PASS2 Register Field Descriptions

| Bit Fie | eld | Туре | Reset | Description |
|---------|-----|------|-------|--|
| 15-0 SC | | R/W | 0h | Bits 31:16 of secure-on password (related to magic packet) |

7.6.1.62 RXF_SCRON_PASS3 Register (Offset = 13Bh) [Reset = 0000h]

RXF SCRON PASS3 is shown in Table 7-83.

Return to the Summary Table.

Table 7-83. RXF_SCRON_PASS3 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|--------------------------|------|-------|--|
| 15-0 | SCRON_PASSWORD_47 _32 | R/W | 0h | Bits 47:32 of secure-on password (related to magic packet) |

7.6.1.63 RXF_PATTERN_1 Register (Offset = 13Ch) [Reset = 0000h]

RXF_PATTERN_1 is shown in Table 7-84.

Return to the Summary Table.

Table 7-84. RXF_PATTERN_1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-------------------|------|-------|---|
| 15-0 | PATTERN_BYTES_0_1 | R/W | 0h | Bytes 0 (LSbyte) + 1 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.64 RXF_PATTERN_2 Register (Offset = 13Dh) [Reset = 0000h]

RXF_PATTERN_2 is shown in Table 7-85.



Table 7-85. RXF_PATTERN_2 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-------------------|------|-------|---|
| 15-0 | PATTERN_BYTES_2_3 | R/W | | Bytes 2 + 3 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.65 RXF_PATTERN_3 Register (Offset = 13Eh) [Reset = 0000h]

RXF_PATTERN_3 is shown in Table 7-86.

Return to the Summary Table.

Table 7-86. RXF_PATTERN_3 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-------------------|------|-------|--|
| 15-0 | PATTERN_BYTES_4_5 | R/W | Oh | Bytes 4 + 5 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.66 RXF_PATTERN_4 Register (Offset = 13Fh) [Reset = 0000h]

RXF_PATTERN_4 is shown in Table 7-87.

Return to the Summary Table.

Table 7-87. RXF_PATTERN_4 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-------------------|------|-------|---|
| 15-0 | PATTERN_BYTES_6_7 | R/W | | Bytes 6 + 7 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.67 RXF_PATTERN_5 Register (Offset = 140h) [Reset = 0000h]

RXF_PATTERN_5 is shown in Table 7-88.

Return to the Summary Table.

Table 7-88. RXF_PATTERN_5 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-------------------|------|-------|---|
| 15-0 | PATTERN_BYTES_8_9 | R/W | - | Bytes 8 + 9 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.68 RXF_PATTERN_6 Register (Offset = 141h) [Reset = 0000h]

RXF_PATTERN_6 is shown in Table 7-89.

Return to the Summary Table.

Table 7-89. RXF_PATTERN_6 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------|------|-------|--|
| 15-0 | PATTERN_BYTES_10_11 | R/W | | Bytes 10 + 11 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.69 RXF_PATTERN_7 Register (Offset = 142h) [Reset = 0000h]

RXF_PATTERN_7 is shown in Table 7-90.

Return to the Summary Table.

Table 7-90. RXF_PATTERN_7 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------|------|-------|--|
| 15-0 | PATTERN_BYTES_12_13 | R/W | | Bytes 12 + 13 of the configured pattern. Each byte can be masked |
| | | | | separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.70 RXF_PATTERN_8 Register (Offset = 143h) [Reset = 0000h]

RXF_PATTERN_8 is shown in Table 7-91.

Return to the Summary Table.

Table 7-91. RXF_PATTERN_8 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------|------|-------|---|
| 15-0 | PATTERN_BYTES_14_15 | R/W | Oh | Bytes 14 + 15 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.71 RXF_PATTERN_9 Register (Offset = 144h) [Reset = 0000h]

RXF_PATTERN_9 is shown in Table 7-92.

Return to the Summary Table.

Table 7-92. RXF_PATTERN_9 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------|------|-------|---|
| 15-0 | PATTERN_BYTES_16_17 | R/W | 0h | Bytes 16 + 17 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.72 RXF_PATTERN_10 Register (Offset = 145h) [Reset = 0000h]

RXF_PATTERN_10 is shown in Table 7-93.

Return to the Summary Table.

Table 7-93. RXF_PATTERN_10 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------|------|-------|---|
| 15-0 | PATTERN_BYTES_18_19 | R/W | | Bytes 18 + 19 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.73 RXF_PATTERN_11 Register (Offset = 146h) [Reset = 0000h]

RXF_PATTERN_11 is shown in Table 7-94.

Return to the Summary Table.

Table 7-94. RXF PATTERN 11 Register Field Descriptions

| | 100101 | • • | = | g |
|------|---------------------|------|-------|---|
| Bit | Field | Туре | Reset | Description |
| 15-0 | PATTERN_BYTES_20_21 | R/W | 0h | Bytes 20 + 21 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

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7.6.1.74 RXF_PATTERN_12 Register (Offset = 147h) [Reset = 0000h]

RXF_PATTERN_12 is shown in Table 7-95.

Return to the Summary Table.

Table 7-95. RXF_PATTERN_12 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------|------|-------|---|
| 15-0 | PATTERN_BYTES_22_23 | R/W | | Bytes 22 + 23 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.75 RXF_PATTERN_13 Register (Offset = 148h) [Reset = 0000h]

RXF_PATTERN_13 is shown in Table 7-96.

Return to the Summary Table.

Table 7-96. RXF_PATTERN_13 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------|------|-------|---|
| 15-0 | PATTERN_BYTES_24_25 | R/W | 0h | Bytes 24 + 25 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.76 RXF_PATTERN_14 Register (Offset = 149h) [Reset = 0000h]

RXF_PATTERN_14 is shown in Table 7-97.

Return to the Summary Table.

Table 7-97. RXF_PATTERN_14 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------|------|-------|---|
| 15-0 | PATTERN_BYTES_26_27 | R/W | Oh | Bytes 26 + 27 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.77 RXF_PATTERN_15 Register (Offset = 14Ah) [Reset = 0000h]

RXF_PATTERN_15 is shown in Table 7-98.

Return to the Summary Table.

Table 7-98. RXF_PATTERN_15 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------|------|-------|---|
| 15-0 | PATTERN_BYTES_28_29 | R/W | | Bytes 28 + 29 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.78 RXF_PATTERN_16 Register (Offset = 14Bh) [Reset = 0000h]

RXF_PATTERN_16 is shown in Table 7-99.

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Table 7-99. RXF_PATTERN_16 Register Field Descriptions

| Bit | t | Field | Туре | Reset | Description |
|------|---|---------------------|------|-------|---|
| 15-0 | 0 | PATTERN_BYTES_30_31 | R/W | | Bytes 30 + 31 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.79 RXF_PATTERN_17 Register (Offset = 14Ch) [Reset = 0000h]

RXF_PATTERN_17 is shown in Table 7-100.

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Table 7-100. RXF_PATTERN_17 Register Field Descriptions

| В | it | Field | Туре | Reset | Description |
|----|----|---------------------|------|-------|---|
| 15 | -0 | PATTERN_BYTES_32_33 | R/W | 0h | Bytes 32 + 33 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.80 RXF_PATTERN_18 Register (Offset = 14Dh) [Reset = 0000h]

RXF_PATTERN_18 is shown in Table 7-101.

Return to the Summary Table.

Table 7-101. RXF_PATTERN_18 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------|------|-------|---|
| 15-0 | PATTERN_BYTES_34_35 | R/W | Oh | Bytes 34 + 35 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.81 RXF_PATTERN_19 Register (Offset = 14Eh) [Reset = 0000h]

RXF_PATTERN_19 is shown in Table 7-102.

Return to the Summary Table.

Table 7-102. RXF_PATTERN_19 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------|------|-------|---|
| 15-0 | PATTERN_BYTES_36_37 | R/W | 0h | Bytes 36 + 37 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.82 RXF_PATTERN_20 Register (Offset = 14Fh) [Reset = 0000h]

RXF_PATTERN_20 is shown in Table 7-103.

Return to the Summary Table.

Table 7-103. RXF_PATTERN_20 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------|------|-------|---|
| 15-0 | PATTERN_BYTES_38_39 | R/W | | Bytes 38 + 39 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

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7.6.1.83 RXF_PATTERN_21 Register (Offset = 150h) [Reset = 0000h]

RXF_PATTERN_21 is shown in Table 7-104.

Return to the Summary Table.

Table 7-104. RXF_PATTERN_21 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------|------|-------|---|
| 15-0 | PATTERN_BYTES_40_41 | R/W | | Bytes 40 + 41 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.84 RXF_PATTERN_22 Register (Offset = 151h) [Reset = 0000h]

RXF_PATTERN_22 is shown in Table 7-105.

Return to the Summary Table.

Table 7-105. RXF_PATTERN_22 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------|------|-------|---|
| 15-0 | PATTERN_BYTES_42_43 | R/W | 0h | Bytes 42 + 43 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.85 RXF_PATTERN_23 Register (Offset = 152h) [Reset = 0000h]

RXF_PATTERN_23 is shown in Table 7-106.

Return to the Summary Table.

Table 7-106. RXF_PATTERN_23 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------|------|-------|---|
| 15-0 | PATTERN_BYTES_44_45 | R/W | Oh | Bytes 44 + 45 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.86 RXF_PATTERN_24 Register (Offset = 153h) [Reset = 0000h]

RXF_PATTERN_24 is shown in Table 7-107.

Return to the Summary Table.

Table 7-107. RXF_PATTERN_24 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------|------|-------|---|
| 15-0 | PATTERN_BYTES_46_47 | R/W | | Bytes 46 + 47 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.87 RXF_PATTERN_25 Register (Offset = 154h) [Reset = 0000h]

RXF_PATTERN_25 is shown in Table 7-108.

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Table 7-108. RXF_PATTERN_25 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------|------|-------|--|
| 15-0 | PATTERN_BYTES_48_49 | R/W | | Bytes 48 + 49 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.88 RXF_PATTERN_26 Register (Offset = 155h) [Reset = 0000h]

RXF_PATTERN_26 is shown in Table 7-109.

Return to the Summary Table.

Table 7-109. RXF_PATTERN_26 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------|------|-------|---|
| 15-0 | PATTERN_BYTES_50_51 | R/W | 0h | Bytes 50 + 51 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.89 RXF_PATTERN_27 Register (Offset = 156h) [Reset = 0000h]

RXF_PATTERN_27 is shown in Table 7-110.

Return to the Summary Table.

Table 7-110. RXF_PATTERN_27 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------|------|-------|---|
| 15-0 | PATTERN_BYTES_52_53 | R/W | 0h | Bytes 52 + 53 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.90 RXF_PATTERN_28 Register (Offset = 157h) [Reset = 0000h]

RXF_PATTERN_28 is shown in Table 7-111.

Return to the Summary Table.

Table 7-111. RXF_PATTERN_28 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------|------|-------|---|
| 15-0 | PATTERN_BYTES_54_55 | R/W | Oh | Bytes 54 + 55 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.91 RXF_PATTERN_29 Register (Offset = 158h) [Reset = 0000h]

RXF_PATTERN_29 is shown in Table 7-112.

Return to the Summary Table.

Table 7-112. RXF_PATTERN_29 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------|------|-------|---|
| 15-0 | PATTERN_BYTES_56_57 | R/W | Oh | Bytes 56 + 57 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

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7.6.1.92 RXF_PATTERN_30 Register (Offset = 159h) [Reset = 0000h]

RXF_PATTERN_30 is shown in Table 7-113.

Return to the Summary Table.

Table 7-113. RXF_PATTERN_30 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------|------|-------|---|
| 15-0 | PATTERN_BYTES_58_59 | R/W | | Bytes 58 + 59 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.93 RXF_PATTERN_31 Register (Offset = 15Ah) [Reset = 0000h]

RXF_PATTERN_31 is shown in Table 7-114.

Return to the Summary Table.

Table 7-114. RXF_PATTERN_31 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------|------|-------|---|
| 15-0 | PATTERN_BYTES_60_61 | R/W | | Bytes 60 + 61 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.94 RXF_PATTERN_32 Register (Offset = 15Bh) [Reset = 0000h]

RXF_PATTERN_32 is shown in Table 7-115.

Return to the Summary Table.

Table 7-115. RXF_PATTERN_32 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------|------|-------|---|
| 15-0 | PATTERN_BYTES_62_63 | R/W | 0h | Bytes 62 + 63 of the configured pattern. Each byte can be masked separately RXF_PATTERN_BYTE_MASK registers |

7.6.1.95 RXF PATTERN BYTE MASK 1 Register (Offset = 15Ch) [Reset = 0000h]

RXF_PATTERN_BYTE_MASK_1 is shown in Table 7-116.

Return to the Summary Table.

Table 7-116. RXF PATTERN BYTE MASK 1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|--------------------|------|-------|--|
| 15-0 | PATTERN_BYTES_MASK | R/W | 0h | Masks for bytes 0 to 15 of the pattern. For each byte: '1' means |
| | _0_15 | | | masked |

7.6.1.96 RXF_PATTERN_BYTE_MASK_2 Register (Offset = 15Dh) [Reset = 0000h]

RXF_PATTERN_BYTE_MASK_2 is shown in Table 7-117.

Return to the Summary Table.

Table 7-117. RXF_PATTERN_BYTE_MASK_2 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|------------------------------|------|-------|--|
| 15-0 | PATTERN_BYTES_MASK _16_31 | R/W | 0h | Masks for bytes 16 to 31 of the pattern. For each byte: '1' means masked |

7.6.1.97 RXF_PATTERN_BYTE_MASK_3 Register (Offset = 15Eh) [Reset = 0000h]

RXF_PATTERN_BYTE_MASK_3 is shown in Table 7-118.

Return to the Summary Table.

Table 7-118. RXF_PATTERN_BYTE_MASK_3 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|------------------------------|------|-------|--|
| 15-0 | PATTERN_BYTES_MASK _32_47 | R/W | 0h | Masks for bytes 32 to 47 of the pattern. For each byte: '1' means masked |

7.6.1.98 RXF_PATTERN_BYTE_MASK_4 Register (Offset = 15Fh) [Reset = 0000h]

RXF_PATTERN_BYTE_MASK_4 is shown in Table 7-119.

Return to the Summary Table.

Table 7-119. RXF_PATTERN_BYTE_MASK_4 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|------------------------------|------|-------|--|
| 15-0 | PATTERN_BYTES_MASK _48_63 | R/W | 0h | Masks for bytes 48 to 63 of the pattern. For each byte: '1' means masked |

7.6.1.99 10M_SGMII_CFG Register (Offset = 16Fh) [Reset = 0115h]

10M SGMII CFG is shown in Table 7-120.

Return to the Summary Table.

Table 7-120. 10M_SGMII_CFG Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------------------------------|------|-------|--|
| 15-8 | RESERVED | R | 0h | Reserved |
| 7 | 10M_SGMII_RATE_ADAP T_DISABLE | R/W | 0h | Rate Adaption Disable 0h = Rate Adaption Enabled 1h = Rate Adaption Disabled |
| 6 | RESERVED | R/W | 0h | Reserved |
| 5 | RESERVED | R/W | 0h | Reserved |
| 4 | RESERVED | R/W | 0h | Reserved |
| 3-0 | RESERVED | R/W | 0h | Reserved |

7.6.1.100 IO_MUX_CFG Register (Offset = 170h) [Reset = 0CX0h]

IO MUX CFG is shown in Table 7-121.

Return to the Summary Table.

Table 7-121. IO MUX CFG Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|----------|------|-------|-------------|
| 15-13 | RESERVED | R | 0h | Reserved |

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Table 7-121. IO_MUX_CFG Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Description (Continued) |
|------|--------------------|------|-------|---|
| 12-8 | CLK_O_SEL | R/W | Ch | Select clock output source 0h = Channel A receive clock 1h = Channel B receive clock 2h = Channel C receive clock 3h = Channel D receive clock 4h = Channel A receive clock divided by 5 5h = Channel B receive clock divided by 5 6h = Channel C receive clock divided by 5 7h = Channel D receive clock divided by 5 8h = Channel D receive clock divided by 5 8h = Channel A transmit clock 9h = Channel B transmit clock Ah = Channel C transmit clock Bh = Channel D transmit clock Ch = Reference clock (synchronous to XI input clock) Note: Reg 0xC6 must be set equal to 0x10 before CLK_O_SEL can be modified |
| 7 | RESERVED | R | 0h | Reserved |
| 6 | CLK_O_DISABLE | R/W | Xh | Clock Out Disable 0h = Clock Out Enable 1h = Clock Out Disable |
| 5 | RESERVED | R/W | 0h | Reserved |
| 4-1 | MAC_IMPEDANCE_CTRL | R/W | 8h | Impedance Control for MAC I/Os: Output impedance approximate range from 35-70 Ω in 16 steps. Lowest being 1111 and highest being 0000. Range and Step size vary with process. Default is set to 50Ω by trim but the default register value can vary by process. Non default values of MAC I/O impedance can be used based on trace impedance. Mismatch between device and trace impedance can cause voltage overshoot and undershoot. |
| 0 | RESERVED | R/W | 0h | Reserved |

7.6.1.101 TDR_GEN_CFG1 Register (Offset = 180h) [Reset = 0752h]

TDR_GEN_CFG1 is shown in Table 7-122.

Return to the Summary Table.

Table 7-122. TDR_GEN_CFG1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|--------------------|------|-------|--|
| 15-13 | RESERVED | R/W | 0h | Reserved |
| 12 | TDR_CH_CD_BYPASS | R/W | 0h | Bypass channel C and D in TDR tests |
| 11 | TDR_CROSS_MODE_DIS | R/W | 0h | If set, disable cross mode option - never check the cross (Listen only to the same channel you transmit) |
| 10 | TDR_NLP_CHECK | R/W | 1h | If set, check for NLPs during silence |
| 9-7 | TDR_AVG_NUM | R/W | 6h | Number Of TDR Cycles to Average: 000b = 1 TDR cycle 001b = 2 TDR cycles 010b = 4 TDR cycles 011b = 8 TDR cycles 100b = 16 TDR cycles 101b = 32 TDR cycles 110b = 64 TDR cycles (default) 111b = Reserved |
| 6-4 | TDR_SEG_NUM | R/W | 5h | Number of TDR segments to check |
| 3-0 | TDR_CYCLE_TIME | R/W | 2h | Number of micro-seconds in each TDR cycle |

7.6.1.102 TDR_GEN_CFG2 Register (Offset = 181h) [Reset = C850h]

TDR_GEN_CFG2 is shown in Table 7-123.

Table 7-123. TDR_GEN_CFG2 Register Field Descriptions

| | 141010 1 1211 1211 1211 121 13 14 14 14 14 14 14 14 14 14 14 14 14 14 | | | | | | |
|------|---|------|-------|---|--|--|--|
| Bit | Field | Туре | Reset | Description | | | |
| 15-8 | TDR_SILENCE_TH | R/W | C8h | Energy detection threshold | | | |
| 7-6 | TDR_POST_SILENCE_TI ME | R/W | 1h | timer for tdr to look for energy after TDR transaction, if energy detected this is fail tdr | | | |
| 5-4 | TDR_PRE_SILENCE_TIM E | R/W | 1h | timer for tdr to look for energy before starting , if energy detected this is fail tdr | | | |
| 3-0 | RESERVED | R | 0h | Reserved | | | |

7.6.1.103 TDR_SEG_DURATION1 Register (Offset = 182h) [Reset = 5326h]

TDR SEG DURATION1 is shown in Table 7-124.

Return to the Summary Table.

Table 7-124. TDR_SEG_DURATION1 Register Field Descriptions

| | idado : il ii il | | | | | | | |
|-------|--|------|-------|--|--|--|--|--|
| Bit | Field | Туре | Reset | Description | | | | |
| 15 | RESERVED | R | 0h | Reserved | | | | |
| 14-10 | TDR_SEG_DURATION_S EG3 | R/W | 14h | Number of 125MHz clock cycles to run for segment 3 | | | | |
| 9-5 | TDR_SEG_DURATION_S EG2 | R/W | 19h | Number of 125MHz clock cycles to run for segment 2 | | | | |
| 4-0 | TDR_SEG_DURATION_S EG1 | R/W | 6h | Number of 125MHz clock cycles to run for segment 1 | | | | |

7.6.1.104 TDR_SEG_DURATION2 Register (Offset = 183h) [Reset = A01Eh]

TDR_SEG_DURATION2 is shown in Table 7-125.

Return to the Summary Table.

Table 7-125. TDR_SEG_DURATION2 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------------|------|-------|--|
| 15-8 | TDR_SEG_DURATION_S EG5 | R/W | A0h | Number of 125MHz clock cycles to run for segment 5 |
| 7-6 | RESERVED | R | 0h | Reserved |
| 5-0 | TDR_SEG_DURATION_S EG4 | R/W | 1Eh | Number of 125MHz clock cycles to run for segment 4 |

7.6.1.105 TDR_GEN_CFG3 Register (Offset = 184h) [Reset = E976h]

TDR_GEN_CFG3 is shown in Table 7-126.

Return to the Summary Table.

Table 7-126. TDR_GEN_CFG3 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|-------------------------|------|-------|---|
| 15-12 | TDR_FWD_SHADOW_SE G4 | R/W | Eh | Indicates how much time to wait after max level before declaring we found a peak in segment 4 |
| 11-8 | TDR_FWD_SHADOW_SE G3 | R/W | 9h | Indicates how much time to wait after max level before declaring we found a peak in segment 3 |
| 7 | RESERVED | R | 0h | Reserved |
| 6-4 | TDR_FWD_SHADOW_SE G2 | R/W | 7h | Indicates how much time to wait after max level before declaring we found a peak in segment 2 |
| 3 | RESERVED | R | 0h | Reserved |



Table 7-126. TDR_GEN_CFG3 Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Description |
|-----|-------------------------|------|-------|---|
| 2-0 | TDR_FWD_SHADOW_SE G1 | R/W | _ · | Indicates how much time to wait after max level before declaring we found a peak in segment 1 |

7.6.1.106 TDR_GEN_CFG4 Register (Offset = 185h) [Reset = 19CFh]

TDR_GEN_CFG4 is shown in Table 7-127.

Return to the Summary Table.

Table 7-127. TDR_GEN_CFG4 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|-------------------------|------|-------|---|
| 15-14 | RESERVED | R | 0h | Reserved |
| 13-11 | TDR_SDW_AVG_LOC | R/W | 3h | how much to look between segments to search average peak |
| 10-9 | RESERVED | R | 0h | Reserved |
| 8 | TDR_TX_TYPE_SEG5 | R/W | 1h | the tx type (10/100) for this segment |
| 7 | TDR_TX_TYPE_SEG4 | R/W | 1h | the tx type (10/100) for this segment |
| 6 | TDR_TX_TYPE_SEG3 | R/W | 1h | the tx type (10/100) for this segment |
| 5 | TDR_TX_TYPE_SEG2 | R/W | 0h | the tx type (10/100) for this segment |
| 4 | TDR_TX_TYPE_SEG1 | R/W | 0h | the tx type (10/100) for this segment |
| 3-0 | TDR_FWD_SHADOW_SE G5 | R/W | Fh | Indicates how much time to wait after max level before declaring we found a peak in segment 5 |

7.6.1.107 TDR_PEAKS_LOC_A_0_1 Register (Offset = 190h) [Reset = 0000h]

TDR_PEAKS_LOC_A_0_1 is shown in Table 7-128.

Return to the Summary Table.

Table 7-128. TDR_PEAKS_LOC_A_0_1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-------------------|------|-------|------------------------------------|
| 15-8 | TDR_PEAKS_LOC_A_1 | R | 0h | Found peak location 1 in channel A |
| 7-0 | TDR_PEAKS_LOC_A_0 | R | 0h | Found peak location 0 in channel A |

7.6.1.108 TDR_PEAKS_LOC_A_2_3 Register (Offset = 191h) [Reset = 0000h]

TDR_PEAKS_LOC_A_2_3 is shown in Table 7-129.

Return to the Summary Table.

Table 7-129. TDR_PEAKS_LOC_A_2_3 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-------------------|------|-------|------------------------------------|
| 15-8 | TDR_PEAKS_LOC_A_3 | R | 0h | Found peak location 3 in channel A |
| 7-0 | TDR_PEAKS_LOC_A_2 | R | 0h | Found peak location 2 in channel A |

7.6.1.109 TDR_PEAKS_LOC_A_4_B_0 Register (Offset = 192h) [Reset = 0000h]

TDR_PEAKS_LOC_A_4_B_0 is shown in Table 7-130.

Table 7-130. TDR_PEAKS_LOC_A_4_B_0 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-------------------|------|-------|------------------------------------|
| 15-8 | TDR_PEAKS_LOC_B_0 | R | 0h | Found peak location 0 in channel B |
| 7-0 | TDR_PEAKS_LOC_A_4 | R | 0h | Found peak location 4 in channel A |

7.6.1.110 TDR_PEAKS_LOC_B_1_2 Register (Offset = 193h) [Reset = 0000h]

TDR_PEAKS_LOC_B_1_2 is shown in Table 7-131.

Return to the Summary Table.

Table 7-131. TDR_PEAKS_LOC_B_1_2 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-------------------|------|-------|------------------------------------|
| 15-8 | TDR_PEAKS_LOC_B_2 | R | 0h | Found peak location 2 in channel B |
| 7-0 | TDR_PEAKS_LOC_B_1 | R | 0h | Found peak location 1 in channel B |

7.6.1.111 TDR_PEAKS_LOC_B_3_4 Register (Offset = 194h) [Reset = 0000h]

TDR_PEAKS_LOC_B_3_4 is shown in Table 7-132.

Return to the Summary Table.

Table 7-132. TDR_PEAKS_LOC_B_3_4 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-------------------|------|-------|------------------------------------|
| 15-8 | TDR_PEAKS_LOC_B_4 | R | 0h | Found peak location 4 in channel B |
| 7-0 | TDR_PEAKS_LOC_B_3 | R | 0h | Found peak location 3 in channel B |

7.6.1.112 TDR_PEAKS_LOC_C_0_1 Register (Offset = 195h) [Reset = 0000h]

TDR_PEAKS_LOC_C_0_1 is shown in Table 7-133.

Return to the Summary Table.

Table 7-133. TDR PEAKS LOC C 0 1 Register Field Descriptions

| | | | | | _o_ : ::og:oto: : :ota = ooo::p::otio |
|--|------|-------------------|------|-------|---------------------------------------|
| | Bit | Field | Туре | Reset | Description |
| | 15-8 | TDR_PEAKS_LOC_C_1 | R | 0h | Found peak location 1 in channel C |
| | 7-0 | TDR_PEAKS_LOC_C_0 | R | 0h | Found peak location 0 in channel C |

7.6.1.113 TDR_PEAKS_LOC_C_2_3 Register (Offset = 196h) [Reset = 0000h]

TDR_PEAKS_LOC_C_2_3 is shown in Table 7-134.

Return to the Summary Table.

Table 7-134. TDR_PEAKS_LOC_C_2_3 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-------------------|------|-------|------------------------------------|
| 15-8 | TDR_PEAKS_LOC_C_3 | R | 0h | Found peak location 3 in channel C |
| 7-0 | TDR_PEAKS_LOC_C_2 | R | 0h | Found peak location 2 in channel C |

7.6.1.114 TDR_PEAKS_LOC_C_4_D_0 Register (Offset = 197h) [Reset = 0000h]

TDR_PEAKS_LOC_C_4_D_0 is shown in Table 7-135.



Table 7-135. TDR_PEAKS_LOC_C_4_D_0 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-------------------|------|-------|------------------------------------|
| 15-8 | TDR_PEAKS_LOC_D_0 | R | 0h | Found peak location 0 in channel D |
| 7-0 | TDR_PEAKS_LOC_C_4 | R | 0h | Found peak location 4 in channel C |

7.6.1.115 TDR_PEAKS_LOC_D_1_2 Register (Offset = 198h) [Reset = 0000h]

TDR_PEAKS_LOC_D_1_2 is shown in Table 7-136.

Return to the Summary Table.

Table 7-136. TDR_PEAKS_LOC_D_1_2 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-------------------|------|-------|------------------------------------|
| 15-8 | TDR_PEAKS_LOC_D_2 | R | 0h | Found peak location 2 in channel D |
| 7-0 | TDR_PEAKS_LOC_D_1 | R | 0h | Found peak location 1 in channel D |

7.6.1.116 TDR_PEAKS_LOC_D_3_4 Register (Offset = 199h) [Reset = 0000h]

TDR_PEAKS_LOC_D_3_4 is shown in Table 7-137.

Return to the Summary Table.

Table 7-137. TDR_PEAKS_LOC_D_3_4 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-------------------|------|-------|------------------------------------|
| 15-8 | TDR_PEAKS_LOC_D_4 | R | 0h | Found peak location 4 in channel D |
| 7-0 | TDR_PEAKS_LOC_D_3 | R | 0h | Found peak location 3 in channel D |

7.6.1.117 TDR_GEN_STATUS Register (Offset = 1A4h) [Reset = 0000h]

TDR_GEN_STATUS is shown in Table 7-138.

Return to the Summary Table.

Table 7-138. TDR_GEN_STATUS Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|----------------------------|------|-------|--|
| 15-12 | RESERVED | R | 0h | Reserved |
| 11 | TDR_P_LOC_CROSS_M ODE_D | R | 0h | Peak found at cross mode in channel D |
| 10 | TDR_P_LOC_CROSS_M ODE_C | R | 0h | Peak found at cross mode in channel C |
| 9 | TDR_P_LOC_CROSS_M ODE_B | R | 0h | Peak found at cross mode in channel B |
| 8 | TDR_P_LOC_CROSS_M ODE_A | R | 0h | Peak found at cross mode in channel A |
| 7 | TDR_P_LOC_OVERFLO W_D | R | 0h | Total number of peaks in current segment reached max value of 5 in channel D |
| 6 | TDR_P_LOC_OVERFLO W_C | R | 0h | Total number of peaks in current segment reached max value of 5 in channel C |
| 5 | TDR_P_LOC_OVERFLO W_B | R | 0h | Total number of peaks in current segment reached max value of 5 in channel B |
| 4 | TDR_P_LOC_OVERFLO W_A | R | 0h | Total number of peaks in current segment reached max value of 5 in channel A |
| 3 | TDR_SEG1_HIGH_CROS S_D | R | 0h | Peak crossed high threshold of segment 1 in channel D |

Table 7-138. TDR_GEN_STATUS Register Field Descriptions (continued)

| | 14510 7 1001 12 | | ., OO | jieter i ieia Beeeriptione (continuea) |
|-----|---------------------------|------|-------|---|
| Bit | Field | Туре | Reset | Description |
| 2 | TDR_SEG1_HIGH_CROS S_C | R | 0h | peak crossed high threshold of segment 1 in channel C |
| 1 | TDR_SEG1_HIGH_CROS S_B | R | 0h | peak crossed high threshold of segment 1 in channel B |
| 0 | TDR_SEG1_HIGH_CROS S_A | R | 0h | peak crossed high threshold of segment 1 in channel A |

7.6.1.118 TDR_PEAKS_SIGN_A_B Register (Offset = 1A5h) [Reset = 0000h]

TDR_PEAKS_SIGN_A_B is shown in Table 7-139.

Return to the Summary Table.

Table 7-139. TDR_PEAKS_SIGN_A_B Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|--------------------|------|-------|---------------------------------|
| 15-10 | RESERVED | R | 0h | Reserved |
| 9 | TDR_PEAKS_SIGN_B_4 | R | 0h | found peaks sign 4 in channel B |
| 8 | TDR_PEAKS_SIGN_B_3 | R | 0h | found peaks sign 3 in channel B |
| 7 | TDR_PEAKS_SIGN_B_2 | R | 0h | found peaks sign 2 in channel B |
| 6 | TDR_PEAKS_SIGN_B_1 | R | 0h | found peaks sign 1 in channel B |
| 5 | TDR_PEAKS_SIGN_B_0 | R | 0h | found peaks sign 0 in channel B |
| 4 | TDR_PEAKS_SIGN_A_4 | R | 0h | found peaks sign 4 in channel A |
| 3 | TDR_PEAKS_SIGN_A_3 | R | 0h | found peaks sign 3 in channel A |
| 2 | TDR_PEAKS_SIGN_A_2 | R | 0h | found peaks sign 2 in channel A |
| 1 | TDR_PEAKS_SIGN_A_1 | R | 0h | found peaks sign 1 in channel A |
| 0 | TDR_PEAKS_SIGN_A_0 | R | 0h | found peaks sign 0 in channel A |

7.6.1.119 TDR_PEAKS_SIGN_C_D Register (Offset = 1A6h) [Reset = 0000h]

TDR_PEAKS_SIGN_C_D is shown in Table 7-140.

Table 7-140. TDR_PEAKS_SIGN_C_D Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|--------------------|------|-------|---------------------------------|
| 15-10 | RESERVED | R | 0h | Reserved |
| 9 | TDR_PEAKS_SIGN_D_4 | R | 0h | found peaks sign 4 in channel D |
| 8 | TDR_PEAKS_SIGN_D_3 | R | 0h | found peaks sign 3 in channel D |
| 7 | TDR_PEAKS_SIGN_D_2 | R | 0h | found peaks sign 2 in channel D |
| 6 | TDR_PEAKS_SIGN_D_1 | R | 0h | found peaks sign 1 in channel D |
| 5 | TDR_PEAKS_SIGN_D_0 | R | 0h | found peaks sign 0 in channel D |
| 4 | TDR_PEAKS_SIGN_C_4 | R | 0h | found peaks sign 4 in channel C |
| 3 | TDR_PEAKS_SIGN_C_3 | R | 0h | found peaks sign 3 in channel C |
| 2 | TDR_PEAKS_SIGN_C_2 | R | 0h | found peaks sign 2 in channel C |
| 1 | TDR_PEAKS_SIGN_C_1 | R | 0h | found peaks sign 1 in channel C |
| 0 | TDR_PEAKS_SIGN_C_0 | R | 0h | found peaks sign 0 in channel C |

7.6.1.120 DBG_PRBS_PKT_CNT_1 Register (Offset = 1A8h) [Reset = 0000h]

DBG_PRBS_PKT_CNT_1 is shown in Table 7-141.

Return to the Summary Table.

Table 7-141. DBG_PRBS_PKT_CNT_1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-------------------|------|-------|--|
| 15-0 | PRBS_PKT_CNT_15_0 | R | | Holds bits [15:0] of number of total packets that received by the PRBS checker. Value in this register is locked when write is done to register DBG_PRBS_ERR_CNT bit[0] or bit[1]. When PRBS Count Mode set to zero, count stops on 0xFFFFFFFF (see register 0x0016) |

7.6.1.121 DBG_PRBS_PKT_CNT_2 Register (Offset = 1A9h) [Reset = 0000h]

DBG_PRBS_PKT_CNT_2 is shown in Table 7-142.

Return to the Summary Table.

Table 7-142. DBG_PRBS_PKT_CNT_2 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|--------------------|------|-------|---|
| 15-0 | PRBS_PKT_CNT_31_16 | R | | Holds bits [31:16] of number of total packets that received by the PRBS checker. Value in this register is locked when write is done to register DBG_PRBS_ERR_CNT bit[0] or bit[1]. When PRBS Count Mode set to zero, count stops on 0xFFFFFFFF (see register 0x0016) |

7.6.1.122 OP_MODE_DECODE Register (Offset = 1DFh) [Reset = 0040h]

OP_MODE_DECODE is shown in Table 7-143.

Return to the Summary Table.

Table 7-143. OP MODE DECODE Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------------|------|-------|--|
| 15-9 | RESERVED | R | 0h | Reserved |
| 8-7 | RESERVED | R | 0h | Reserved |
| 6 | BRIDGE_MODE_RGMII_ MAC | R/W | 1h | 0h = SGMII to RGMII Bridge 1h = RGMII to SGMII Bridge |
| 5 | RGMII_MII_SEL | R/W | 0h | 0h = RGMII 1h = MII |
| 4 | RESERVED | R | 0h | Reserved |
| 3 | RESERVED | R | 0h | Reserved |
| 2-0 | CFG_OPMODE | R/W | Oh | Operation Mode 0h = RGMII to Copper 1h = RGMII to 1000Base-X 2h = RGMII to 100Base-FX 3h = RGMII to SGMII 4h = 1000Base-T to 1000Base-X 5h = 100Base-TX to 100Base-FX 6h = SGMII to Copper 7h = Reserved |

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7.6.1.123 GPIO_MUX_CTRL Register (Offset = 1E0h) [Reset = 417Ah]

GPIO_MUX_CTRL is shown in Table 7-144.

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Table 7-144. GPIO_MUX_CTRL Register Field Descriptions

| Table 7-144. Of 10_Inlox_011th Register Field Descriptions | | | | | | |
|--|--------------------------|------|-------|--|--|--|
| Bit | Field | Туре | Reset | Description | | |
| 15-12 | RESERVED | R/W | 0h | Reserved | | |
| 11-8 | RESERVED | R/W | 0h | Reserved | | |
| 7-4 | JTAG_TDO_GPIO_1_CT RL | R/W | 7h | See bits [3:0] for GPIO control options. If either type of SFD is enabled, this pin automatically configures to TX_SFD. | | |
| 3-0 | LED_2_GPIO_0_CTRL | R/W | Ah | Following options are available for GPIO control. If either type of SFD is enabled, this pin automatically configures to RX_SFD. 0h = CLK_OUT 1h = RESERVED 2h = INT 3h = Link status 4h = RESERVED 5h = Transmit SFD 6h = Receive SFD 7h = WOL 8h = Energy detect(1000Base-T and 100Base-TX only) 9h = PRBS errors Ah = LED_2 Bh = LED_GPIO(3) Ch = CRS Dh = COL Eh = constant '0' Fh = constant '1' | | |

7.6.1.124 MC_LINK_LOSS Register (Offset = 1ECh) [Reset = 1FFDh]

MC_LINK_LOSS is shown in Table 7-145.

Return to the Summary Table.

Table 7-145. MC_LINK_LOSS Register Field Descriptions

| | 1 | - 10g | | |
|-------|------------------|---|-------|--|
| Bit | Field | Туре | Reset | Description |
| 15-13 | RESERVED | R/W | 0h | Reserved |
| 12-9 | RESERVED | R/W | 0h | Reserved |
| 8 | RESERVED | R/W | 0h | Reserved |
| 7 | RESERVED | R/W | 0h | Reserved |
| 6 | RESERVED | R/W | 0h | Reserved |
| 5 | RESERVED | R/W | 0h | Reserved |
| 4 | RESERVED | R/W | 0h | Reserved |
| 3 | CFG_LINK_LOSS_EN | R/W | 1h | Disables MC link loss feature 0h = Enable link loss feature 1h = Disable link loss feature |
| 2-1 | RESERVED | R/W | 0h | Reserved |
| 0 | RESERVED | R/W | 0h | Reserved |

7.6.1.125 FX_CTRL Register (Offset = C00h) [Reset = 1140h]

FX_CTRL is shown in Table 7-146.

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Registers after 0xC00 are common for Fiber, SGMII IP blocks for RGMII-to-SGMII, SGMII-to-RGMII, and Media Convertor.



Table 7-146, FX CTRL Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-----|-------------------------|------|-------|--|
| 15 | CTRL0_RESET | R/W | Oh | Controls reset in Fiber mode. This bit is automatically cleared after reset is completed. 0h = Normal Operation 1h = Reset. |
| 14 | CTRL0_LOOPBACK | R/W | Oh | 100BASE-X, 1000BASE-FX and RGMII-SGMII, SGMII-RGMII MAC loopback. 0h = Disable MAC loopback 1h = Enable MAC Loopback |
| 13 | CTRLO_SPEED_SEL_LS B | R/W | Oh | Speed selection bits LSB[13] and MSB[6] are used to control the data rate of the ethernet link when in Fiber Ethernet mode. These bits are also affected by straps. Oh = 10Mbps 1h = 100Mbps 2h = 1000Mbps 3h = Reserved |
| 12 | CTRL0_ANEG_EN | R/W | 1h | Enable 1000BASE-X, R2S, S2R Bridge mode Auto-negotiation. Controlled by strap. 0h = Disable 1h = Enable |
| 11 | CTRL0_PWRDN | R/W | Oh | Power Down SGMII for R2S, S2R, 1000BX, 100FX. Digital is in reset. 0h = Normal operation 1h = Power Down |
| 10 | CTRL0_ISOLATE | R/W | Oh | Isolate MAC interface. Used in 1000BX, 100FX and RGMII-SGMII mode. N/A in SGMII-RGMII mode. 0h = Normal operation 1h = Isolate |
| 9 | CTRL0_RESTART_AN | R/W | Oh | Writing 1 to this control bit restarts Autoneg in SGMII and 1000B-X mode. This bit is self-cleared by hardware. 0h = Normal operation 1h = Restart 1000BASE-X/SGMII Auto-Negotiation Process |
| 8 | CTRL0_DUPLEX_MODE | R/W | 1h | Forced Duplex mode. Applicable only in MII-100FX mode. 0h = Half duplex mode 1h = Full duplex mode |
| 7 | CTRL0_COL_TEST | R/W | 0h | Used to test collision functionality. Settings this bit asserts collision on just asserting tx_en |
| 6 | CTRL0_SPEED_SEL_MS B | R/W | 1h | Forced Speed for SGMII only when Autoneg is disabled. Controlled by straps. See bit 13 of this register. |
| 5-0 | RESERVED | R/W | 0h | Reserved |

7.6.1.126 FX_STS Register (Offset = C01h) [Reset = 6149h]

FX_STS is shown in Table 7-147.

Return to the Summary Table.

Table 7-147. FX_STS Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-----|-----------------|------|-------|--|
| 15 | STTS_100B_T4 | R | 0h | Return Always 0. Device doesn 't support 100BASE-T4 mode |
| 14 | STTS_100B_X_FD | R | 1h | Return Always 1. Device supports 100BASE-FX Full-Duplex |
| 13 | STTS_100B_X_HD | R | 1h | Return Always 1. Device supports 100BASE-FX Half-Duplex |
| 12 | STTS_10B_FD | R | 0h | Return Always 0. Device doesn 't support 10Mbps fiber mode |
| 11 | STTS_10B_HD | R | 0h | Return Always 0. Device doesn 't support 10Mbps fiber mode |
| 10 | STTS_100B_T2_FD | R | 0h | Return Always 0. Device doesn 't support 100BASE-T2 mode |
| 9 | STTS_100B_T2_HD | R | 0h | Return Always 0. Device doesn 't support 100BASE-T2 mode |

Table 7-147. FX_STS Register Field Descriptions (continued)

| Table 1-141: 1 X_010 Register | | | | riola Becomptione (continued) |
|-------------------------------|------------------------------|------|-------|---|
| Bit | Field | Туре | Reset | Description |
| 8 | STTS_EXTENDED_STATUS | R | 1h | Return Always 1. Extended status information in register15 |
| 7 | RESERVED | R | 0h | Reserved |
| 6 | STTS_MF_PREAMBLE_S UPRSN | R | 1h | Return Always 1. Phy accepts management frames with preamble suppressed. |
| 5 | STTS_ANEG_COMPLET E | R | 0h | Auto negotiation process complete O:Auto negotiation process not complete |
| 4 | STTS_REMOTE_FAULT | R | 0h | Remote fault condition detected Remote fault condition not detected |
| 3 | STTS_ANEG_ABILITY | R | 1h | Return Always 1. Device capable of performing Auto-Negotiation |
| 2 | STTS_LINK_STATUS | R | Oh | Indicates 100FX/1000X link-up in 100FX/1000X and 100FX/1000X MC Mode. In RGMII-SGMII mode, this bit indicates SGMII link-up and LP link up if Autoneg is enabled else(if autoneg disabled) this bit indicates SGMII link-up. In SGMII-RGMII mode, this bit indicates LP link-up 0h = link down 1h = link-up |
| 1 | STTS_JABBER_DET | R | 0h | Return 0. |
| 0 | STTS_EXTENDED_CAPA BILITY | R | 1h | Return Always 1. Device supports Extended register capabilities |

7.6.1.127 FX_PHYID1 Register (Offset = C02h) [Reset = 2000h]

FX_PHYID1 is shown in Table 7-148.

Return to the Summary Table.

Table 7-148. FX_PHYID1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|----------------|------|-------|--|
| 15-14 | RESERVED | R | 0h | Reserved |
| 13-0 | OUI_6_19_FIBER | R | 2000h | Organizationally Unique Identifier Bits 19:6 |

7.6.1.128 FX_PHYID2 Register (Offset = C03h) [Reset = A0F1h]

FX_PHYID2 is shown in Table 7-149.

Return to the Summary Table.

Table 7-149. FX_PHYID2 Register Field Descriptions

| _ | | | | | <u> </u> |
|---|-------|--------------------|------|-------|---|
| | Bit | Field | Туре | Reset | Description |
| | 15-10 | OUI_0_5_FIBER | R | 28h | Organizationally Unique Identifier Bits 5:0 |
| | 9-4 | MODEL_NUM_FIBER | R | Fh | model number |
| | 3-0 | REVISION_NUM_FIBER | R | 1h | revision number |

7.6.1.129 FX_ANADV Register (Offset = C04h) [Reset = 0020h]

FX_ANADV is shown in Table 7-150.



Table 7-150. FX_ANADV Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|-------------------------|------|-------|--|
| 15 | BP_NEXT_PAGE | R/W | 0h | Set this bit if next page needs to be advertised. 1 = Advertise 0 = Not advertised |
| 14 | BP_ACK | R | 0h | Always return 0 |
| 13-12 | BP_REMOTE_FAULT | R/W | 0h | 00 = LINK_STATUS/UP 01=OFFLINE 10=LINK_FAILURE 11=AUTO_ERROR |
| 11-9 | RESERVED | R | 0h | Reserved |
| 8 | BP_ASYMMETRIC_PAUS E | R/W | 0h | 1 = Asymmetric Pause 0 = No asymmetric Pause |
| 7 | BP_PAUSE | R/W | 0h | 1 = MAC PAUSE 0 = No MAC PAUSE |
| 6 | BP_HALF_DUPLEX | R/W | 0h | 1 = Advertise 0 = Not advertised |
| 5 | BP_FULL_DUPLEX | R/W | 1h | 1 = Advertise 0 = Not advertised |
| 4-0 | BP_RSVD1 | R | 0h | Reserved. Set to 00000 |

7.6.1.130 FX_LPABL Register (Offset = C05h) [Reset = 0000h]

FX_LPABL is shown in Table 7-151.

Return to the Summary Table.

Table 7-151. FX_LPABL Register Field Descriptions

| Tubio 1 To 11 1 A_E1 AEE Register 1 Total Becomptions | | | | | |
|---|---------------------------------|------|-------|--|--|
| Bit | Field | Туре | Reset | Description | |
| 15 | LP_ABILITY_NEXT_PAG E | R | 0h | 0h = LP is not capable of next page 1h = LP is capable of next page | |
| 14 | LP_ABILITY_ACK | R | 0h | Oh = LP has not acknowledged that the LP has received link code word 1h = LP acknowledges that the LP has received link code word | |
| 13-12 | LP_ABILITY_REMOTE_F AULT | R | 0h | Received Remote fault from LP. 0h = LINK_STATUS/UP 1h = OFFLINE 2h = LINK_FAILURE 3h = AUTO_ERROR | |
| 11-9 | RESERVED | R | 0h | Reserved | |
| 8 | LP_ABILITY_ASYMMETR IC_PAUSE | R | 0h | 0h = LP does not request asymmetric pause 1h = LP requests of asymmetric pause | |
| 7 | LP_ABILITY_PAUSE | R | 0h | 0h = LP is not capable of pause operation 1h = LP is capable of pause operation | |
| 6 | LP_ABILITY_HALF_DUPL EX | R | 0h | 0h = LP is not 1000BASE-X Half-duplex capable 1h = LP is 1000BASE-X Half-duplex capable | |
| 5 | LP_ABILITY_FULL_DUPL EX | R | 0h | 0h = LP is not 1000BASE-X Full-duplex capable 1h = LP is 1000BASE-X Full-duplex capable | |
| 4-0 | RESERVED | R | 0h | Reserved | |

7.6.1.131 FX_ANEXP Register (Offset = C06h) [Reset = 0000h]

FX_ANEXP is shown in Table 7-152.

Return to the Summary Table.

Table 7-152. FX ANEXP Register Field Descriptions

| | | | | <u> </u> |
|------|----------|------|-------|-------------|
| Bit | Field | Туре | Reset | Description |
| 15-4 | RESERVED | R | 0h | Reserved |

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Table 7-152. FX_ANEXP Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Description |
|-----|---------------------------------|------|-------|---|
| 3 | AN_EXP_LP_NEXT_PAG E_ABLE | R | 0h | Bit is set to 1 when device receives base page with NP bit (bit 15) set to 1. The bit is cleared when Autoneg state goes to AN_ENABLE. This bit is expected that NP bit sets to 0 in SGMII mode as SGMII doesn 't supports next page. Oh = Link partner is not next page able 1h = Link partner is Next page able |
| 2 | AN_EXP_LOCAL_NEXT_ PAGE_ABLE | R | 0h | This bit is set to 1 in fiber 1000BASE-X mode. This bit is set to 0 in SGMII mode. 0h = Local device is not next page able 1h = Local device is next page able |
| 1 | AN_EXP_PAGE_RECEIV ED | R | Oh | Status is latched when new page is received by the device. This bit is cleared when SW reads this register. 0h = No new page has been received 1h = A new page(base page or next page) has been received |
| 0 | AN_EXP_LP_AUTO_NEG _ABLE | R | Oh | Bit is set to 1 when device receives base page. This bit is cleared when Autoneg state goes to AN_ENABLE. 0h = Link partner is not auto negotiation able 1h = Link partner is auto negotiation able |

7.6.1.132 FX_LOCNP Register (Offset = C07h) [Reset = 2001h]

FX_LOCNP is shown in Table 7-153.

Return to the Summary Table.

Table 7-153. FX_LOCNP Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-----------------------------|------|-------|---|
| 15 | NP_TX_NEXT_PAGE | R/W | 0h | 0: If last page 1: If there is more pages to transmit |
| 14 | RESERVED | R | 0h | Reserved |
| 13 | NP_TX_MESSAGE_PAG E_MODE | R/W | 1h | 0: Unformatted page 1: Message page |
| 12 | NP_TX_ACK_2 | R/W | 0h | Device has the ability to comply with the message 0h = Cannot comply with message. 1h = Comply with message. |
| 11 | NP_TX_TOGGLE | R | Oh | 0h = Previous value of the transmitted link codeword equalled logic one. 1h = Previous value of the transmitted link codeword equalled logic zero |
| 10-0 | NP_TX_MESSAGE_FIEL D | R/W | 1h | Message code field as defined in IEEE Annex 28C |

7.6.1.133 FX_LPNP Register (Offset = C08h) [Reset = 0000h]

FX_LPNP is shown in Table 7-154.

Return to the Summary Table.

Table 7-154. FX_LPNP Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-----|-----------------------------|------|-------|--|
| 15 | LP_NP_NEXT_PAGE | R | Oh | LP last page 0h = If last page 1h = If there is more pages to transmit |
| 14 | LP_NP_ACK | R | 0h | Reserved |
| 13 | LP_NP_MESSAGE_PAG E_MODE | R | 0h | LP message page mode 0: Unformatted page 1: Message page |



Table 7-154. FX_LPNP Register Field Descriptions (continued)

| | | | | , , |
|------|----------------------|------|-------|---|
| Bit | Field | Туре | Reset | Description |
| 12 | LP_NP_ACK_2 | R | 0h | LP has the ability to comply with the message 0: Cannot comply with message. 1: Comply with message. |
| 11 | LP_NP_TOGGLE | R | 0h | LP Toggle bit 0: Previous value of the transmitted link codeword equalled logic one. 1: Previous value of the transmitted link codeword equalled logic zero |
| 10-0 | LP_NP_MESSAGE_FIEL D | R | 0h | LP Message code field as defined in IEEE Annex 28C |

7.6.1.134 CFG_FX_CTRL0 Register (Offset = C10h) [Reset = 0000h]

CFG FX CTRL0 is shown in Table 7-155.

Return to the Summary Table.

Table 7-155. CFG_FX_CTRL0 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|----------|------|-------|--|
| 15-10 | RESERVED | R | 0h | RESERVED |
| 9 | CFG_SDIN | R/W | | 0h = Signal Detect Pin is not used 1h = Signal Detect Pin is used |
| 8-0 | RESERVED | R | 0h | RESERVED |

7.6.1.135 FX_INT_EN Register (Offset = C18h) [Reset = 03FFh]

FX_INT_EN is shown in Table 7-156.

Return to the Summary Table.

Table 7-156. FX_INT_EN Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|--------------------|------|-------|---|
| 15-10 | RESERVED | R | 0h | Reserved |
| 9 | FEF_FAULT_EN | R/W | 1h | FEF fault received interrupt enable 0h = Disable Interrupt 1h = Enable Interrupt |
| 8 | TX_FIFO_FULL_EN | R/W | 1h | Fiber and SGMII Tx FIFO full interrupt enable 0h = Disable Interrupt 1h = Enable Interrupt |
| 7 | TX_FIFO_EMPTY_EN | R/W | 1h | Fiber and SGMII Tx FIFO empty interrupt enable 0h = Disable Interrupt 1h = Enable Interrupt |
| 6 | RX_FIFO_FULL_EN | R/W | 1h | Fiber and SGMII Rx FIFO full interrupt enable 0h = Disable Interrupt 1h = Enable Interrupt |
| 5 | RX_FIFO_EMPTY_EN | R/W | 1h | Fiber and SGMII Rx FIFO empty interrupt enable 0h = Disable Interrupt 1h = Enable Interrupt |
| 4 | LINK_STS_CHANGE_EN | R/W | 1h | Link Status Change Interrupt Enable 0h = Disable Interrupt 1h = Enable Interrupt |
| 3 | LP_FAULT_RX_EN | R/W | 1h | Link Partner Remote Fault Interrupt Enable 0h = Disable Interrupt 1h = Enable Interrupt |
| 2 | PRI_RES_FAIL_EN | R/W | 1h | Priority Resolution Fail Interrupt Enable 0h = Disable Interrupt 1h = Enable Interrupt |

Table 7-156. FX INT EN Register Field Descriptions (continued)

| | Table 7 Too. 1 X_INT_EN Troughster 1 leid Descriptions (continued) | | | | | |
|-----|--|------|-------|---|--|--|
| Bit | Field | Туре | Reset | Description | | |
| 1 | LP_NP_RX_EN | R/W | 1h | Link Partner Next Page Received Interrupt Enable 0h = Disable Interrupt 1h = Enable Interrupt | | |
| 0 | LP_BP_RX_EN | R/W | 1h | Link Partner Base Page Received Interrupt Enable 0h = Disable Interrupt 1h = Enable Interrupt | | |

7.6.1.136 FX_INT_STS Register (Offset = C19h) [Reset = 0000h]

FX_INT_STS is shown in Table 7-157.

Return to the Summary Table.

Table 7-157. FX_INT_STS Register Field Descriptions

| Table 7-157. FX | | | INT_STS Register Field Descriptions | | |
|-----------------|-----------------|------|-------------------------------------|---|--|
| Bit | Field | Туре | Reset | Description | |
| 15-10 | RESERVED | R | 0h | Reserved | |
| 9 | FEF_FAULT | RC | Oh | FEF fault received interrupt 0h = No Interrupt pending 1h = Interrupt pending, cleared on read | |
| 8 | TX_FIFO_FULL | RC | 0h | Fiber Tx FIFO full interrupt 0h = No Interrupt pending 1h = Interrupt pending, cleared on read | |
| 7 | TX_FIFO_EMPTY | RC | Oh | Fiber Tx FIFO empty interrupt 0h = No Interrupt pending 1h = Interrupt pending, cleared on read | |
| 6 | RX_FIFO_FULL | RC | Oh | Fiber Rx FIFO full interrupt 0h = No Interrupt pending 1h = Interrupt pending, cleared on read | |
| 5 | RX_FIFO_EMPTY | RC | Oh | Fiber Rx FIFO empty interrupt 0h = No Interrupt pending 1h = Interrupt pending, cleared on read | |
| 4 | LINK_STS_CHANGE | RC | Oh | Link Status Change Interrupt 0h = No Interrupt pending 1h = Interrupt pending, cleared on read | |
| 3 | LP_FAULT_RX | RC | Oh | Link Partner Remote Fault Interrupt 0h = No Interrupt pending 1h = Interrupt pending, cleared on read | |
| 2 | PRI_RES_FAIL | RC | Oh | Priority Resolution Fail Interrupt 0h = No Interrupt pending 1h = Interrupt pending, cleared on read | |
| 1 | LP_NP_RX | RC | Oh | Link Partner Next Page Received Interrupt 0h = No Interrupt pending 1h = Interrupt pending, cleared on read | |
| 0 | LP_BP_RX | RC | Oh | Link Partner Base Page Received Interrupt 0h = No Interrupt pending 1h = Interrupt pending, cleared on read | |

7.6.1.137 BIST_CONTROL_FX Register (Offset = C1Ah) [Reset = 0000h]

BIST_CONTROL_FX is shown in Table 7-158.

Return to the Summary Table.

Table 7-158. BIST_CONTROL_FX Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-----|----------|------|-------|-------------|
| 15 | RESERVED | R/W | 0h | Reserved |



Table 7-158. BIST_CONTROL_FX Register Field Descriptions (continued)

| | Table 1 100. Bio 1_001411(0E_1 X 10gister 1 leta besoriptions (continued) | | | | | |
|-------|---|------|-------|--|--|--|
| Bit | Field | Туре | Reset | Description | | |
| 14 | RESERVED | R/W | 0h | Reserved | | |
| 13 | RESERVED | R/W | 0h | Reserved | | |
| 12 | RESERVED | R/W | 0h | Reserved | | |
| 11-10 | RESERVED | R/W | 0h | Reserved | | |
| 9 | RESERVED | R/W | 0h | Reserved | | |
| 8 | RESERVED | R/W | 0h | Reserved | | |
| 7 | RESERVED | R/W | 0h | Reserved | | |
| 6 | RESERVED | R/W | 0h | Reserved | | |
| 5 | FIBER_REVERSE_LOOP BACK_EN | R/W | Oh | Enables Reverse Loopback for fiber connection 0h = Disables Fiber Reverse Loopback 1h = Enables Fiber Reverse Loopback | | |
| 4-3 | RESERVED | R/W | 0h | Reserved | | |
| 2 | RESERVED | R/W | 0h | Reserved | | |
| 1-0 | RESERVED | R/W | 0h | Reserved | | |

7.6.1.138 CFG_100FX_CTRL5 Register (Offset = C30h) [Reset = 3056h]

CFG_100FX_CTRL5 is shown in Table 7-159.

Return to the Summary Table.

Table 7-159. CFG_100FX_CTRL5 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|-----------------|------|-------|---|
| 15-12 | RESERVED | R/W | 0h | Reserved |
| 11-4 | RESERVED | R/W | 0h | Reserved |
| 3 | RESERVED | R/W | 0h | Reserved |
| 2 | CFG_SD_POLARITY | R/W | 1h | Signal_detect polarity control bit 0h = SD pin is active high 1h = SD pin is active low |
| 1 | RESERVED | R/W | 0h | |
| 0 | RESERVED | R/W | 0h | Reserved |

8 Application and Implementation

Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

8.1 Application Information

The DP83869HM is a 10/100/1000 Copper and Fiber Ethernet PHY. It supports connections to an Ethernet MAC through SGMII or RGMII. MII is also supported but only for 100M and 10M speeds. For MII to be operate correctly, 1000M advertisement must be disabled. SGMII is not available in Fiber Ethernet mode and Media Convertor mode because the SGMII pins are multipurpose pins which carry Fiber Ethernet signals. Connections to the Ethernet media are made through the IEEE 802.3 defined Media Dependent Interface.

When using the device for Ethernet application, it is necessary to meet certain requirements for normal operation of the device. The following typical application and design requirements can be used for selecting appropriate component values for the DP83869.

8.2 Typical Applications

8.2.1 Copper Ethernet Typical Application

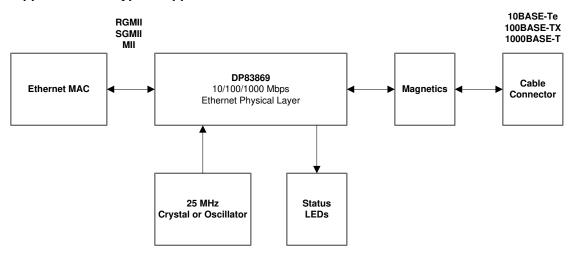


Figure 8-1. Typical Copper Ethernet Application

8.2.1.1 Design Requirements

The design requirements for the DP83869HM are:

- VDDA2P5 = 2.5V
- VDD1P1 = 1.1V
- VDDIO = 3.3V, 2.5V, or 1.8V
- VDDA1P8 x = 1.8V (optional)
- Clock Input = 25MHz

8.2.1.2 Detailed Design Procedure

8.2.1.2.1 Clock Input

Input reference clock requirements are same in all functional modes.

8.2.1.2.1.1 Crystal Recommendations

A 25MHz, parallel, 15pF to 40pF load crystal resonator must be used if a crystal source is desired. Figure 8-2 shows a typical connection for a crystal resonator circuit. The load capacitor values vary with the crystal vendors. Check with the vendor for the recommended loads.

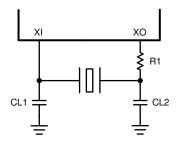


Figure 8-2. Crystal Oscillator Circuit

As a starting point for evaluating the oscillator performance, the value of CL1 and CL2 must each be equal to 2x the specified load capacitance from the crystal vendor's data sheet. For example, if the specified load capacitance of the crystal is 10pF, set CL1 = CL2 = 20pF. CL1, CL2 value can be adjusted based on the parasitic capacitance. Depending on the crystal drive level, R1 is possibly needed.

Specification for 25MHz crystal are listed in Table 8-1.

Table 8-1. 25MHz Crystal Specifications

| PARAMETER | TEST CONDITION | MIN | TYP | MAX | UNIT |
|------------------------|--|-----|-----|------|------|
| Frequency | | | 25 | | MHz |
| Frequency Tolerance | Including Operational Temperature, Aging, and Other Factors | | | ±100 | ppm |
| Load Capacitance | | 15 | | 40 | pF |
| ESR | | | | 50 | ohm |

Product Folder Links: DP83869HM

8.2.1.2.1.2 External Clock Source Recommendation

If an external clock oscillator is used, then the oscillator must be directly connected to XI. XO must be left floating.

The CMOS 25MHz oscillator specifications are listed in Table 8-2 . Additionally, the maximum oscillator phase noise tolerated by the PHY is shown in Figure 8-3.

| Table 8-2. 25MHz Oscillator | Specifications |
|-----------------------------|-----------------------|
|-----------------------------|-----------------------|

| PARAMETER | TEST CONDITION | MIN | TYP | MAX | UNIT |
|---------------------|---------------------------------------|-----|-----|------|------|
| Frequency | | | 25 | | MHz |
| Frequency Tolerance | Operational Temperature, 1 Year Aging | | | ±100 | ppm |
| Rise / Fall Time | 20% - 80% | | | 5 | ns |
| Symmetry | Duty Cycle | 40% | | 60% | |
| Jitter RMS | Integration Band: 12kHz to 5MHz | | | 11 | ps |

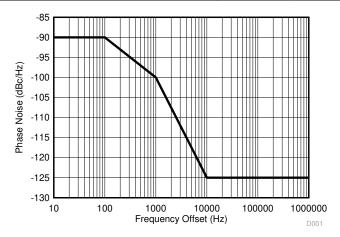
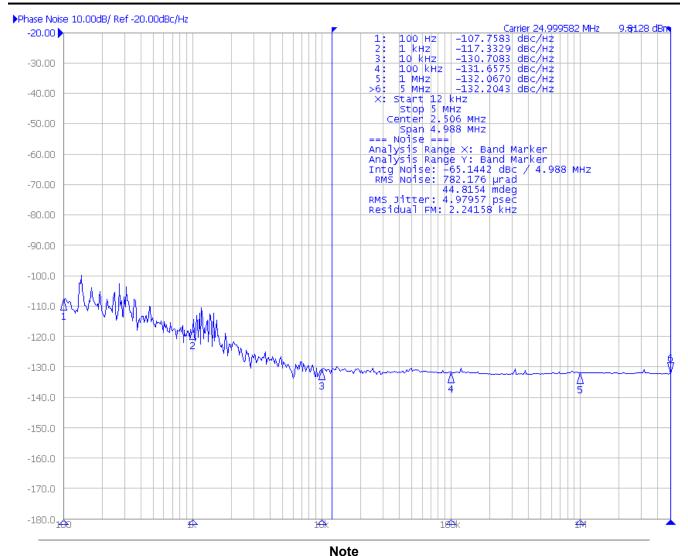


Figure 8-3. 25MHz Oscillator Phase Noise

8.2.1.2.1.3 Clock Out (CLK_OUT) Phase Noise

Figure 8-4 provides a phase noise plot for the 25MHz clock output from the device.





The phase noise on the CLK_OUT pin before linkup and after link up with no packets being generated are expected to be lower than pictured.

Figure 8-4. 25MHz Clock Output Phase Noise

8.2.1.2.2 Magnetics Requirements

In applications where copper Ethernet interface is used, magnetic isolation is required. Magnetics can be discrete or integrated in the Ethernet cable connector. The DP83869HM operates with discrete and integrate magnetics if the magnetics meet the electrical specifications listed in Table 8-3.

Table 8-3. Magnetics Electrical Specification

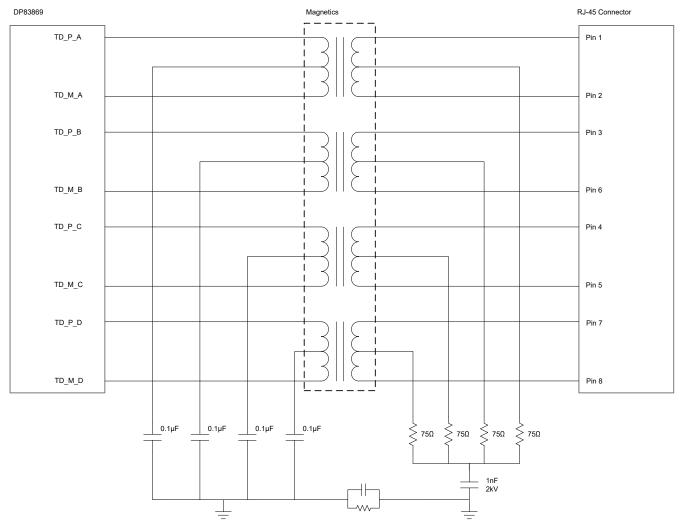
| PARAMETER | TEST CONDITIONS | TYP | UNIT |
|------------------------|-----------------|-----|------|
| Turns Ratio | ±2% Tolerance | 1:1 | - |
| Insertion Loss | 1-100MHz | -1 | dB |
| | 1-30MHz | -16 | dB |
| Return Loss | 30-60MHz | -12 | dB |
| | 60-80MHz | -10 | dB |
| Differential to Common | 1-50MHz | -30 | dB |
| Mode Rejection | 60-150MHz | -20 | dB |

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Table 8-3. Magnetics Electrical Specification (continued)

| PARAMETER | TEST CONDITIONS | TYP | UNIT |
|-------------------------|-----------------|------|------|
| Crosstalk | 30MHz | -35 | dB |
| Ciossiaik | 60MHz | -30 | dB |
| Open Circuit Inductance | 8mA DC Bias | 350 | μН |
| Isolation | HPOT | 1500 | Vrms |

8.2.1.2.2.1 Magnetics Connection



- A. Each center tap on the side connected to the PHY, must be isolated from one another and connected to ground via a decoupling capacitor (0.1µF recommended).
- B. Discrete transformer is recommended for better EMC/EMI performance. Pulse Electronics part, HX5008NL is recommended for discrete magnetics.
- C. Only Channels A&B are required for 100Mbps/10Mbps communication
- D. R//C ground isolation circuit is recommended for EMI purposes. Please refer to DP83869 Schematic Checklist for recommended values

Figure 8-5. PHY to RJ45 and Magnetics



8.2.1.3 Application Curves

For expected MDI signal, see Table 8-4.

Table 8-4. Table of Graphs

| NAME | FIGURE |
|----------------------|-------------|
| 1000Base-T Signal | Figure 6-9 |
| 100Base-TX Signal | Figure 6-10 |
| 10Base-Te Link Pulse | Figure 6-11 |
| Auto-Negotiation FLP | Figure 6-12 |

8.2.2 Fiber Ethernet Typical Ethernet

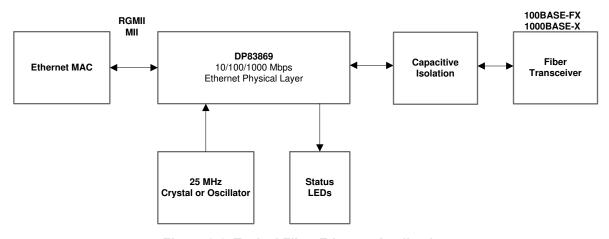


Figure 8-6. Typical Fiber Ethernet Application

8.2.2.1 Design Requirements

The design requirements for the DP83869HM are:

- VDDA2P5 = 2.5V
- VDD1P1 = 1.1V
- VDDIO = 3.3V, 2.5V, or 1.8V
- VDDA1P8_x = 1.8V (optional)
- Clock Input = 25MHz

8.2.2.2 Detailed Design Procedure

See Section 8.2.1.2 for more information.

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8.2.2.2.1 Transceiver Connections

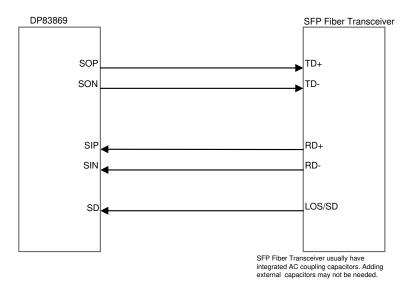


Figure 8-7. PHY to Fiber Transceiver Connections

8.2.2.3 Application Curves

For expected MDI signal, see Table 8-4 in the Section 8.2.1.3 section.

8.3 Power Supply Recommendations

The DP83869HM is capable of operating with as few as two or three supplies. The I/O power supply can also be operated independently of the main device power supplies to provide flexibility for the MAC interface. There are two possible supply configuration that can be used: Two-supply and Three-supply. In Two-supply Configuration, no power rail is connected to VDDA1P8_x pins (pin 13, 48). When unused, pin 13 and 48 must be left floating with no components attached to them. For both power supply configurations, please note that input pins must not be driven until VDDIO and VDDA are stable.

8.3.1 Two-Supply Configuration

Figure 8-8 shows the connection diagram for a two-supply configuration.



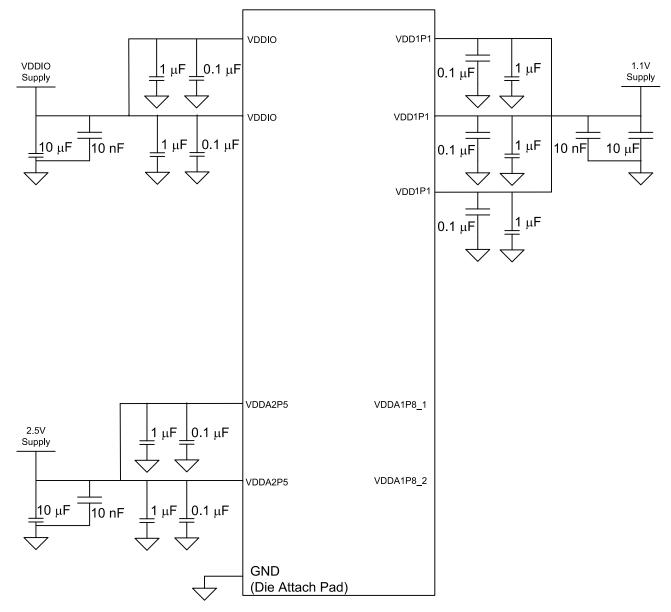


Figure 8-8. Two-Supply Configuration

For a two-supply configuration, both VDDA1P8 pins must be left unconnected.

Place $1\mu F$ and $0.1\mu F$ decoupling capacitors as close as possible to component VDD pins, placing the $0.1\mu F$ capacitor closest to the pin.

For two-supply configuration, the recommendation is to power all supplies together. If that is not possible, then the following power sequencing must be used.

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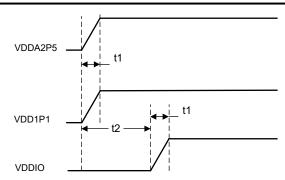


Figure 8-9. Two-Supply Sequence Diagram

Table 8-5. Two-Supply Sequence

| | PARAMETER | TEST CONDITIONS | MIN | NOM | MAX | UNIT |
|----|--|--|-----|-----|-----|------|
| t1 | Supply ramp time | Applicable to all supplies | 0.5 | | 100 | ms |
| t2 | Time instance at which VDDIO starts up | Measured with respect to start of VDDA2P5 and VDD1P1 | | | 50 | ms |



8.3.2 Three-Supply Configuration

Figure 8-10 shows the connection diagram for the three-supply configuration.

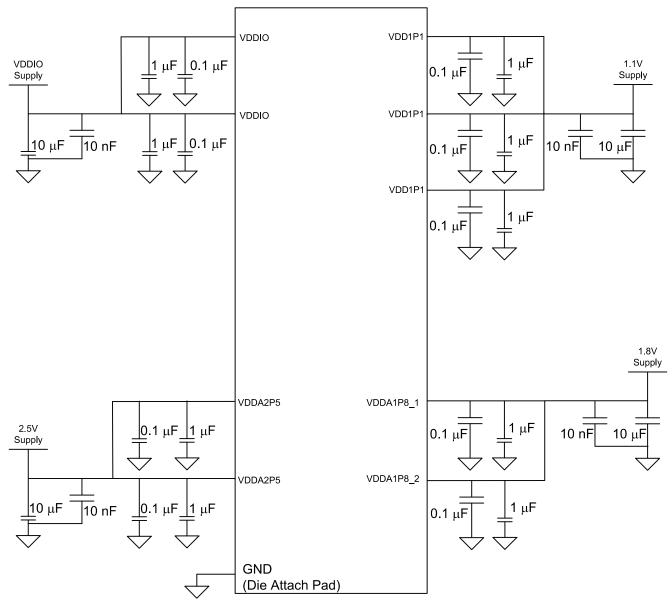


Figure 8-10. Three-Supply Configuration

Place $1\mu F$ and $0.1\mu F$ decoupling capacitors as close as possible to component VDD pins, placing the $0.1\mu F$ capacitor closest to the pin.

For three-supply configuration, the recommendation is to power all supplies together. If that is not possible, then the following power sequencing must be used.

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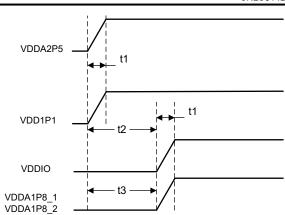


Figure 8-11. Three-Supply Sequence Diagram

Table 8-6. Three-Supply Sequence

| | | mile o or rimor outphil order | | | | |
|----|--|--|-----|-----|-----|------|
| | PARAMETER | TEST CONDITIONS | MIN | NOM | MAX | UNIT |
| t1 | Supply ramp time | Applicable to all supplies | 0.5 | | 100 | ms |
| t2 | Time instance at which VDDIO starts up | Measured with respect to start of VDDA2P5 and VDD1P1 | 0 | | 50 | ms |
| t3 | Time instance at which VDDA1P8_x starts up | Measured with respect to start of VDDA2P5 and VDD1P1 | 0 | | 50 | ms |

8.4 Layout

8.4.1 Layout Guidelines

8.4.1.1 Signal Traces

PCB traces are lossy and long traces can degrade the signal quality. Traces must be kept short as possible. Unless mentioned otherwise, all signal traces must be 50Ω , single-ended impedance. Differential traces must be 50Ω , single-ended and 100Ω differential. Take care that the impedance is constant throughout. Impedance discontinuities cause reflections leading to EMI and signal integrity problems. Stubs must be avoided on all signal traces, especially the differential signal pairs. See Figure 8-12.

Within the differential pairs, the trace lengths must run parallel to each other and matched in length. Matched lengths minimize delay differences, avoiding an increase in common-mode noise and increased EMI.

Length matching is also important on MAC interface. All Transmit signal trace lengths must match to each other and all Receive signal trace lengths must match to each other. When using 1G transmission speeds, the tolerance for length matching is 50 mils. When using 100/10M, the tolerance for length matching is 100 mils.

There must be no crossover or via on the signal paths. Vias present impedance discontinuities and must be minimized. Route an entire trace pair on a single layer if possible.

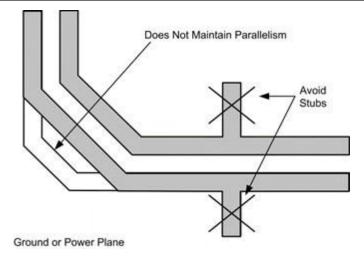


Figure 8-12. Avoiding Stubs in a Differential Signal Pair

Signals on different layers must not cross each other without at least one return path plane between them.

Coupling between traces is also an important factor. Unwanted coupling can cause cross talk problems. Differential pairs on the other hand, must have a constant coupling distance between them.

For convenience and efficient layout process, start by routing the critical signals first.

8.4.1.1.1 MAC Interface Layout Guidelines

The Media Independent Interface (SGMII / RGMII) connects the DP83869 to the Media Access Controller (MAC). The MAC can in fact be a discrete device, integrated into a microprocessor, CPU, or FPGA.

8.4.1.1.1.1 SGMII Layout Guidelines

- All SGMII connections must be AC-coupled through an 0.1µF capacitor. Series capacitors must be 0.1µF and the size must be 0402 or smaller.
- SGMII signals are differential signals.
- Traces must be routed with 100Ω differential impedance.
- Skew matching within a pair must be less than 5pS, which correlates to 30 mil for standard FR4.
- There is no requirement to match the TX pair to the RX pair.
- SGMII signals must be routed on the same layer.
- Pairs must be referenced to parallel ground plane.
- When operating in 6-wire mode, the RX pair must match the Clock pair to within 5pS, which correlates to 30 mil for standard FR4.

8.4.1.1.1.2 RGMII Layout Guidelines

- RGMII signals are single-ended signals.
- Traces must be routed with impedance of 50Ω to ground.
- Skew between TXD[3:0] lines must be less than 11ps, which correlates to 60 mil for standard FR4.
- Skew between RXD[3:0] lines must be less than 11ps, which correlates to 60 mil for standard FR4.
- Keep trace lengths as short as possible, Traces less than 2 inches is recommended with less than 6 inches as maximum length.
- Configurable clock skew for GTX_CLK and RX_CLK.
 - Clock skew for RX and TX paths can be optimized independently.
 - Clock skew is adjustable in 0.25ns increments (through register).

8.4.1.1.2 MDI Layout Guidelines

The Media Dependent Interface (MDI) connects the DP83869 to the transformer and the Ethernet network.

Product Folder Links: DP83869HM

- MDI traces must be 50Ω to ground and 100Ω differential controlled impedance.
- Route MDI traces to transformer on the same layer.

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- Use a metal shielded RJ-45 connector, and connect the shield to chassis ground.
- Use magnetics with integrated common-mode choking devices.
- Void supplies and ground beneath magnetics.
- Do not overlap the circuit and chassis ground planes, keep them isolated. Instead, make chassis ground an isolated island and make a void between the chassis and circuit ground. Connecting circuit and chassis planes using a size 1206 resistor and capacitor on either side of the connector is a good practice.

8.4.1.2 Return Path

A general best practice is to have a solid return path beneath all signal traces. This return path can be a continuous ground or DC power plane. Reducing the width of the return path width can potentially affect the impedance of the signal trace. This effect is more prominent when the width of the return path is comparable to the width of the signal trace. Breaks in return path beneath the signal traces needs to be avoided at all cost. A signal crossing a plane split can cause unpredictable return path currents and can likely impact signal quality as well, potentially creating EMI problems. See Figure 8-13.

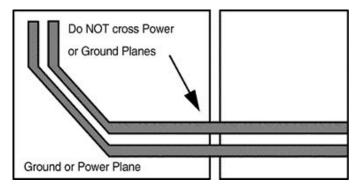


Figure 8-13. Differential Signal Pair-Plane Crossing

8.4.1.3 Transformer Layout

There can be no metal layer running beneath the transformer. Transformers can inject noise in metal beneath them which can affect the performance of the system.

8.4.1.4 Metal Pour

All metal pours which are not signals or power must be tied to ground. There can be no floating metal on the system. There must be no metal between the differential traces.

8.4.1.5 PCB Layer Stacking

To meet signal integrity and performance requirements, at minimum a 4-layer PCB must be used. However a 6-layer board is recommended. See Figure 8-14 for the recommended layer stack ups for 4, 6, and 8-layer boards. These are recommendations not requirements, other configurations can be used as per system requirements.



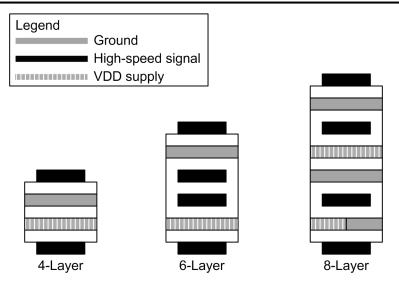


Figure 8-14. Recommended Layer Stack-Up

Within a PCB, running traces using different methods, microstrip versus stripline, can be desirable depending on the location of the signal on the PCB. For example, changing layer sacking where an isolated chassis ground plane is used can be desirable. Figure 8-15 shows alternative PCB stacking options.

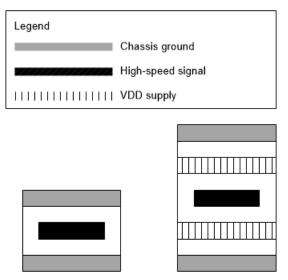


Figure 8-15. Alternative Layer Stack-Up

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8.4.2 Layout Example

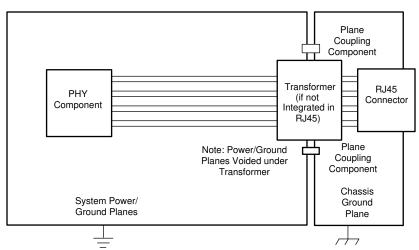


Figure 8-16. Copper Ethernet Layout Example



9 Device and Documentation Support

9.1 Documentation Support

9.1.1 Related Documentation

For related documentation, see the following:

Texas Instruments, DP83869 1000Base-X Link Detection application note

9.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on Alert me to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

9.3 Support Resources

TI E2E[™] support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

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9.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

9.6 Glossary

TI Glossary

This glossary lists and explains terms, acronyms, and definitions.

10 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Revision C (April 2024) to Revision D (June 2025) Page Added that JTAG TDI/SD Pin is an active-low pin when the pin acts as the signal detect pin. Added note to keep Hi-Z pins float/NC or connect to GND with 10kΩ resistor......4 Changed the terms "master" and "slave" to "leader" and "follower" per the Texas Instruments inclusive All instances of "master" and "slave" changed to "leader" and "follower" respectively, Added fiber link status for register 18h LED configurations (settings: 5h and 6h), Added Register Name for Register E9h, Clarified Register 86h delay options, Clarified Register 170h[4:1] setting on MAC impedance control, Clarified Register 1DFh[6] setting, Added Link Loss Pass Through Enable Register (1ECh[3]). Removed Link Loss Pass Through No Link Bit (1ECh[0]). Register C01h[2] clarified. Register C10h[9] clarified. Unreserved register C1Ah[5] and register C30h[2]. Changed register D6h[14:13] bit name from "SGMII TESTMODE SWING" to "SGMII_VOLTAGE_SWING".......54

Product Folder Links: DP83869HM

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| • | Added 25MHz Oscillator Phase Noise Figure | 11 | 1 |
|---|---|----|---|
| | Added Section 8.2.1.2.1.3. | | |
| | | | |

| С | hanges from Revision B (December 2022) to Revision C (April 2024) | Page |
|---|--|---|
| • | RESET N Pin State in IEEE PWDN corrected from PD to PU | 4 |
| • | Added Junction Temperature Spec | |
| • | Magic Packet Detection Registers Table added | |
| • | Added BIST Configuration example | |
| • | More detailed steps to enable MII mode of operation added | |
| • | Extended Register Space section formatted more clearly | |
| • | Corrected typo 100Base-T to 100Base-TX | |
| • | Corrected table functions | |
| • | Added IPG Control Registers (0x7B-0x7C), SFD Registers (0xE9, 0x55), PRBS Config Registers (0x71, 0x72, 0x1A8, 0x1A9), CLKOUT Config Reg (0xC6, needed before writing to 0x170), and WoL Registers (0x134-0x15F) | |
| | Added RC ground isolation circuit to Magnetics connection figure | |
| | Removed mention of SUPPLYMODE_SEL, pin 23, which doesn't exist on this part | |
| | Removed line mentioning SUPPLYMODE_SEL, does not exist on this device | |
| - | Changed fiber compliance to current Specification | |
| _ | , | Page |
| • | Updated the numbering format for tables, figures, and cross-references throughout the document | |
| | Deleted leading 0 from all register, read, and write statements | |
| | Deleted 1000Base-X fiber application clarification, bug has been fixed | |
| | Changed bridge mode image and description to clarify TX and RX pin behavior | |
| • | | |
| | Changed description of Media Converter mode to support Unmanaged Media Converter mode in respon | se to |
| • | bug fix | |
| • | bug fixChanged register read and writes to correct values with comments | 42 42 |
| • | bug fix | 42 42 |
| | bug fixChanged register read and writes to correct values with comments | 42 42 43 |
| • | bug fix | 42 42 43 |
| • | bug fix Changed register read and writes to correct values with comments Changed number of PHYs and size of PHY address to correct values Added clarification for Auto-Negotiation setting Changed strapping modes in the figure and description to correct values Changed Table 8-1 to clarify Frequency Tolerance | 42 43 51 51 |
| | bug fix Changed register read and writes to correct values with comments Changed number of PHYs and size of PHY address to correct values Added clarification for Auto-Negotiation setting Changed strapping modes in the figure and description to correct values Changed Table 8-1 to clarify Frequency Tolerance Changed to Table 8-2clarify Frequency Tolerance | 42 43 51 51 110 |
| • | bug fix Changed register read and writes to correct values with comments Changed number of PHYs and size of PHY address to correct values. Added clarification for Auto-Negotiation setting. Changed strapping modes in the figure and description to correct values. Changed Table 8-1 to clarify Frequency Tolerance Changed to Table 8-2clarify Frequency Tolerance Changed the two-supply config figure to the correct number of pins for VDDIO and VDD1P1, also change | 42 43 51 51 110 111 |
| • | bug fix Changed register read and writes to correct values with comments Changed number of PHYs and size of PHY address to correct values Added clarification for Auto-Negotiation setting Changed strapping modes in the figure and description to correct values Changed Table 8-1 to clarify Frequency Tolerance Changed to Table 8-2clarify Frequency Tolerance | 42 43 51 51 110 111 ed 115 |

11 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

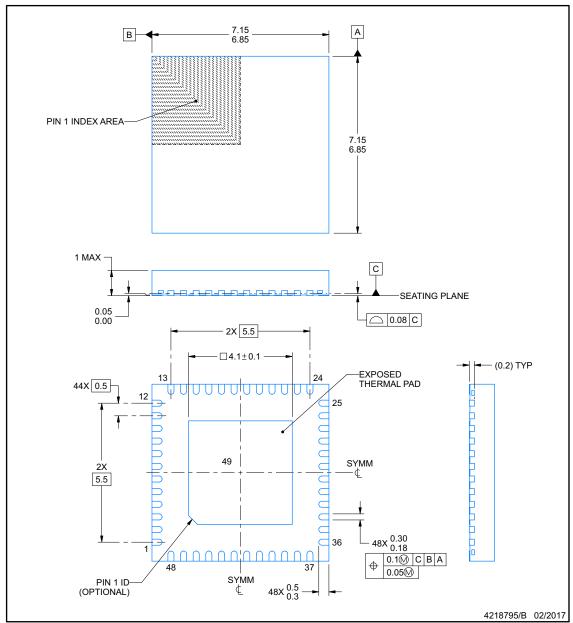




PACKAGE OUTLINE

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES:

- All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 This drawing is subject to change without notice.
 The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



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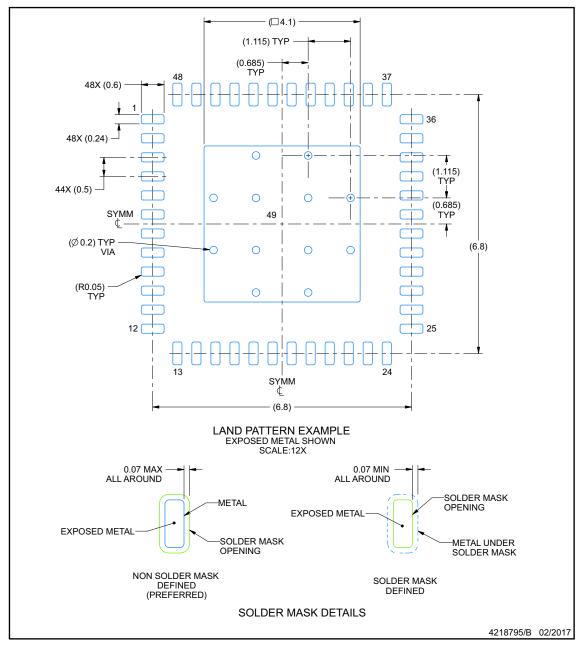


EXAMPLE BOARD LAYOUT

RGZ0048B

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

- 4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

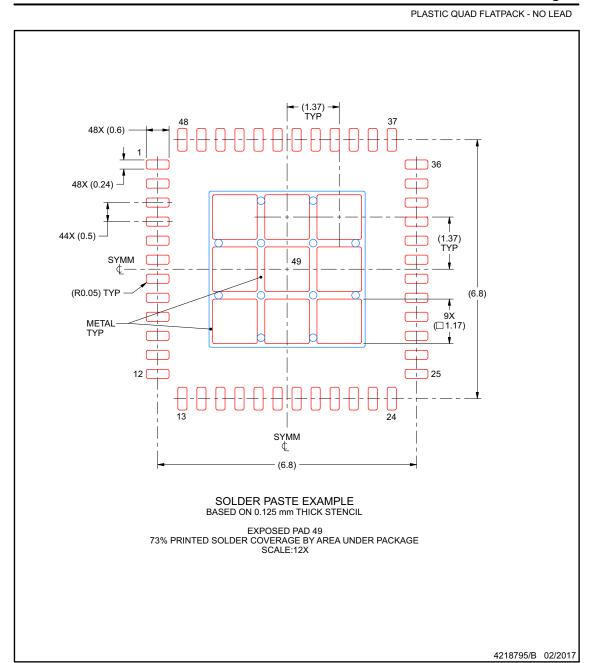




EXAMPLE STENCIL DESIGN

RGZ0048B

VQFN - 1 mm max height



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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PACKAGING INFORMATION

| Orderable part number | Status | Material type | Package Pins | Package qty Carrier | RoHS | Lead finish/ Ball material | MSL rating/ Peak reflow | Op temp (°C) | Part marking |
|-----------------------|--------|---------------|-----------------|-----------------------|------|-------------------------------|----------------------------|--------------|--------------|
| | (-) | (=/ | | | (-) | (4) | (5) | | (-) |
| DP83869HMRGZR | Active | Production | VQFN (RGZ) 48 | 2000 LARGE T&R | Yes | Call TI Nipdauag | Level-2-260C-1 YEAR | -40 to 125 | DP83869HM |
| DP83869HMRGZR.A | Active | Production | VQFN (RGZ) 48 | 2000 LARGE T&R | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | DP83869HM |
| DP83869HMRGZT | Active | Production | VQFN (RGZ) 48 | 250 SMALL T&R | Yes | NIPDAUAG | Level-2-260C-1 YEAR | -40 to 125 | DP83869HM |
| DP83869HMRGZT.A | Active | Production | VQFN (RGZ) 48 | 250 SMALL T&R | Yes | NIPDAUAG | Level-2-260C-1 YEAR | -40 to 125 | DP83869HM |
| DP83869HMRGZT.B | Active | Production | VQFN (RGZ) 48 | 250 SMALL T&R | - | NIPDAUAG | Level-2-260C-1 YEAR | -40 to 125 | DP83869HM |

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

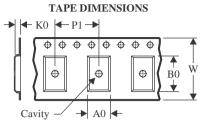
⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width |
|----|---|
| В0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| DP83869HMRGZR | VQFN | RGZ | 48 | 2000 | 330.0 | 16.4 | 7.3 | 7.3 | 1.1 | 12.0 | 16.0 | Q2 |
| DP83869HMRGZT | VQFN | RGZ | 48 | 250 | 180.0 | 16.4 | 7.3 | 7.3 | 1.1 | 12.0 | 16.0 | Q2 |

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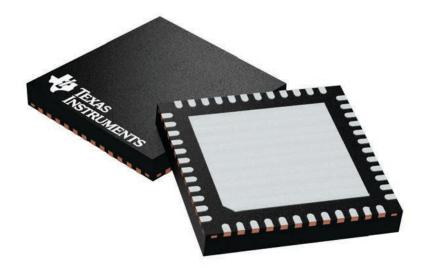


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| DP83869HMRGZR | VQFN | RGZ | 48 | 2000 | 367.0 | 367.0 | 38.0 |
| DP83869HMRGZT | VQFN | RGZ | 48 | 250 | 210.0 | 185.0 | 35.0 |

7 x 7, 0.5 mm pitch

PLASTIC QUADFLAT PACK- NO LEAD



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4224671/A



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